



# CAT521

## Configured Digitally Programmable Potentiometer (DPP™): Programmable Voltage Applications

### FEATURES

- 8-bit DPP configured as a programmable voltage source in DAC-like applications
- Buffered wiper output
- Non-volatile NVRAM memory wiper storage
- Output voltage range includes both supply rails
- 1 LSB accuracy, high resolution
- Serial Microwire-like interface
- Single supply operation: 2.7V - 5.5V
- Setting read-back without effecting outputs

### APPLICATIONS

- Automated product calibration
- Remote control adjustment of equipment
- Offset, gain and zero adjustments in self-calibrating and adaptive control systems
- Tamper-proof calibrations
- DAC (with memory) substitute

### DESCRIPTION

The CAT521 is a 8-bit digitally-programmable potentiometer (DPP™) configured for programmable voltage and DAC-like applications. Intended for final calibration of products such as camcorders, fax machines and cellular telephones on automated high volume production lines, it is also well suited for self-calibrating systems and for applications where equipment which requires periodic adjustment is either difficult to access or in a hazardous environment.

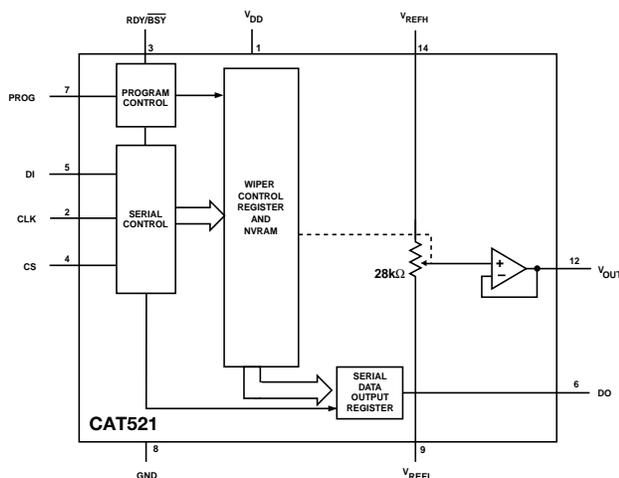
The programmable DPP has an output voltage range which includes both supply rails. The wiper is buffered by a rail to rail op amp. The wiper setting, stored in non-volatile NVRAM memory, is not lost when the device is powered down and is automatically reinstated when power is returned. The wiper can be dithered to test new output values without effecting the stored

settings and stored settings can be read back without disturbing the DPP's output.

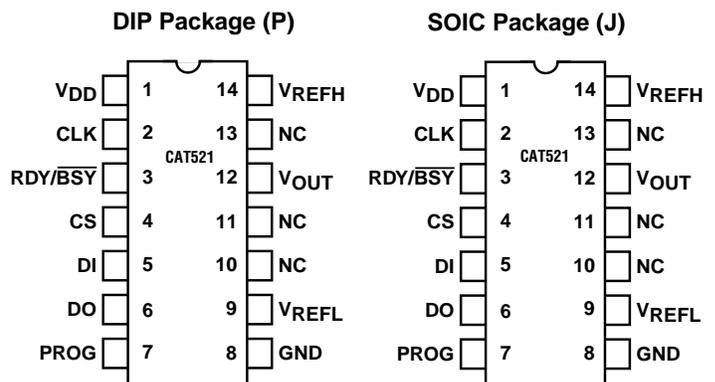
The CAT521 is controlled with a simple 3-wire, Microwire-like serial interface. A Chip Select pin allows several devices to share a common serial interface. Communication back to the host controller is via a single serial data line thanks to the CAT521 Tri-Stated Data Output pin. A RDY/BSY output working in concert with an internal low voltage detector signals proper operation of the non-volatile NVRAM memory Erase/Write cycle.

The CAT521 is available in 0°C to 70°C commercial and -40°C to 85°C industrial operating temperature ranges. Both 14-pin plastic DIP and surface mount packages are available.

### FUNCTIONAL DIAGRAM



### PIN CONFIGURATION



**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage\*  
 $V_{DD}$  to GND ..... -0.5V to +7V

Inputs  
 CLK to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 CS to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 DI to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 RDY/BSY to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 PROG to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 $V_{REFH}$  to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 $V_{REFL}$  to GND ..... -0.5V to  $V_{DD} + 0.5V$

Outputs  
 $D_0$  to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 $V_{OUT}$  1– 4 to GND ..... -0.5V to  $V_{DD} + 0.5V$

Operating Ambient Temperature

Commercial ('C' or Blank suffix) ..... 0°C to +70°C  
 Industrial ('I' suffix) ..... -40°C to +85°C  
 Junction Temperature ..... +150°C  
 Storage Temperature ..... -65°C to +150°C  
 Lead Soldering (10 sec max) ..... +300°C

\* Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Absolute Maximum Ratings are limited values applied individually while other parameters are within specified operating conditions, and functional operation at any of these conditions is NOT implied. Device performance and reliability may be impaired by exposure to absolute rating conditions for extended periods of time.

**RELIABILITY CHARACTERISTICS**

Symbol	Parameter	Min	Max	Units	Test Method
$V_{ZAP}^{(1)}$	ESD Susceptibility	2000		Volts	MIL-STD-883, Test Method 3015
$I_{LTH}^{(1)(2)}$	Latch-Up	100		mA	JEDEC Standard 17

- NOTES:** 1. This parameter is tested initially and after a design or process change that affects the parameter.  
 2. Latch-up protection is provided for stresses up to 100mA on address and data pins from -1V to  $V_{CC} + 1V$ .

**POWER SUPPLY**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{DD1}$	Supply Current (Read)	Normal Operating	—	400	600	$\mu A$
$I_{DD2}$	Supply Current (Write)	Programming, $V_{DD} = 5V$	—	1600	2500	$\mu A$
		$V_{DD} = 3V$	—	1000	1600	$\mu A$
$V_{DD}$	Operating Voltage Range		2.7	—	5.5	V

**LOGIC INPUTS**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{IH}$	Input Leakage Current	$V_{IN} = V_{DD}$	—	—	10	$\mu A$
$I_{IL}$	Input Leakage Current	$V_{IN} = 0V$	—	—	-10	$\mu A$
$V_{IH}$	High Level Input Voltage		2	—	$V_{DD}$	V
$V_{IL}$	Low Level Input Voltage		0	—	0.8	V

**LOGIC OUTPUTS**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{OH}$	High Level Output Voltage	$I_{OH} = -40\mu A$	$V_{DD} - 0.3$	—	—	V
$V_{IL}$	Low Level Output Voltage	$I_{OL} = 1\text{ mA}, V_{DD} = +5V$	—	—	0.4	V
		$I_{OL} = 0.4\text{ mA}, V_{DD} = +3V$	—	—	0.4	V

**POTENTIOMETER CHARACTERISTICS**
 $V_{DD} = +2.7V$  to  $+5.5V$ ,  $V_{REFH} = V_{DD}$ ,  $V_{REFL} = 0V$ , unless otherwise specified

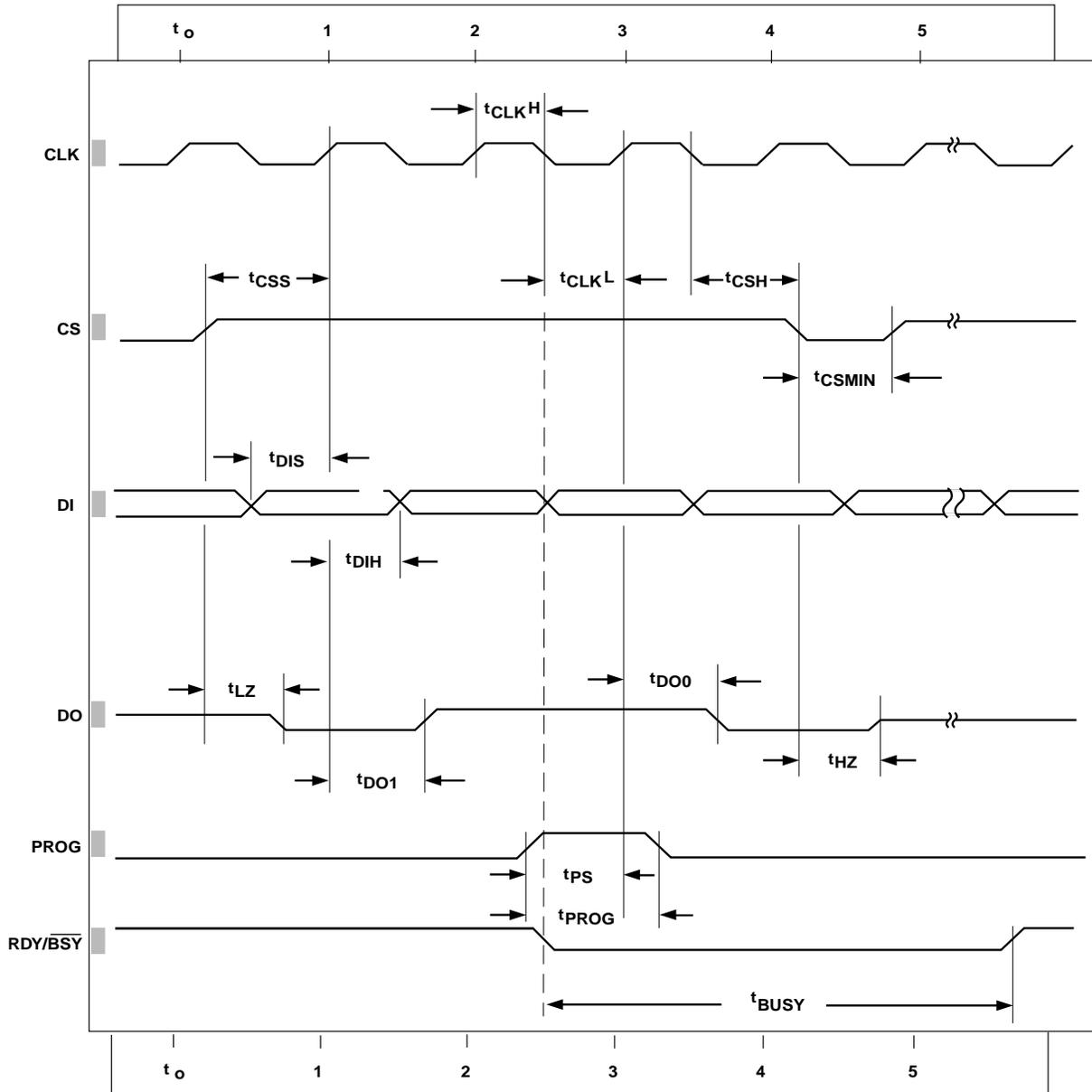
Symbol	Parameter	Conditions	Min	Typ	Max	Units
R <sub>POT</sub>	Potentiometer Resistance			28		k $\Omega$
	R <sub>POT</sub> to R <sub>POT</sub> Match		—	$\pm 0.5$	$\pm 1$	%
	Pot Resistance Tolerance				$\pm 15$	%
	Voltage on V <sub>REFH</sub> pin		2.7		V <sub>DD</sub>	V
	Voltage on V <sub>REFL</sub> pin		0V		V <sub>DD</sub> - 2.7	V
	Resolution			0.4		%
INL	Integral Linearity Error			0.5	1	LSB
DNL	Differential Linearity Error			0.25	0.5	LSB
R <sub>OUT</sub>	Buffer Output Resistance				10	$\Omega$
I <sub>OUT</sub>	Buffer Output Current				3	mA
TC <sub>R<sub>POT</sub></sub>	TC of Pot Resistance			300		ppm/ $^{\circ}$ C
TC <sub>R<sub>RATIO</sub></sub>	Ratiometric TC					ppm/ $^{\circ}$ C
R <sub>ISO</sub>	Isolation Resistance					$\Omega$
V <sub>N</sub>	Noise					nV/ $\sqrt{\text{Hz}}$
C <sub>H</sub> /C <sub>L</sub>	Potentiometer Capacitances			8/8		pF
f <sub>c</sub>	Frequency Response	Passive Attenuator				MHz

**AC ELECTRICAL CHARACTERISTICS:**
 $V_{DD} = +2.7V$  to  $+5.5V$ ,  $V_{REFH} = V_{DD}$ ,  $V_{REFL} = 0V$ , unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Digital</b>						
t <sub>CSMIN</sub>	Minimum CS Low Time		150	—	—	ns
t <sub>CSS</sub>	CS Setup Time		100	—	—	ns
t <sub>CSH</sub>	CS Hold Time	C <sub>L</sub> =100pF, see note 1	0	—	—	ns
t <sub>DIS</sub>	DI Setup Time		50	—	—	ns
t <sub>DIH</sub>	DI Hold Time		50	—	—	ns
t <sub>DO1</sub>	Output Delay to 1		—	—	150	ns
t <sub>DO0</sub>	Output Delay to 0		—	—	150	ns
t <sub>HZ</sub>	Output Delay to High-Z		—	400	—	ns
t <sub>LZ</sub>	Output Delay to Low-Z	—	400	—	ns	
t <sub>BUSY</sub>	Erase/Write Cycle Time		—	4	5	ms
t <sub>PS</sub>	PROG Setup Time		150	—	—	ns
t <sub>PROG</sub>	Minimum Pulse Width		700	—	—	ns
t <sub>CLKH</sub>	Minimum CLK High Time		500	—	—	ns
t <sub>CLKL</sub>	Minimum CLK Low Time		300	—	—	ns
f <sub>c</sub>	Clock Frequency		DC	—	1	MHz
<b>Analog</b>						
t <sub>DS</sub>	DPP Settling Time to 1 LSB	C <sub>LOAD</sub> = 10 pF, V <sub>DD</sub> = +5V	—	3	10	$\mu$ s
		C <sub>LOAD</sub> = 10 pF, V <sub>DD</sub> = +3V	—	6	10	$\mu$ s

- NOTES:** 1. All timing measurements are defined at the point of signal crossing  $V_{DD} / 2$ .  
2. These parameters are periodically sampled and are not 100% tested.

A. C. TIMING DIAGRAM



## PIN DESCRIPTION

Pin	Name	Function
1	V <sub>DD</sub>	Power supply positive
2	CLK	Clock input pin
3	RDY/ $\overline{\text{BSY}}$	Ready/Busy output
4	CS	Chip select
5	DI	Serial data input pin
6	DO	Serial data output pin
7	PROG	EEPROM Programming Enable Input
8	GND	Power supply ground
9	V <sub>REFL</sub>	Minimum DAC output voltage
10	NC	No Connect
11	NC	No Connect
12	V <sub>OUT</sub>	DPP output
13	NC	No Connect
14	V <sub>REFH</sub>	Maximum DPP 1 output voltage

DPP addressing is as follows:

DPP OUTPUT	A0	A1
V <sub>OUT</sub>	1	0

## DEVICE OPERATION

The CAT521 is a single 8-bit configured digitally programmable potentiometer (DPP™) whose output can be programmed to any one of 256 individual voltage steps. Once programmed, the output setting is retained in non-volatile memory and will not be lost when power is removed from the chip. Upon power up the DPP returns to the setting stored in non-volatile memory. The DPP can be written to and read from without effecting the output voltage during the read or write cycle. The output can also be adjusted without altering the stored output setting, which is useful for testing new output settings before storing them in memory.

## DIGITAL INTERFACE

The CAT521 employs a 3 wire, Microwire-like serial control interface consisting of Clock (CLK), Chip Select (CS) and Data In (DI) inputs. For all operations, address and data are shifted in LSB first. In addition, all digital data must be preceded by a logic "1" as a start bit. The DPP address and data are clocked into the DI pin on the clock's rising edge. When sending multiple blocks of information a minimum of two clock cycles is required between the last block sent and the next start bit.

Multiple devices may share a common input data line by selectively activating the CS control of the desired IC. Data Outputs (DO) can also share a common line because the DO pin is Tri-States and returns to a high impedance when not in use.

## CHIP SELECT

Chip Select (CS) enables and disables the CAT521's read and write operations. When CS is high data may be read to or from the chip, and the Data Output (DO) pin is active. Data loaded into the DPP control register will remain in effect until CS goes low. Bringing CS to a logic low returns all DPP outputs to the settings stored in non-volatile memory and switches DO to its high impedance Tri-State mode.

Because CS functions like a reset the CS pin has been desensitized with a 30 ns to 90 ns filter circuit to prevent noise spikes from causing unwanted resets and the loss of volatile data.

## CLOCK

The CAT521 clock controls both data flow in and out of the device and non-volatile memory cell programming. Serial data is shifted into the DI pin and out of the DO pin on the clock's rising edge. While it is not necessary for the clock to be running between data transfers, the clock must be operating in order to write to non-volatile memory, even though the data being saved may already be resident in the DPP wiper control register.

No clock is necessary upon system power-up. The CAT521 internal power-on reset circuitry loads data from non-volatile memory to the DPP without using the external clock.

As data transfers are edge triggered clean clock transitions are necessary to avoid falsely clocking data into the control register. Standard CMOS and TTL logic families work well in this regard and it is recommended that any mechanical switches used for breadboarding or device evaluation purposes be debounced by a flip-flop or other suitable debouncing circuit.

**V<sub>REF</sub>**

V<sub>REF</sub>, the voltage applied between pins V<sub>REFH</sub> & V<sub>REFL</sub>, sets the DPP's Zero to Full Scale output range where V<sub>REFL</sub> = Zero and V<sub>REFH</sub> = Full Scale. V<sub>REF</sub> can span the full power supply range or just a fraction of it. In typical applications V<sub>REFH</sub> & V<sub>REFL</sub> are connected across the power supply rails. When using less than the full supply voltage be mindfull of the limits placed on V<sub>REFH</sub> and V<sub>REFL</sub> as specified in the References section of DC Electrical Characteristics.

**READY/BSY**

When saving data to non-volatile memory, the Ready/Busy output (RDY/BSY) signals the start and duration of the non-volatile erase/write cycle. Upon receiving a command to store data (PROG goes high) RDY/BSY goes low and remains low until the programming cycle is complete. During this time the CAT521 will ignore any data appearing at DI and no data will be output on DO.

RDY/BSY is internally ANDed with a low voltage detector circuit monitoring V<sub>DD</sub>. If V<sub>DD</sub> is below the minimum value required for non-volatile programming, RDY/BSY will remain high following the program command indicating a failure to record the desired data in non-volatile memory.

**DATA OUTPUT**

Data is output serially by the CAT521, LSB first, via the Data Out (DO) pin following the reception of a start bit and two address bits by the Data Input (DI). DO becomes active whenever CS goes high and resumes its high impedance Tri-State mode when CS returns low. Tri-Stating the DO pin allows several 521s to share a

single serial data line and simplifies interfacing multiple 521s to a microprocessor.

**WRITING TO MEMORY**

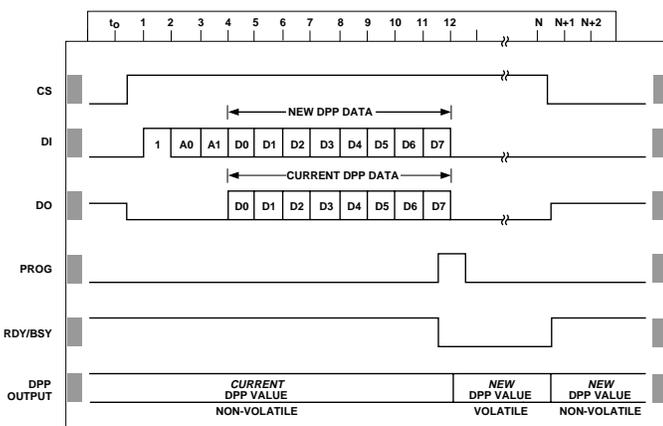
Programming the CAT521's non-volatile memory is accomplished through the control signals: Chip Select (CS) and Program (PROG). With CS high, a start bit followed by a two bit DPP address and eight data bits are clocked into the DPP wiper control register via the DI pin. Data enters on the clock's rising edge. The DPP output changes to its new setting on the clock cycle following D7, the last data bit.

Programming is accomplished by bringing PROG high sometime after the start bit and at least 150 ns prior to the rising edge of the clock cycle immediately following the D7 bit. Two clock cycles after the D7 bit the DPP wiper control register will be ready to receive the next set of address and data bits. The clock must be kept running throughout the programming cycle. Internal control circuitry takes care of generating and ramping up the programming voltage for data transfer to the non-volatile memory cells. The CAT521 non-volatile memory cells will endure over 1,000,000 write cycles and will retain data for a minimum of 100 years without being refreshed.

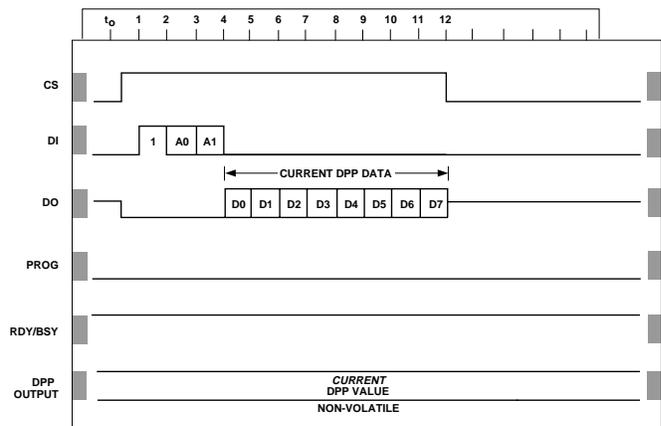
**READING DATA**

Each time data is transferred into the DPP wiper control register currently held data is shifted out via the D0 pin, thus in every data transaction a read cycle occurs. Note, however, that the reading process is destructive. Data must be removed from the register in order to be read. Figure 2 depicts a Read Only cycle in which no change occurs in the DPP's output. This feature allows  $\mu$ Ps to poll DPPs for their current setting without disturbing the output voltage but it assumes that the setting being read is also stored in non-volatile memory so that it can be restored at the end of the read cycle. In Figure 2 CS returns low before the 13<sup>th</sup> clock cycle completes. In doing so the non-volatile memory's setting is reloaded into the DPP wiper control register. Since this value is

**Figure 1. Writing to Memory**



**Figure 2. Reading from Memory**



the same as that which had been there previously no change in the DPP's output is noticed. Had the value held in the control register been different from that stored in non-volatile memory then *a change would occur* at the read cycle's conclusion.

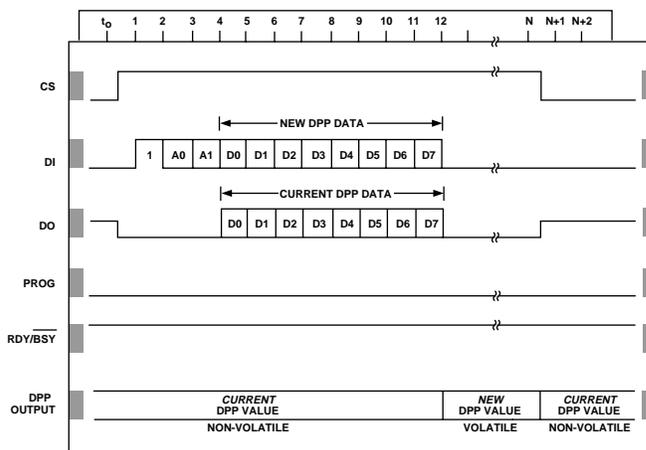
**TEMPORARILY CHANGE OUTPUT**

The CAT521 allows temporary changes in the DPP's output to be made without disturbing the settings retained in non-volatile memory. This feature is particularly useful when testing for a new output setting and allows for user adjustment of preset or default values without losing the original factory settings.

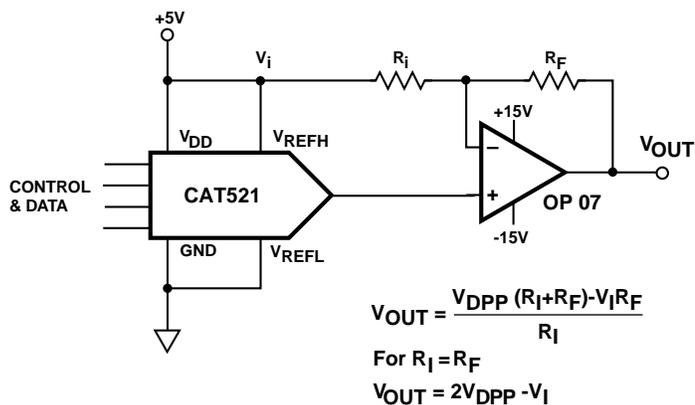
Figure 3 shows the control and data signals needed to effect a temporary output change. DPP settings may be changed as many times as required. The temporary setting remains in effect long as CS remains high. When CS returns low the DPP will return to the output value stored in non-volatile memory.

When it is desired to save a new setting acquired using this feature, the new value must be reloaded into the DPP wiper control register prior to programming. This is because the CAT521's internal control circuitry discards from the programming register the new data two clock cycles after receiving it if no PROG signal is received.

**Figure 3. Temporary Change in Output**

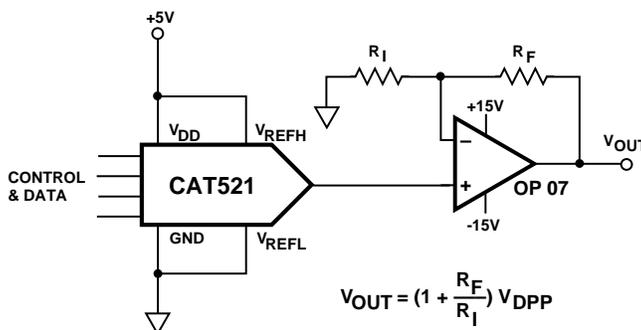


**APPLICATION CIRCUITS**



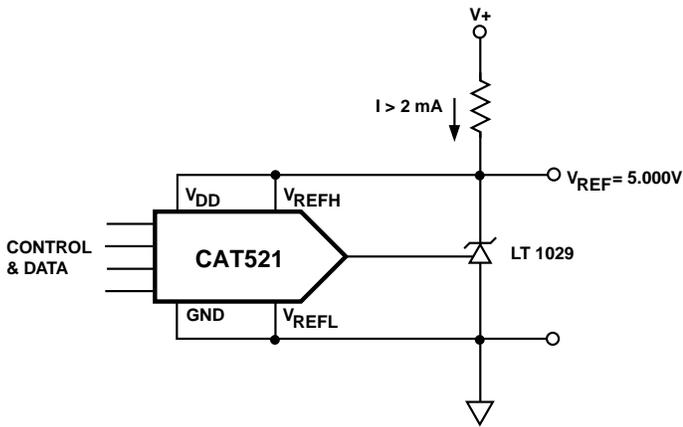
DPP INPUT		DPP OUTPUT		ANALOG OUTPUT
MSB	LSB	$V_{DPP} = \frac{CODE}{255} (V_{FS} - V_{ZERO}) + V_{ZERO}$		
			$V_{FS} = 0.99 V$	$V_{REF} = 5V$ $R_I = R_F$
			$V_{ZERO} = 0.01 V$	
1111	1111	$\frac{255}{255}$	$(.98 V_{REF}) + .01 V_{REF} = .990 V_{REF}$	$V_{OUT} = +4.90V$
1000	0000	$\frac{128}{255}$	$(.98 V_{REF}) + .01 V_{REF} = .502 V_{REF}$	$V_{OUT} = +0.02V$
0111	1111	$\frac{127}{255}$	$(.98 V_{REF}) + .01 V_{REF} = .498 V_{REF}$	$V_{OUT} = -0.02V$
0000	0001	$\frac{1}{255}$	$(.98 V_{REF}) + .01 V_{REF} = .014 V_{REF}$	$V_{OUT} = -4.86V$
0000	0000	$\frac{0}{255}$	$(.98 V_{REF}) + .01 V_{REF} = .010 V_{REF}$	$V_{OUT} = -4.90V$

**Bipolar DPP Output**

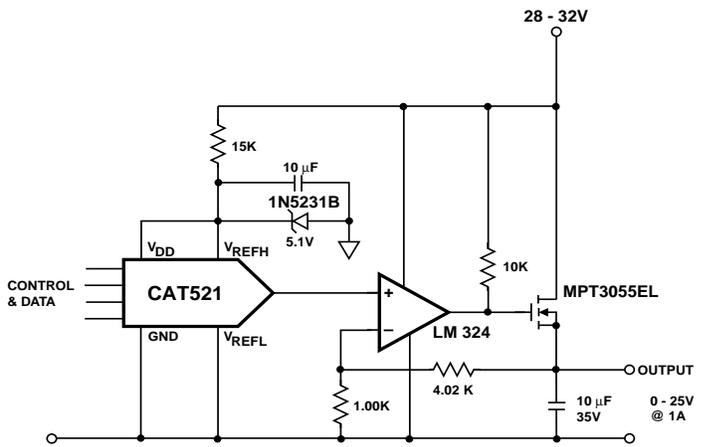


**Amplified DPP Output**

APPLICATION CIRCUITS (Cont.)

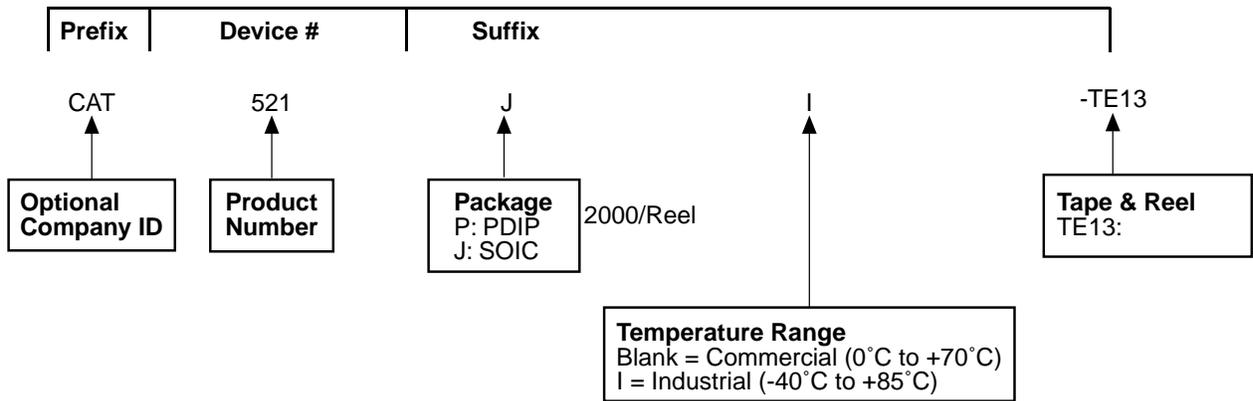


Digitally Trimmed Voltage Reference



Digitally Controlled Voltage Reference

**ORDERING INFORMATION**



Notes:

(1) The device used in the above example is a CAT521JI-TE13 (SOIC, Industrial Temperature, Tape & Reel)

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# CAT522

## Configured Digitally Programmable Potentiometer (DPP™): Programmable Voltage Applications

### FEATURES

- Two 8-bit DPPs configured as programmable voltage sources in DAC-like applications
- Independent reference inputs
- Non-volatile NVRAM memory wiper storage
- Output voltage range includes both supply rails
- 2 independently addressable buffered output wipers
- 1 LSB accuracy, high resolution
- Serial Microwire-like interface
- Single supply operation: 2.7V - 5.5V
- Setting read-back without effecting outputs

### APPLICATIONS

- Automated product calibration.
- Remote control adjustment of equipment
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- Tamper-proof calibrations.
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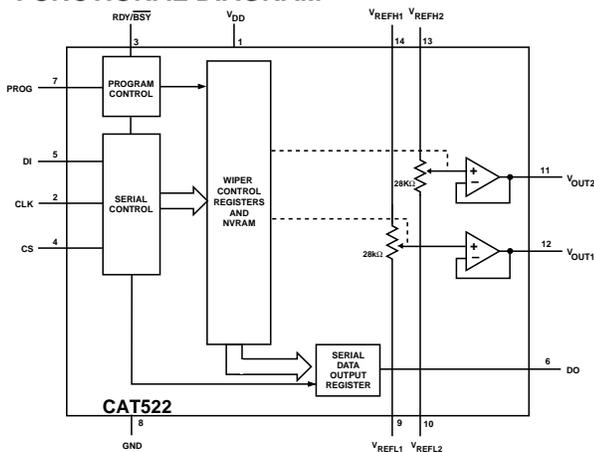
The CAT522 offers two independently programmable DPPs each having its own reference inputs and each capable of rail to rail output swing. The wipers are buffered by rail to rail opamps. Wiper settings, stored in non-volatile NVRAM memory, are not lost when the device is powered down and are automatically reinstated when power is returned. Each wiper can be

dithered to test new output values without effecting the stored settings and stored settings can be read back without disturbing the DPP's output.

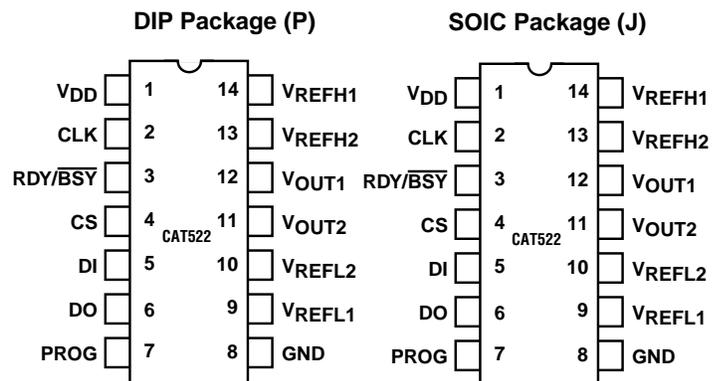
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### PIN CONFIGURATION



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 DI to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 RDY/BSY to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 PROG to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 $V_{REFH}$  to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 $V_{REFL}$  to GND ..... -0.5V to  $V_{DD} + 0.5V$

Outputs  
 $D_0$  to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 $V_{OUT 1-4}$  to GND ..... -0.5V to  $V_{DD} + 0.5V$

Operating Ambient Temperature

Commercial ('C' or Blank suffix) ..... 0°C to +70°C  
 Industrial ('I' suffix) ..... -40°C to +85°C  
 Junction Temperature ..... +150°C  
 Storage Temperature ..... -65°C to +150°C  
 Lead Soldering (10 sec max) ..... +300°C

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**RELIABILITY CHARACTERISTICS**

Symbol	Parameter	Min	Max	Units	Test Method
$V_{ZAP}^{(1)}$	ESD Susceptibility	2000		Volts	MIL-STD-883, Test Method 3015
$I_{LTH}^{(1)(2)}$	Latch-Up	100		mA	JEDEC Standard 17

- NOTES:** 1. This parameter is tested initially and after a design or process change that affects the parameter.  
 2. Latch-up protection is provided for stresses up to 100mA on address and data pins from -1V to  $V_{CC} + 1V$ .

**POWER SUPPLY**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{DD1}$	Supply Current (Read)	Normal Operating	—	400	600	$\mu A$
$I_{DD2}$	Supply Current (Write)	Programming, $V_{DD} = 5V$	—	1600	2500	$\mu A$
		$V_{DD} = 3V$	—	1000	1600	$\mu A$
$V_{DD}$	Operating Voltage Range		2.7	—	5.5	V

**LOGIC INPUTS**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{IH}$	Input Leakage Current	$V_{IN} = V_{DD}$	—	—	10	$\mu A$
$I_{IL}$	Input Leakage Current	$V_{IN} = 0V$	—	—	-10	$\mu A$
$V_{IH}$	High Level Input Voltage		2	—	$V_{DD}$	V
$V_{IL}$	Low Level Input Voltage		0	—	0.8	V

**LOGIC OUTPUTS**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{OH}$	High Level Output Voltage	$I_{OH} = -40\mu A$	$V_{DD} - 0.3$	—	—	V
$V_{IL}$	Low Level Output Voltage	$I_{OL} = 1 mA, V_{DD} = +5V$	—	—	0.4	V
		$I_{OL} = 0.4 mA, V_{DD} = +3V$	—	—	0.4	V

**POTENTIOMETER CHARACTERISTICS**

$V_{DD} = +2.7V$  to  $+5.5V$ ,  $V_{REFH} = V_{DD}$ ,  $V_{REFL} = 0V$ , unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$R_{POT}$	Potentiometer Resistance			28		$k\Omega$
	$R_{POT}$ to $R_{POT}$ Match		—	$\pm 0.5$	$\pm 1$	%
	Pot Resistance Tolerance				$\pm 15$	%
	Voltage on $V_{REFH}$ pin		2.7		$V_{DD}$	V
	Voltage on $V_{REFL}$ pin		0V		$V_{DD} - 2.7$	V
	Resolution			0.4		%
INL	Integral Linearity Error			0.5	1	LSB
DNL	Differential Linearity Error			0.25	0.5	LSB
$R_{OUT}$	Buffer Output Resistance				10	$\Omega$
$I_{OUT}$	Buffer Output Current				3	mA
$TC_{RPOT}$	TC of Pot Resistance			300		ppm/ $^{\circ}C$
$TC_{RATIO}$	Ratiometric TC					ppm/ $^{\circ}C$
$R_{ISO}$	Isolation Resistance					$\Omega$
$V_N$	Noise					nV/ $\sqrt{Hz}$
$C_H/C_L$	Potentiometer Capacitances			8/8		pF
fc	Frequency Response	Passive Attenuator				MHz

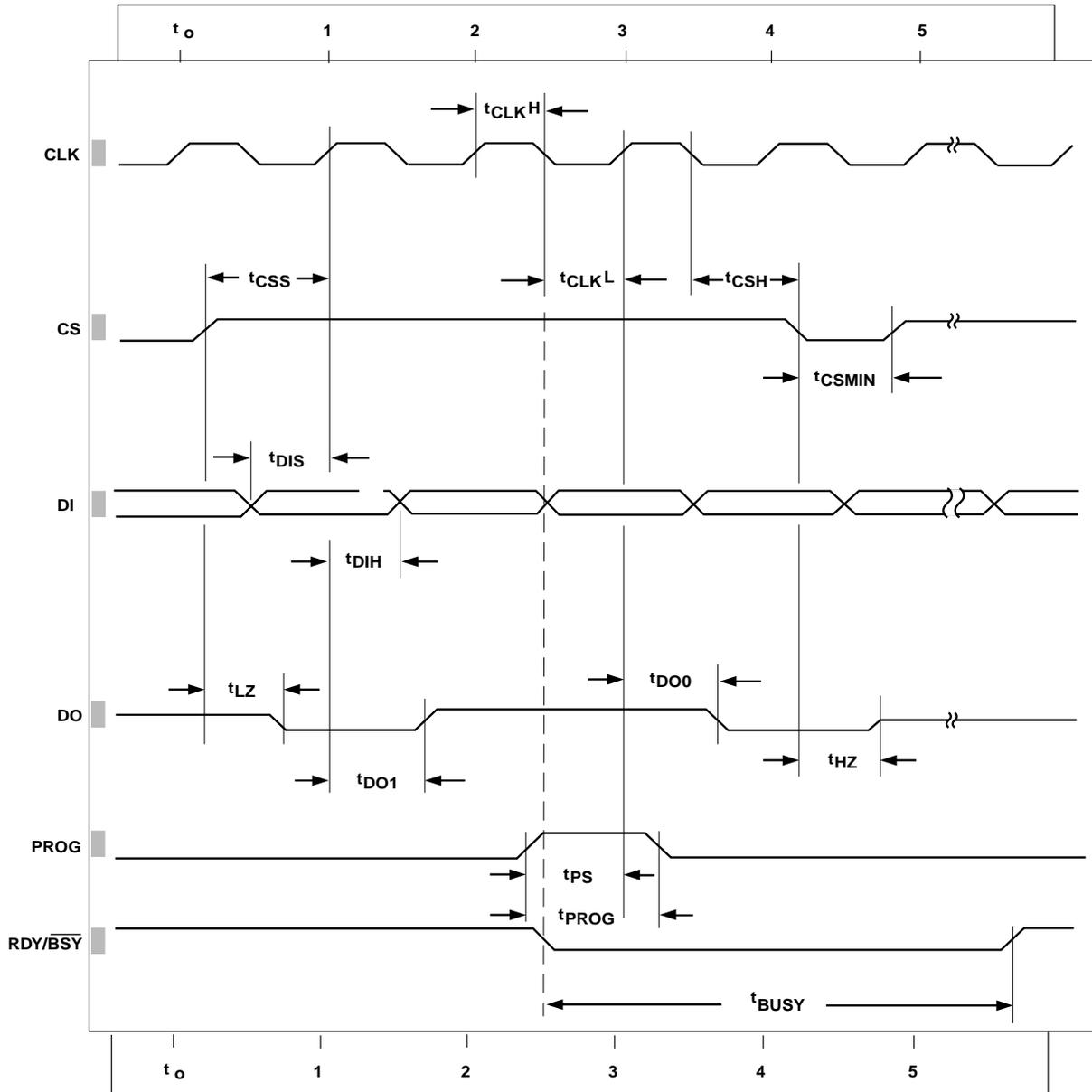
**AC ELECTRICAL CHARACTERISTICS:**

$V_{DD} = +2.7V$  to  $+5.5V$ ,  $V_{REFH} = V_{DD}$ ,  $V_{REFL} = 0V$ , unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Digital</b>						
$t_{CSMIN}$	Minimum CS Low Time		150	—	—	ns
$t_{CSS}$	CS Setup Time		100	—	—	ns
$t_{CSH}$	CS Hold Time	$C_L = 100pF$ , see note 1	0	—	—	ns
$t_{DIS}$	DI Setup Time		50	—	—	ns
$t_{DIH}$	DI Hold Time		50	—	—	ns
$t_{DO1}$	Output Delay to 1		—	—	150	ns
$t_{DO0}$	Output Delay to 0		—	—	150	ns
$t_{HZ}$	Output Delay to High-Z		—	400	—	ns
$t_{LZ}$	Output Delay to Low-Z	—	400	—	ns	
$t_{BUSY}$	Erase/Write Cycle Time		—	4	5	ms
$t_{PS}$	PROG Setup Time		150	—	—	ns
$t_{PROG}$	Minimum Pulse Width		700	—	—	ns
$t_{CLKH}$	Minimum CLK High Time		500	—	—	ns
$t_{CLKL}$	Minimum CLK Low Time		300	—	—	ns
fc	Clock Frequency		DC	—	1	MHz
<b>Analog</b>						
$t_{DS}$	DPP Settling Time to 1 LSB	$C_{LOAD} = 10 pF$ , $V_{DD} = +5V$	—	3	10	$\mu s$
		$C_{LOAD} = 10 pF$ , $V_{DD} = +3V$	—	6	10	$\mu s$

- NOTES:** 1. All timing measurements are defined at the point of signal crossing  $V_{DD} / 2$ .  
2. These parameters are periodically sampled and are not 100% tested.

A. C. TIMING DIAGRAM



## PIN DESCRIPTION

Pin	Name	Function
1	V <sub>DD</sub>	Power supply positive
2	CLK	Clock input pin
3	RDY/ $\overline{\text{BSY}}$	Ready/Busy output
4	CS	Chip select
5	DI	Serial data input pin
6	DO	Serial data output pin
7	PROG	EEPROM Programming Enable Input
8	GND	Power supply ground
9	V <sub>REFL1</sub>	Minimum DPP 1 output voltage
10	V <sub>REFL2</sub>	Minimum DPP 2 output voltage
11	V <sub>OUT2</sub>	DPP 2 output
12	V <sub>OUT1</sub>	DPP 1 output
13	V <sub>REFH2</sub>	Maximum DPP 2 output voltage
14	V <sub>REFH1</sub>	Maximum DPP 1 output voltage

DPP addressing is as follows:

DPP OUTPUT	A0	A1
V <sub>OUT1</sub>	0	1
V <sub>OUT2</sub>	1	1

## DEVICE OPERATION

The CAT522 is a dual 8-bit configured digitally programmable potentiometer (DPP) whose outputs can be programmed to any one of 256 individual voltage steps. Once programmed, these output settings are retained in non-volatile memory and will not be lost when power is removed from the chip. Upon power up the DPPs return to the settings stored in non-volatile memory. Each DPP can be written to and read from independently without effecting the output voltage during the read or write cycle. Each output can also be adjusted without altering the stored output setting, which is useful for testing new output settings before storing them in memory.

## DIGITAL INTERFACE

The CAT522 employs a 3 wire serial, Microwire-like control interface consisting of Clock (CLK), Chip Select (CS) and Data In (DI) inputs. For all operations, address and data are shifted in LSB first. In addition, all digital data must be preceded by a logic "1" as a start bit. The DPP address and data are clocked into the DI pin on the clock's rising edge. When sending multiple blocks of information a minimum of two clock cycles is required between the last block sent and the next start bit.

Multiple devices may share a common input data line by selectively activating the CS control of the desired IC. Data Outputs (DO) can also share a common line because the DO pin is Tri-Stated and returns to a high impedance when not in use.

## CHIP SELECT

Chip Select (CS) enables and disables the CAT522's read and write operations. When CS is high data may be read to or from the chip, and the Data Output (DO) pin is active. Data loaded into the DPP control registers will remain in effect until CS goes low. Bringing CS to a logic low returns all DPP outputs to the settings stored in non-volatile memory and switches DO to its high impedance Tri-State mode.

Because CS functions like a reset the CS pin has been desensitized with a 30 ns to 90 ns filter circuit to prevent noise spikes from causing unwanted resets and the loss of volatile data.

## CLOCK

The CAT522's clock controls both data flow in and out of the IC and non-volatile memory cell programming. Serial data is shifted into the DI pin and out of the DO pin on the clock's rising edge. While it is not necessary for the clock to be running between data transfers, the clock must be operating in order to write to non-volatile memory, even though the data being saved may already be resident in the DPP wiper control register.

No clock is necessary upon system power-up. The CAT522's internal power-on reset circuitry loads data from non-volatile memory to the DPPs without using the external clock.

As data transfers are edge triggered clean clock transitions are necessary to avoid falsely clocking data into the control registers. Standard CMOS and TTL logic families work well in this regard and it is recommended that any mechanical switches used for breadboarding or device evaluation purposes be debounced by a flip-flop or other suitable debouncing circuit.

**V<sub>REF</sub>**

V<sub>REF</sub>, the voltage applied between pins V<sub>REFH</sub> & V<sub>REFL</sub>, sets the configured DPP's Zero to Full Scale output range where V<sub>REFL</sub> = Zero and V<sub>REFH</sub> = Full Scale. V<sub>REF</sub> can span the full power supply range or just a fraction of it. In typical applications V<sub>REFH</sub> & V<sub>REFL</sub> are connected across the power supply rails. When using less than the full supply voltage be mindful of the limits placed on V<sub>REFL</sub> and V<sub>REFH</sub> as specified in the References section of DC Electrical Characteristics.

**READY/BSY**

When saving data to non-volatile memory, the Ready/Busy output (RDY/BSY) signals the start and duration of the non-volatile erase/write cycle. Upon receiving a command to store data (PROG goes high) RDY/BSY goes low and remains low until the programming cycle is complete. During this time the CAT522 will ignore any data appearing at DI and no data will be output on DO.

RDY/BSY is internally ANDed with a low voltage detector circuit monitoring V<sub>DD</sub>. If V<sub>DD</sub> is below the minimum value required for non-volatile programming, RDY/BSY will remain high following the program command indicating a failure to record the desired data in non-volatile memory.

**DATA OUTPUT**

Data is output serially by the CAT522, LSB first, via the Data Out (DO) pin following the reception of a start bit and two address bits by the Data Input (DI). DO becomes active whenever CS goes high and resumes its high impedance Tri-State mode when CS returns low. Tri-Stating the DO pin allows several 522s to share a

single serial data line and simplifies interfacing multiple 522s to a microprocessor.

**WRITING TO MEMORY**

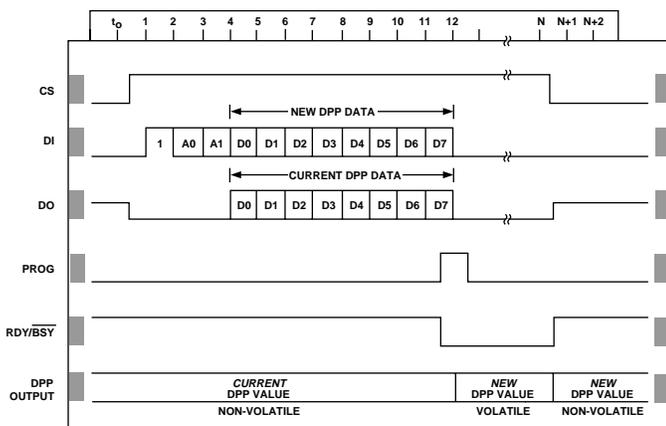
Programming the CAT522's non-volatile memory is accomplished through the control signals: Chip Select (CS) and Program (PROG). With CS high, a start bit followed by a two bit DPP address and eight data bits are clocked into the DPP wiper control register via the DI pin. Data enters on the clock's rising edge. The DPP output changes to its new setting on the clock cycle following D7, the last data bit.

Programming is accomplished by bringing PROG high sometime after the start bit and at least 150 ns prior to the rising edge of the clock cycle immediately following the D7 bit. Two clock cycles after the D7 bit the DPP wiper control register will be ready to receive the next set of address and data bits. The clock must be kept running throughout the programming cycle. Internal control circuitry takes care of generating and ramping up the programming voltage for data transfer to the non-volatile cells. The CAT522's non-volatile memory cells will endure over 1,000,000 write cycles and will retain data for a minimum of 100 years without being refreshed.

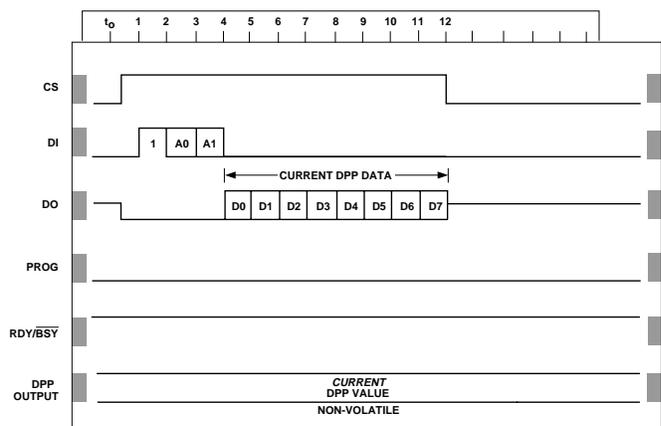
**READING DATA**

Each time data is transferred into a DPP control register currently held data is shifted out via the D0 pin, thus in every data transaction a read cycle occurs. Note, however, that the reading process is destructive. Data must be removed from the register in order to be read. Figure 2 depicts a Read Only cycle in which no change occurs in the DPP's output. This feature allows  $\mu$ Ps to poll DPPs for their current setting without disturbing the output voltage but it assumes that the setting being read is also stored in non-volatile memory so that it can be restored at the end of the read cycle. In Figure 2 CS returns low before the 13<sup>th</sup> clock cycle completes. In doing so the non-volatile memory setting is reloaded into the DPP wiper control register. Since this value is the

**Figure 1. Writing to Memory**



**Figure 2. Reading from Memory**



same as that which had been there previously no change in the DPP's output is noticed. Had the value held in the control register been different from that stored in non-volatile memory then *a change would occur* at the read cycle's conclusion.

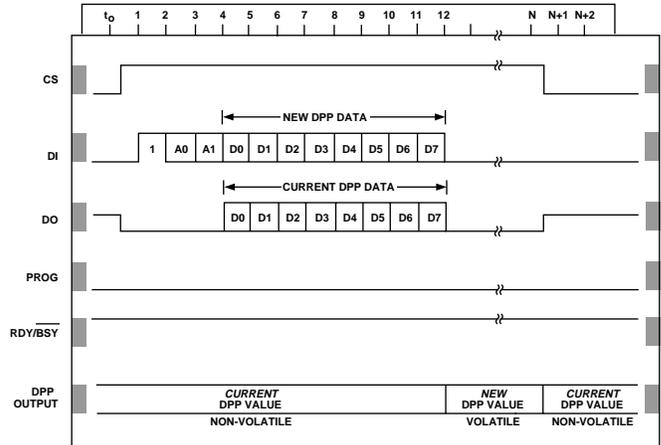
**TEMPORARILY CHANGE OUTPUT**

The CAT522 allows temporary changes in DPP's output to be made without disturbing the settings retained in non-volatile memory. This feature is particularly useful when testing for a new output setting and allows for user adjustment of preset or default values without losing the original factory settings.

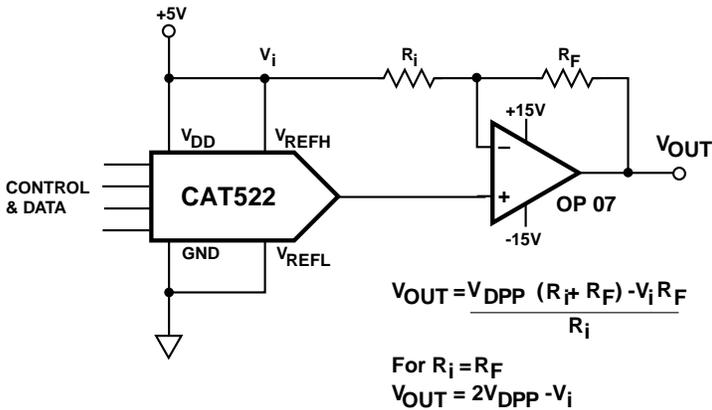
Figure 3 shows the control and data signals needed to effect a temporary output change. DPP wiper settings may be changed as many times as required and can be made to any of the two DPPs in any order or sequence. The temporary setting(s) remain in effect long as CS remains high. When CS returns low all two DPPs will return to the output values stored in non-volatile memory.

When it is desired to save a new setting acquired using this feature, the new value must be reloaded into the DPP wiper control register prior to programming. This is because the CAT522's internal control circuitry discards from the programming register the new data two clock cycles after receiving it if no PROG signal is received.

**Figure 3. Temporary Change in Output**

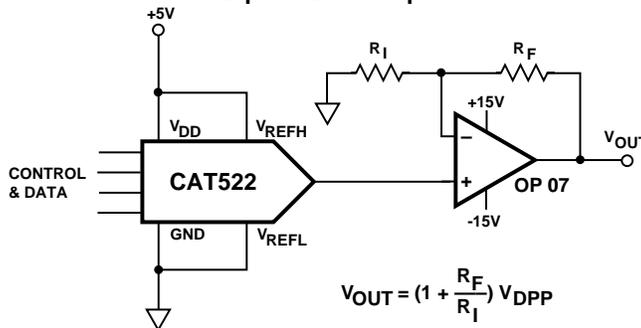


**APPLICATION CIRCUITS**



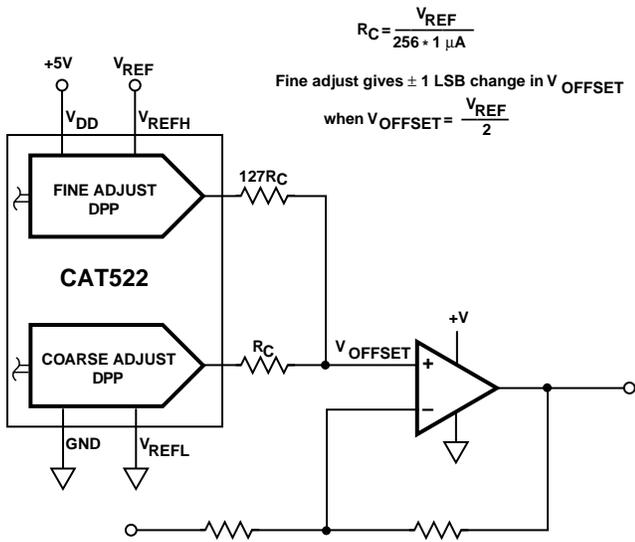
DPP INPUT		DPP OUTPUT		ANALOG OUTPUT
MSB	LSB	$V_{DPP} = \frac{CODE}{255} (V_{FS} - V_{ZERO}) + V_{ZERO}$		
		$V_{FS} = 0.99 V_{REF}$		$V_{REF} = 5V$ $R_i = R_F$
		$V_{ZERO} = 0.01 V_{REF}$		
1111	1111	$\frac{255}{255}$	$(.98 V_{REF}) + .01 V_{REF} = .990 V_{REF}$	$V_{OUT} = +4.90V$
1000	0000	$\frac{128}{255}$	$(.98 V_{REF}) + .01 V_{REF} = .502 V_{REF}$	$V_{OUT} = +0.02V$
0111	1111	$\frac{127}{255}$	$(.98 V_{REF}) + .01 V_{REF} = .498 V_{REF}$	$V_{OUT} = -0.02V$
0000	0001	$\frac{1}{255}$	$(.98 V_{REF}) + .01 V_{REF} = .014 V_{REF}$	$V_{OUT} = -4.86V$
0000	0000	$\frac{0}{255}$	$(.98 V_{REF}) + .01 V_{REF} = .010 V_{REF}$	$V_{OUT} = -4.90V$

**Bipolar DPP Output**

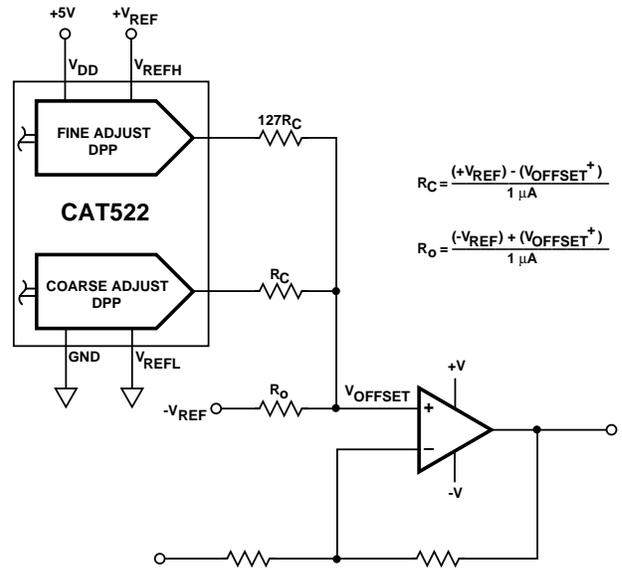


**Amplified DPP Output**

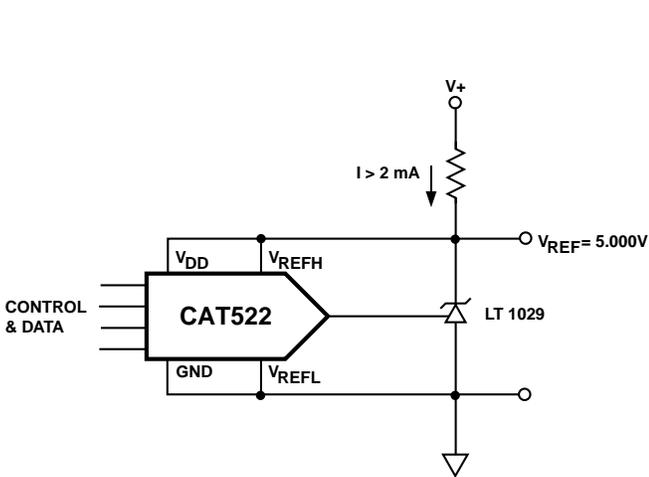
APPLICATION CIRCUITS (Cont.)



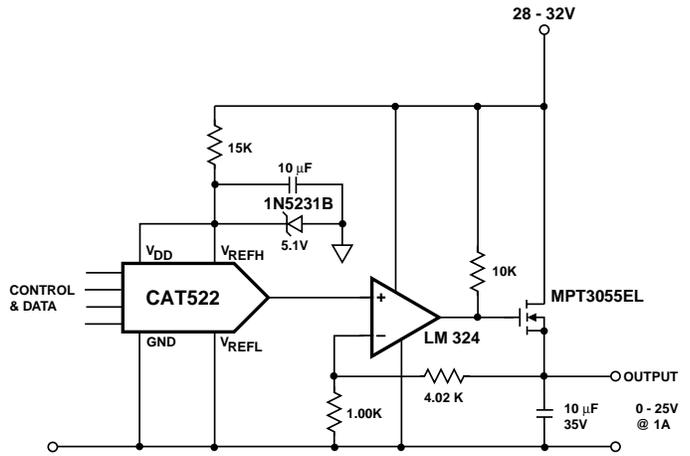
Coarse-Fine Offset Control by Averaging DPP Outputs for Single Power Supply Systems



Coarse-Fine Offset Control by Averaging DPP Outputs for Dual Power Supply Systems

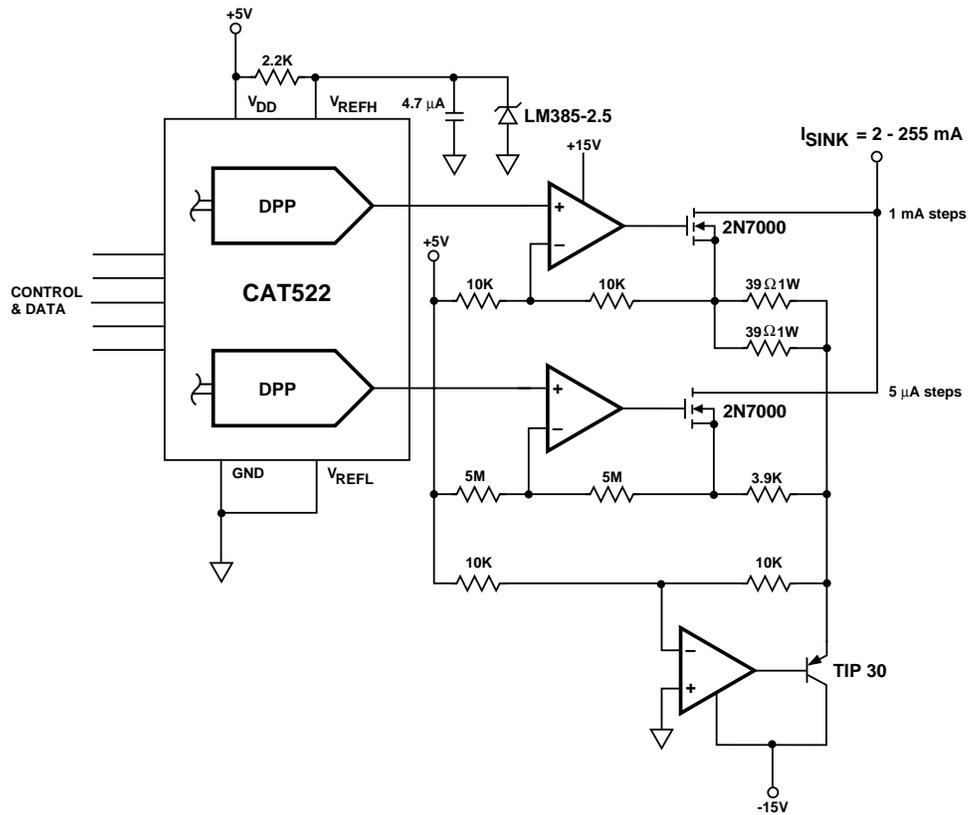


Digitally Trimmed Voltage Reference

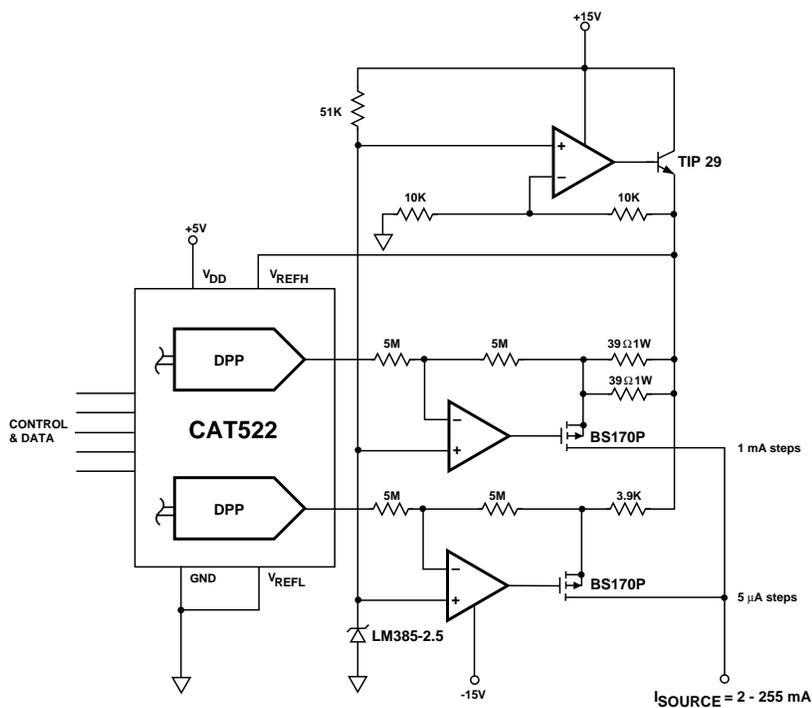


Digitally Controlled Voltage Reference

APPLICATION CIRCUITS (Cont.)

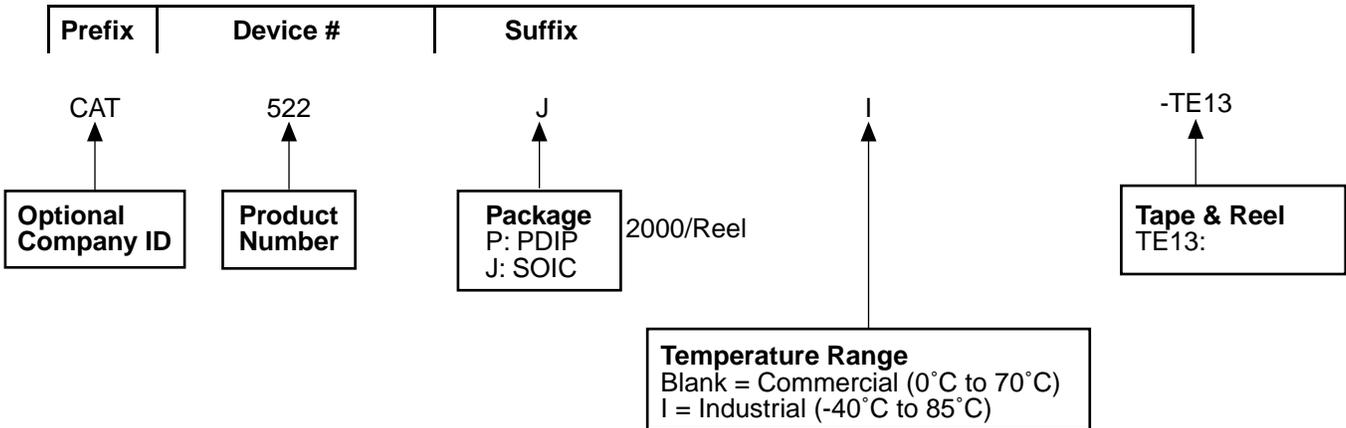


Current Sink with 4 Decades of Resolution



Current Source with 4 Decades of Resolution

**ORDERING INFORMATION**



Notes:

(1) The device used in the above example is a CAT522JI-TE13 (SOIC, Industrial Temperature, Tape & Reel)

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DPP™ AE²™

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 Revision: B  
 Issue date: 03/21/02  
 Type: Final



# CAT523

## Configured Digitally Programmable Potentiometer (DPP™): Programmable Voltage Applications

### FEATURES

- Two 8-bit DPPs configured as programmable voltage sources in DAC-like applications
- Common reference inputs
- Non-volatile NVRAM memory wiper storage
- Output voltage range includes both supply rails
- 2 independently addressable buffered output wipers
- 1 LSB accuracy, high resolution
- Serial microwire-like interface
- Single supply operation: 2.7V - 5.5V
- Setting read-back without effecting outputs

### APPLICATIONS

- Automated product calibration.
- Remote control adjustment of equipment
- Offset, gain and zero adjustments in self-calibrating and adaptive control systems.
- Tamper-proof calibrations.
- DAC (with memory) substitute

### DESCRIPTION

The CAT523 is a dual, 8-bit digitally-programmable potentiometer (DPP™) configured for programmable voltage and DAC-like applications. Intended for final calibration of products such as camcorders, fax machines and cellular telephones on automated high volume production lines, it is also well suited for systems capable of self calibration, and applications where equipment which is either difficult to access or in a hazardous environment, requires periodic adjustment.

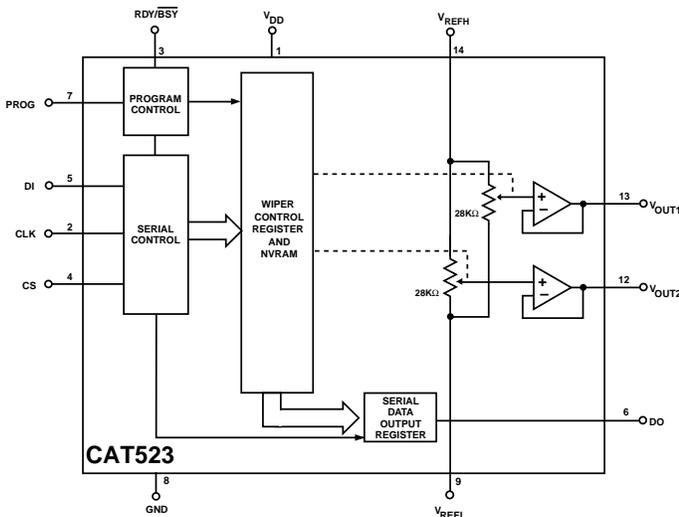
The two independently programmable DPPs have a common output voltage range which includes both supply rails. The wipers are buffered by rail to rail op amps. Wiper settings, stored in non-volatile NVRAM memory, are not lost when the device is powered down and are automatically reinstated when power is returned. Each wiper can be dithered to test new output

values without effecting the stored settings and stored settings can be read back without disturbing the DPP's output.

Control of the CAT523 is accomplished with a simple 3-wire, Microwire-like serial interface. A Chip Select pin allows several CAT523's to share a common serial interface and communication back to the host controller is via a single serial data line thanks to the CAT523's Tri-Stated Data Output pin. A RDY/BSY output working in concert with an internal low voltage detector signals proper operation of non-volatile NVRAM memory Erase/Write cycle.

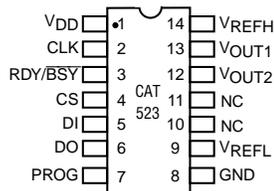
The CAT523 is available in the 0°C to 70°C Commercial and -40°C to + 85°C Industrial operating temperature ranges and offered in 14-pin plastic DIP and SOIC mount packages.

### FUNCTIONAL DIAGRAM

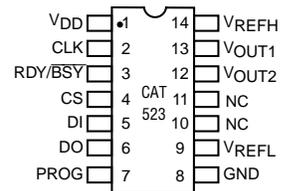


### PIN CONFIGURATION

#### DIP Package (P)



#### SOIC Package (J)



**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage*		
$V_{DD}$ to GND		-0.5V to +7V
Inputs		
CLK to GND		-0.5V to $V_{DD} + 0.5V$
CS to GND		-0.5V to $V_{DD} + 0.5V$
DI to GND		-0.5V to $V_{DD} + 0.5V$
RDY/BSY to GND		-0.5V to $V_{DD} + 0.5V$
PROG to GND		-0.5V to $V_{DD} + 0.5V$
$V_{REFH}$ to GND		-0.5V to $V_{DD} + 0.5V$
$V_{REFL}$ to GND		-0.5V to $V_{DD} + 0.5V$
Outputs		
$D_0$ to GND		-0.5V to $V_{DD} + 0.5V$
$V_{OUT}$ 1– 4 to GND		-0.5V to $V_{DD} + 0.5V$

Operating Ambient Temperature

Commercial ('C' or Blank suffix)	0°C to +70°C
Industrial ('I' suffix)	-40°C to +85°C
Junction Temperature	+150°C
Storage Temperature	-65°C to +150°C
Lead Soldering (10 sec max)	+300°C

\* Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Absolute Maximum Ratings are limited values applied individually while other parameters are within specified operating conditions, and functional operation at any of these conditions is NOT implied. Device performance and reliability may be impaired by exposure to absolute rating conditions for extended periods of time.

**RELIABILITY CHARACTERISTICS**

Symbol	Parameter	Min	Max	Units	Test Method
$V_{ZAP}^{(1)}$	ESD Susceptibility	2000		Volts	MIL-STD-883, Test Method 3015
$I_{LTH}^{(1)(2)}$	Latch-Up	100		mA	JEDEC Standard 17

- NOTES:** 1. This parameter is tested initially and after a design or process change that affects the parameter.  
 2. Latch-up protection is provided for stresses up to 100mA on address and data pins from -1V to  $V_{CC} + 1V$ .

**POWER SUPPLY**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{DD1}$	Supply Current (Read)	Normal Operating	—	400	600	$\mu A$
$I_{DD2}$	Supply Current (Write)	Programming, $V_{DD} = 5V$	—	1600	2500	$\mu A$
		$V_{DD} = 3V$	—	1000	1600	$\mu A$
$V_{DD}$	Operating Voltage Range		2.7	—	5.5	V

**LOGIC INPUTS**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{IH}$	Input Leakage Current	$V_{IN} = V_{DD}$	—	—	10	$\mu A$
$I_{IL}$	Input Leakage Current	$V_{IN} = 0V$	—	—	-10	$\mu A$
$V_{IH}$	High Level Input Voltage		2	—	$V_{DD}$	V
$V_{IL}$	Low Level Input Voltage		0	—	0.8	V

**LOGIC OUTPUTS**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{OH}$	High Level Output Voltage	$I_{OH} = -40\mu A$	$V_{DD} - 0.3$	—	—	V
$V_{IL}$	Low Level Output Voltage	$I_{OL} = 1\text{ mA}, V_{DD} = +5V$	—	—	0.4	V
		$I_{OL} = 0.4\text{ mA}, V_{DD} = +3V$	—	—	0.4	V

**POTENTIOMETER CHARACTERISTICS**

$V_{DD} = +2.7V$  to  $+5.5V$ ,  $V_{REFH} = V_{DD}$ ,  $V_{REFL} = 0V$ , unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$R_{POT}$	Potentiometer Resistance			28		$k\Omega$
	$R_{POT}$ to $R_{POT}$ Match		—	$\pm 0.5$	$\pm 1$	%
	Pot Resistance Tolerance				$\pm 15$	%
	Voltage on $V_{REFH}$ pin		2.7		$V_{DD}$	V
	Voltage on $V_{REFL}$ pin		0V		$V_{DD} - 2.7$	V
	Resolution			0.4		%
INL	Integral Linearity Error			0.5	1	LSB
DNL	Differential Linearity Error			0.25	0.5	LSB
$R_{OUT}$	Buffer Output Resistance				10	$\Omega$
$I_{OUT}$	Buffer Output Current				3	mA
$TC_{RPOT}$	TC of Pot Resistance			300		ppm/ $^{\circ}C$
$TC_{RATIO}$	Ratiometric TC					ppm/ $^{\circ}C$
$R_{ISO}$	Isolation Resistance					$\Omega$
$V_N$	Noise					nV/ $\sqrt{Hz}$
$C_H/C_L$	Potentiometer Capacitances			8/8		pF
fc	Frequency Response	Passive Attenuator				MHz

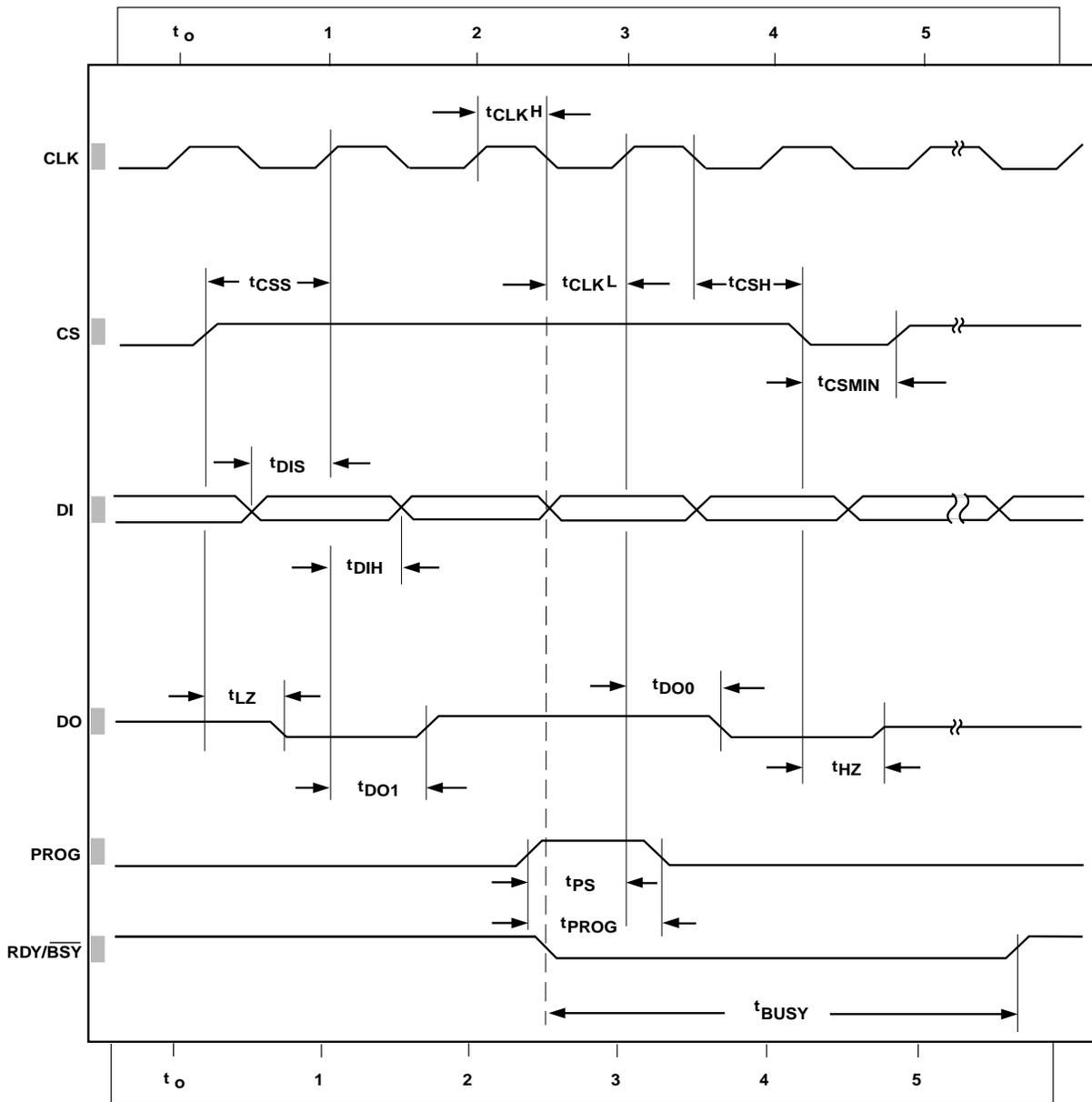
**AC ELECTRICAL CHARACTERISTICS:**

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Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Digital</b>						
$t_{CSMIN}$	Minimum CS Low Time		150	—	—	ns
$t_{CSS}$	CS Setup Time		100	—	—	ns
$t_{CSH}$	CS Hold Time	$C_L = 100pF$ , see note 1	0	—	—	ns
$t_{DIS}$	DI Setup Time		50	—	—	ns
$t_{DIH}$	DI Hold Time		50	—	—	ns
$t_{DO1}$	Output Delay to 1		—	—	150	ns
$t_{DO0}$	Output Delay to 0		—	—	150	ns
$t_{HZ}$	Output Delay to High-Z		—	400	—	ns
$t_{LZ}$	Output Delay to Low-Z	—	400	—	ns	
$t_{BUSY}$	Erase/Write Cycle Time		—	4	5	ms
$t_{PS}$	PROG Setup Time		150	—	—	ns
$t_{PROG}$	Minimum Pulse Width		700	—	—	ns
$t_{CLKH}$	Minimum CLK High Time		500	—	—	ns
$t_{CLKL}$	Minimum CLK Low Time		300	—	—	ns
$f_C$	Clock Frequency		DC	—	1	MHz
<b>Analog</b>						
$t_{DS}$	DPP Settling Time to 1 LSB	$C_{LOAD} = 10 pF$ , $V_{DD} = +5V$	—	3	10	$\mu s$
		$C_{LOAD} = 10 pF$ , $V_{DD} = +3V$	—	6	10	$\mu s$

- NOTES:** 1. All timing measurements are defined at the point of signal crossing  $V_{DD} / 2$ .  
2. These parameters are periodically sampled and are not 100% tested.

A. C. TIMING DIAGRAM



## PIN DESCRIPTION

Pin	Name	Function
1	V <sub>DD</sub>	Power supply positive.
2	CLK	Clock input pin.Clock input pin.
3	RDY/BSY	Ready/Busy Output
4	CS	Chip Select
5	DI	Serial data input pin.
6	DO	Serial data output pin.
7	PROG	EEPROM Programming Enable Input
8	GND	Power supply ground.
9	V <sub>REFL</sub>	Minimum DPP output voltage.
10	NC	No Connect.
11	NC	No Connect.
12	V <sub>OUT2</sub>	DPP output channel 2.
13	V <sub>OUT1</sub>	DPP output channel 1.
14	V <sub>REFH</sub>	Maximum DPP output voltage.

DPP addressing is as follows:

DPP OUTPUT	A0	A1
V <sub>OUT1</sub>	0	0
V <sub>OUT2</sub>	1	0

## DEVICE OPERATION

The CAT523 is a dual 8-bit configured digitally programmable potentiometer (DPP) whose outputs can be programmed to any one of 256 individual voltage steps. Once programmed, these output settings are retained in non-volatile memory and will not be lost when power is removed from the chip. Upon power up the DPPs return to the settings stored in non-volatile memory. Each DPP can be written to and read from independently without effecting the output voltage during the read or write cycle. Each output can also be temporarily adjusted without changing the stored output setting, which is useful for testing new output settings before storing them in memory.

## DIGITAL INTERFACE

The CAT523 employs a 3 wire, Microwire-like, serial control interface consisting of Clock (CLK), Chip Select (CS) and Data In (DI) inputs. For all operations, address and data are shifted in LSB first. In addition, all digital data must be preceded by a logic "1" as a start bit. The DPP address and data are clocked into the DI pin on the clock's rising edge. When sending multiple blocks of information a minimum of two clock cycles is required between the last block sent and the next start bit.

Multiple devices may share a common input data line by selectively activating the CS control of the desired IC. Data Outputs (DO) can also share a common line because the DO pin is Tri-States and returns to a high impedance when not in use.

## CHIP SELECT

Chip Select (CS) enables and disables the CAT523's

read and write operations. When CS is high data may be read to or from the chip, and the Data Output (DO) pin is active. Data loaded into the DPP control registers will remain in effect until CS goes low. Bringing CS to a logic low returns all DPP outputs to the settings stored in non-volatile memory and switches DO to its high impedance Tri-State mode.

Because CS functions like a reset the CS pin has been equipped with a 30 ns to 90 ns filter circuit to prevent noise spikes from causing unwanted resets and the loss of volatile data.

## CLOCK

The CAT523's clock controls both data flow in and out of the IC and non-volatile memory cell programming. Serial data is shifted into the DI pin and out of the DO pin on the clock's rising edge. While it is not necessary for the clock to be running between data transfers, the clock must be operating in order to write to non-volatile memory, even though the data being saved may already be resident in the DPP wiper control register.

No clock is necessary upon system power-up. The CAT523's internal power-on reset circuitry loads data from non-volatile memory to the DPPs without using the external clock.

As data transfers are edge triggered clean clock transitions are necessary to avoid falsely clocking data into the control registers. Standard CMOS and TTL logic families work well in this regard and it is recommended that any mechanical switches used for breadboarding or device evaluation purposes be debounced by a flip-flop or other suitable debouncing circuit.

**V<sub>REF</sub>**

V<sub>REF</sub>, the voltage applied between pins V<sub>REFH</sub> and V<sub>REFL</sub>, sets the DPP's Zero to Full Scale output range where V<sub>REFL</sub> = Zero and V<sub>REFH</sub> = Full Scale. V<sub>REF</sub> can span the full power supply range or just a fraction of it. In typical applications V<sub>REFH</sub> and V<sub>REFL</sub> are connected across the power supply rails. When using less than the full supply voltage V<sub>REFH</sub> is restricted to voltages between V<sub>DD</sub> and V<sub>DD</sub>/2 and V<sub>REFL</sub> to voltages between GND and V<sub>DD</sub>/2.

**READY/BSY**

When saving data to non-volatile memory, the Ready/Busy output (RDY/BSY) signals the start and duration of the non-volatile erase/write cycle. Upon receiving a command to store data (PROG goes high) RDY/BSY goes low and remains low until the programming cycle is complete. During this time the CAT523 will ignore any data appearing at DI and no data will be output on DO.

RDY/BSY is internally ANDed with a low voltage detector circuit monitoring V<sub>DD</sub>. If V<sub>DD</sub> is below the minimum value required for non-volatile programming, RDY/BSY will remain high following the program command indicating a failure to record the desired data in non-volatile memory.

**DATA OUTPUT**

Data is output serially by the CAT523, LSB first, via the Data Out (DO) pin following the reception of a start bit and two address bits by the Data Input (DI). DO becomes active whenever CS goes high and resumes its high impedance Tri-State mode when CS returns low. Tri-Stating the DO pin allows several 523s to share a single serial data line and simplifies interfacing multiple 523s to a microprocessor.

**WRITING TO MEMORY**

Programming the CAT523's non-volatile memory is accomplished through the control signals: Chip Select (CS) and Program (PROG). With CS high, a start bit

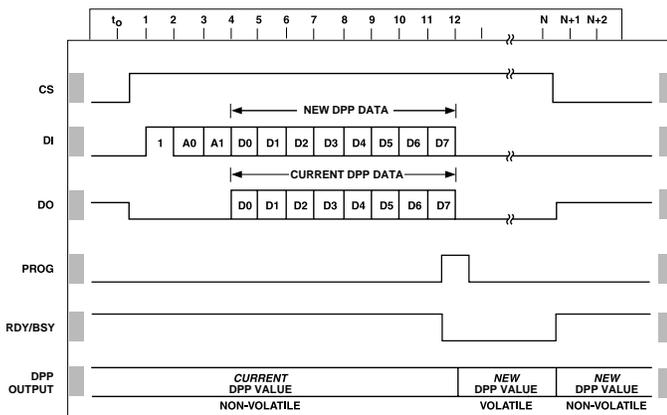
followed by a two bit DPP address and eight data bits are clocked into the DPP control register via the DI pin. Data enters on the clock's rising edge. The DPP output changes to its new setting on the clock cycle following D7, the last data bit.

Programming is achieved by bringing PROG high for a minimum of 3 ms. PROG must be brought high sometime after the start bit and at least 150 ns prior to the rising edge of the clock cycle immediately following the D7 bit. Two clock cycles after the D7 bit the DAC control register will be ready to receive the next set of address and data bits. The clock must be kept running throughout the programming cycle. Internal control circuitry takes care of ramping the programming voltage for data transfer to the non-volatile memory cells. The CAT523's non-volatile memory cells will endure over 100,000 write cycles and will retain data for a minimum of 100 years without being refreshed.

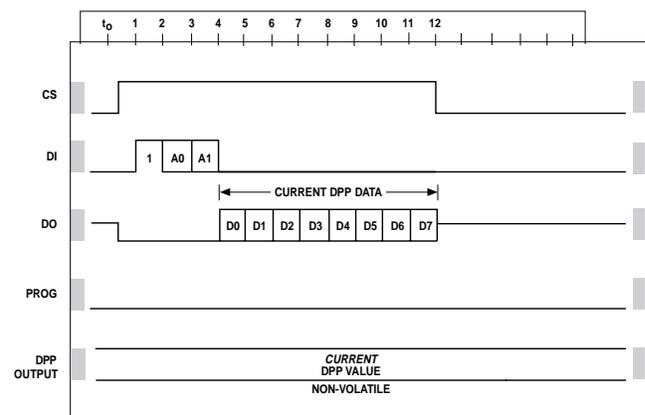
**READING DATA**

Each time data is transferred into a DPP wiper control register currently held data is shifted out via the D0 pin, thus in every data transaction a read cycle occurs. Note, however, that the reading process is destructive. Data must be removed from the register in order to be read. Figure 2 depicts a Read Only cycle in which no change occurs in the DPP's output. This feature allows  $\mu$ Ps to poll DPPs for their current setting without disturbing the output voltage but it assumes that the setting being read is also stored in non-volatile memory so that it can be restored at the end of the read cycle. In Figure 2 CS returns low before the 13<sup>th</sup> clock cycle completes. In doing so the non-volatile memory setting is reloaded into the DPP wiper control register.

**Figure 1. Writing to Memory**



**Figure 2. Reading from Memory**



Since this value is the same as that which had been there previously no change in the DPP's output is noticed. Had the value held in the control register been different from that stored in non-volatile memory then a *change would occur* at the read cycle's conclusion.

**TEMPORARILY CHANGE OUTPUT**

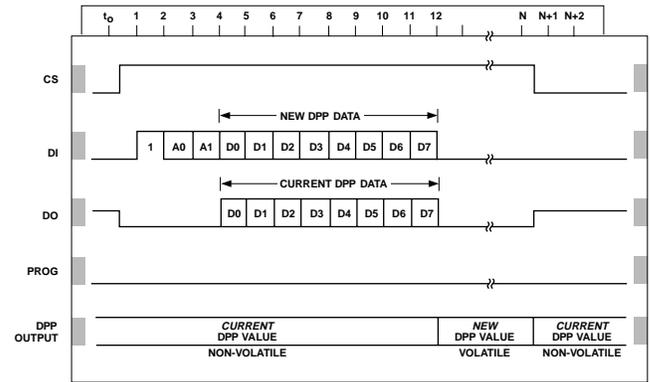
The CAT523 allows temporary changes in DPP's output to be made without disturbing the settings retained in non-volatile memory. This feature is particularly useful when testing for a new output setting and allows for user adjustment of preset or default values without losing the original factory settings.

Figure 3 shows the control and data signals needed to effect a temporary output change. DPP wiper settings may be changed as many times as required and can be made to any of the two DPPs in any order or sequence. The temporary setting(s) remain in effect long as CS remains high. When CS returns low all two DPPs will return to the output values stored in non-volatile memory.

When it is desired to save a new setting acquired using

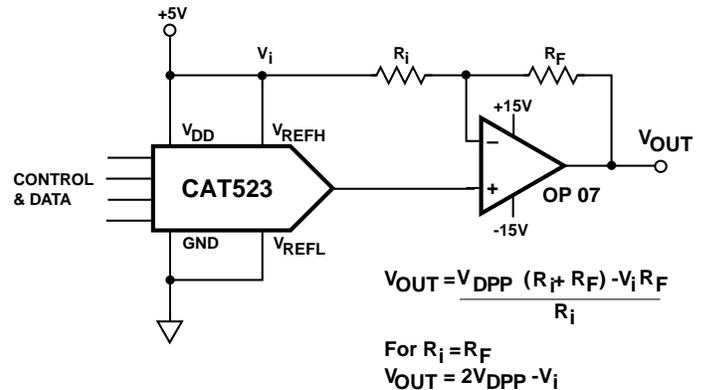
this feature, the new value must be reloaded into the DPP wiper control register prior to programming. This is because the CAT523's internal control circuitry discards the new data from the programming register two clock cycles after receiving it (after reception is complete) if no PROG signal is received.

**Figure 3. Temporary Change in Output**

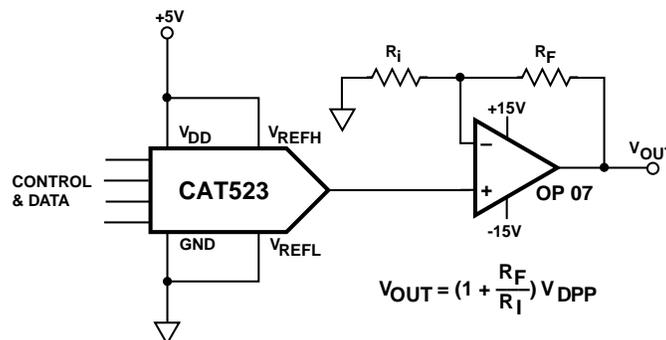


**APPLICATION CIRCUITS**

DPP INPUT		DPP OUTPUT	ANALOG OUTPUT
		$V_{DPP} = \frac{CODE}{255} (V_{FS} - V_{ZERO}) + V_{ZERO}$	
		$V_{FS} = 0.99 V_{REF}$	$V_{REF} = 5V$
		$V_{ZERO} = 0.01 V_{REF}$	$R_i = R_f$
MSB	LSB		
1111	1111	$\frac{255}{255} (.98 V_{REF}) + .01 V_{REF} = .990 V_{REF}$	$V_{OUT} = +4.90V$
1000	0000	$\frac{128}{255} (.98 V_{REF}) + .01 V_{REF} = .502 V_{REF}$	$V_{OUT} = +0.02V$
0111	1111	$\frac{127}{255} (.98 V_{REF}) + .01 V_{REF} = .498 V_{REF}$	$V_{OUT} = -0.02V$
0000	0001	$\frac{1}{255} (.98 V_{REF}) + .01 V_{REF} = .014 V_{REF}$	$V_{OUT} = -4.86V$
0000	0000	$\frac{0}{255} (.98 V_{REF}) + .01 V_{REF} = .010 V_{REF}$	$V_{OUT} = -4.90V$

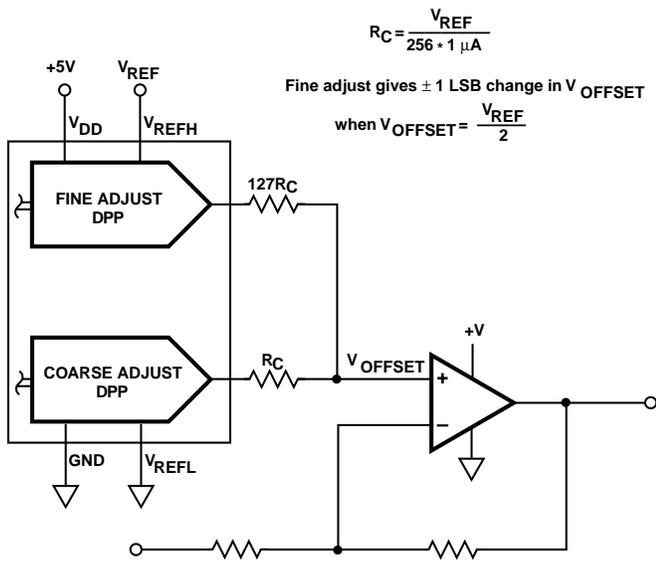


**Bipolar DPP Output**

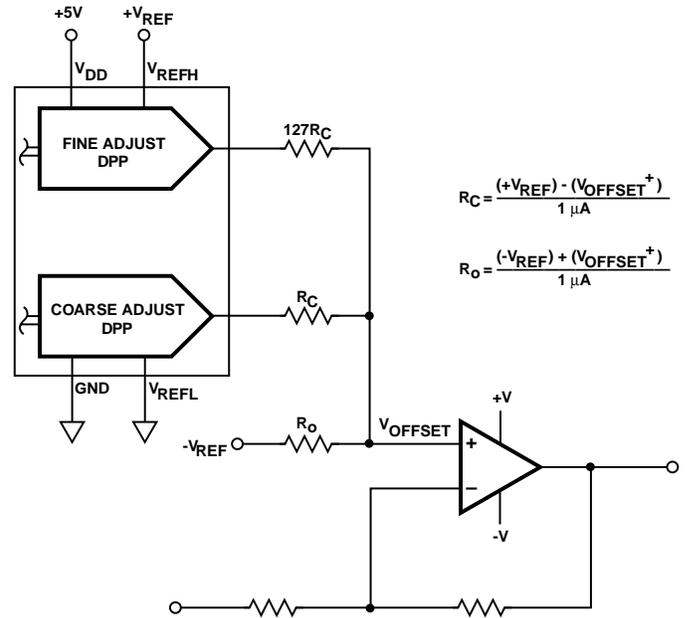


**Amplified DPP Output**

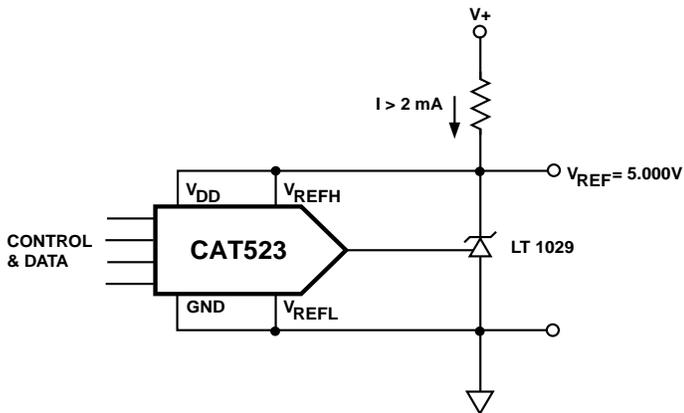
APPLICATION CIRCUITS (Cont.)



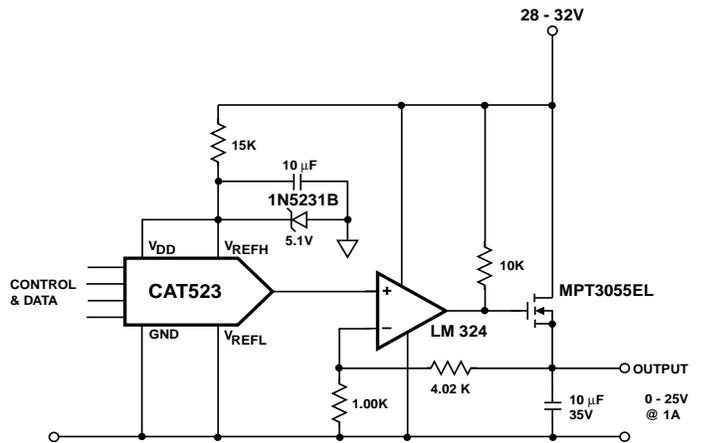
Coarse-Fine Offset Control by Averaging DPP Outputs for Single Power Supply Systems



Coarse-Fine Offset Control by Averaging DPP Outputs for Dual Power Supply Systems

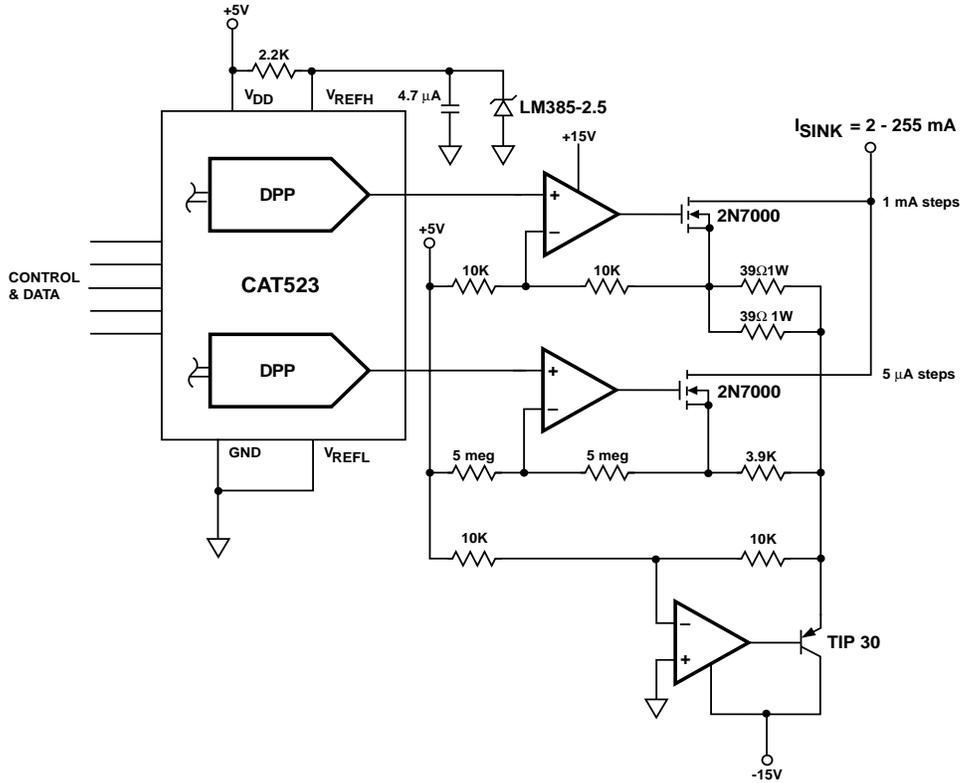


Digitally Trimmed Voltage Reference

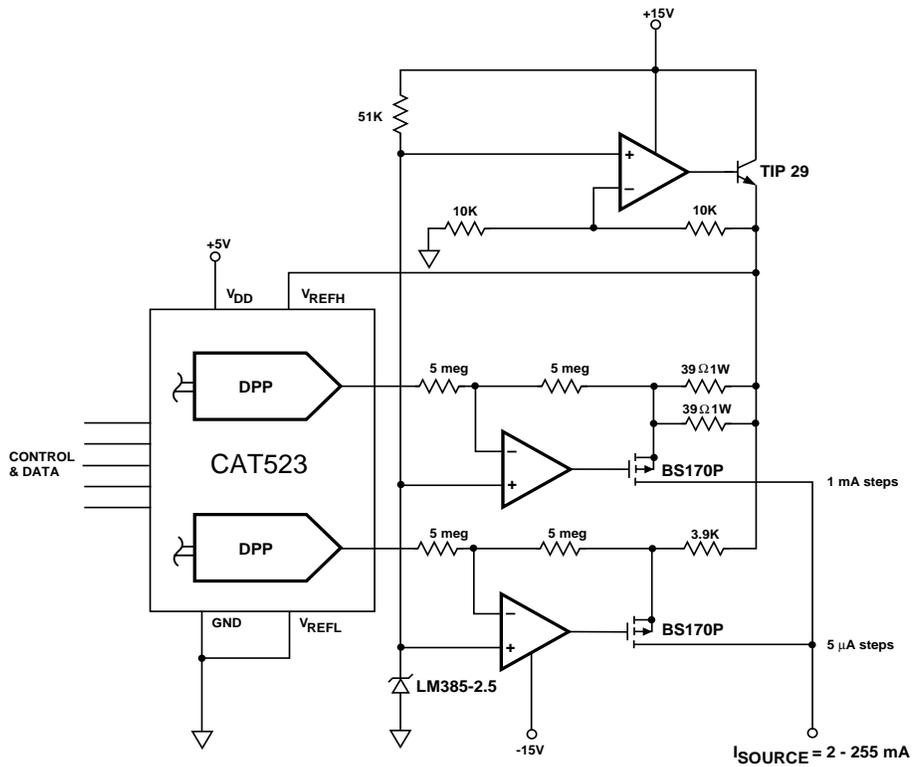


Digitally Controlled Voltage Reference

APPLICATION CIRCUITS (Cont.)

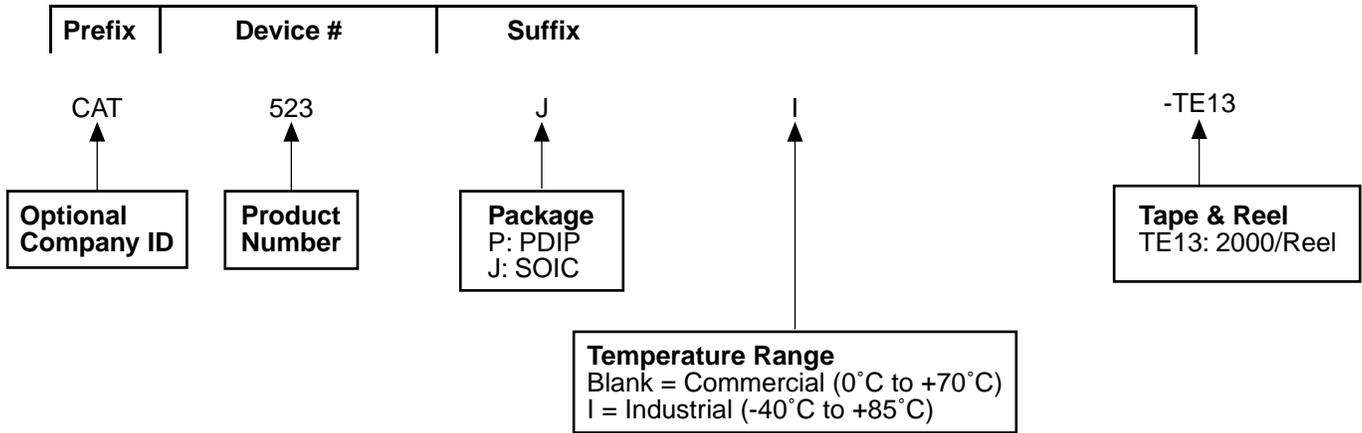


Current Sink with 4 Decades of Resolution



Current Source with 4 Decades of Resolution

**ORDERING INFORMATION**



**Notes:**

(1) The device used in the above example is a CAT523JI-TE13 (SOIC, Industrial Temperature, Tape & Reel)

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# CAT524

## Configured Digitally Programmable Potentiometer (DPP™): Programmable Voltage Applications

### FEATURES

- Four 8-bit DPPs configured as programmable voltage sources in DAC-like applications
- Common reference inputs
- Buffered wiper outputs
- Non-volatile NVRAM memory wiper storage
- Output voltage range includes both supply rails
- 4 independently addressable buffered output wipers
- 1 LSB accuracy, high resolution
- Serial Microwire-like interface
- Single supply operation: 2.7V - 5.5V
- Setting read-back without effecting outputs

### APPLICATIONS

- Automated product calibration
- Remote control adjustment of equipment
- Offset, gain and zero adjustments in self-calibrating and adaptive control systems
- Tamper-proof calibrations
- DAC (with memory) substitute

### DESCRIPTION

The CAT524 is a quad, 8-bit digitally-programmable potentiometer (DPP™) configured for programmable voltage and DAC-like applications. Intended for final calibration of products such as camcorders, fax machines and cellular telephones on automated high volume production lines, it is also well suited for self-calibrating systems and for applications where equipment which requires periodic adjustment is either difficult to access or in a hazardous environment.

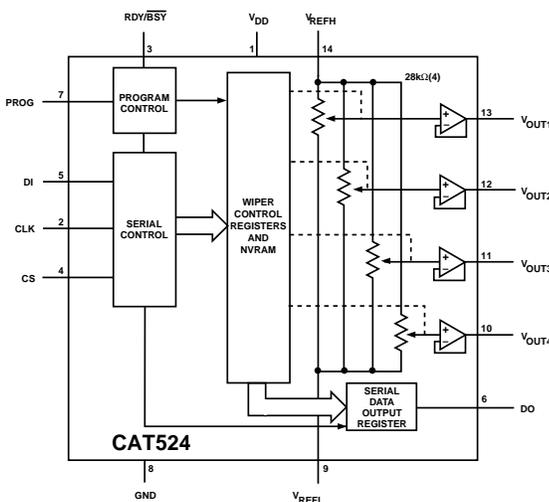
The four independently programmable DPPs have an output range which includes both supply rails. The wipers are buffered by rail to rail op amps. Wiper settings, stored in non-volatile NVRAM memory, are not lost when the device is powered down and are automatically reinstated when power is returned. Each wiper can be dithered to test new output values without

effecting the stored settings, and stored settings can be read back without disturbing the DPP's output.

The CAT524 is controlled with a simple 3-wire serial, Microwire-like interface. A Chip Select pin allows several devices to share a common serial interface. Communication back to the host controller is via a single serial data line thanks to the Tri-Stated CAT524 Data Output pin. A RDY/BSY output working in concert with an internal low voltage detector signals proper operation of the non-volatile NVRAM memory Erase/Write cycle.

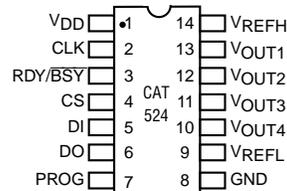
The CAT524 is available in the 0°C to 70°C commercial and -40°C to 85°C industrial operating temperature ranges. Both 14-pin plastic DIP and SOIC packages are offered.

### FUNCTIONAL DIAGRAM

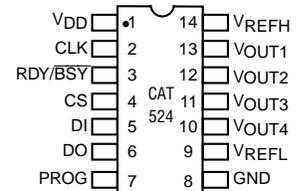


### PIN CONFIGURATION

#### DIP Package (P)



#### SOIC Package (J)



**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage*	$V_{DD}$ to GND	-0.5V to +7V
Inputs		
	CLK to GND	-0.5V to $V_{DD} + 0.5V$
	CS to GND	-0.5V to $V_{DD} + 0.5V$
	DI to GND	-0.5V to $V_{DD} + 0.5V$
	RDY/BSY to GND	-0.5V to $V_{DD} + 0.5V$
	PROG to GND	-0.5V to $V_{DD} + 0.5V$
	$V_{REFH}$ to GND	-0.5V to $V_{DD} + 0.5V$
	$V_{REFL}$ to GND	-0.5V to $V_{DD} + 0.5V$
Outputs		
	$D_0$ to GND	-0.5V to $V_{DD} + 0.5V$
	$V_{OUT}$ 1– 4 to GND	-0.5V to $V_{DD} + 0.5V$

Operating Ambient Temperature

Commercial ('C' or Blank suffix)	0°C to +70°C
Industrial ('I' suffix)	-40°C to +85°C
Junction Temperature	+150°C
Storage Temperature	-65°C to +150°C
Lead Soldering (10 sec max)	+300°C

\* Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Absolute Maximum Ratings are limited values applied individually while other parameters are within specified operating conditions, and functional operation at any of these conditions is NOT implied. Device performance and reliability may be impaired by exposure to absolute rating conditions for extended periods of time.

**RELIABILITY CHARACTERISTICS**

Symbol	Parameter	Min	Max	Units	Test Method
$V_{ZAP}^{(1)}$	ESD Susceptibility	2000		Volts	MIL-STD-883, Test Method 3015
$I_{LTH}^{(1)(2)}$	Latch-Up	100		mA	JEDEC Standard 17

- NOTES:** 1. This parameter is tested initially and after a design or process change that affects the parameter.  
 2. Latch-up protection is provided for stresses up to 100mA on address and data pins from -1V to  $V_{CC} + 1V$ .

**POWER SUPPLY**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{DD1}$	Supply Current (Read)	Normal Operating	—	400	600	$\mu A$
$I_{DD2}$	Supply Current (Write)	Programming, $V_{DD} = 5V$	—	1600	2500	$\mu A$
		$V_{DD} = 3V$	—	1000	1600	$\mu A$
$V_{DD}$	Operating Voltage Range		2.7	—	5.5	V

**LOGIC INPUTS**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{IH}$	Input Leakage Current	$V_{IN} = V_{DD}$	—	—	10	$\mu A$
$I_{IL}$	Input Leakage Current	$V_{IN} = 0V$	—	—	-10	$\mu A$
$V_{IH}$	High Level Input Voltage		2	—	$V_{DD}$	V
$V_{IL}$	Low Level Input Voltage		0	—	0.8	V

**LOGIC OUTPUTS**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{OH}$	High Level Output Voltage	$I_{OH} = -40\mu A$	$V_{DD} - 0.3$	—	—	V
$V_{IL}$	Low Level Output Voltage	$I_{OL} = 1\text{ mA}, V_{DD} = +5V$	—	—	0.4	V
		$I_{OL} = 0.4\text{ mA}, V_{DD} = +3V$	—	—	0.4	V

**POTENTIOMETER CHARACTERISTICS**

$V_{DD} = +2.7V$  to  $+5.5V$ ,  $V_{REFH} = V_{DD}$ ,  $V_{REFL} = 0V$ , unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$R_{POT}$	Potentiometer Resistance			28		$k\Omega$
	$R_{POT}$ to $R_{POT}$ Match		—	$\pm 0.5$	$\pm 1$	%
	Pot Resistance Tolerance				$\pm 15$	%
	Voltage on $V_{REFH}$ pin		2.7		$V_{DD}$	V
	Voltage on $V_{REFL}$ pin		OV		$V_{DD} - 2.7$	V
	Resolution			0.4		%
INL	Integral Linearity Error			0.5	1	LSB
DNL	Differential Linearity Error			0.25	0.5	LSB
$R_{OUT}$	Buffer Output Resistance				10	$\Omega$
$I_{OUT}$	Buffer Output Current				3	mA
$TC_{RPOT}$	TC of Pot Resistance			300		ppm/ $^{\circ}C$
$TC_{RATIO}$	Ratiometric TC					ppm/ $^{\circ}C$
$R_{ISO}$	Isolation Resistance					$\Omega$
$V_N$	Noise					nV/ $\sqrt{Hz}$
$C_H/C_L$	Potentiometer Capacitances			8/8		pF
fc	Frequency Response	Passive Attenuator				MHz

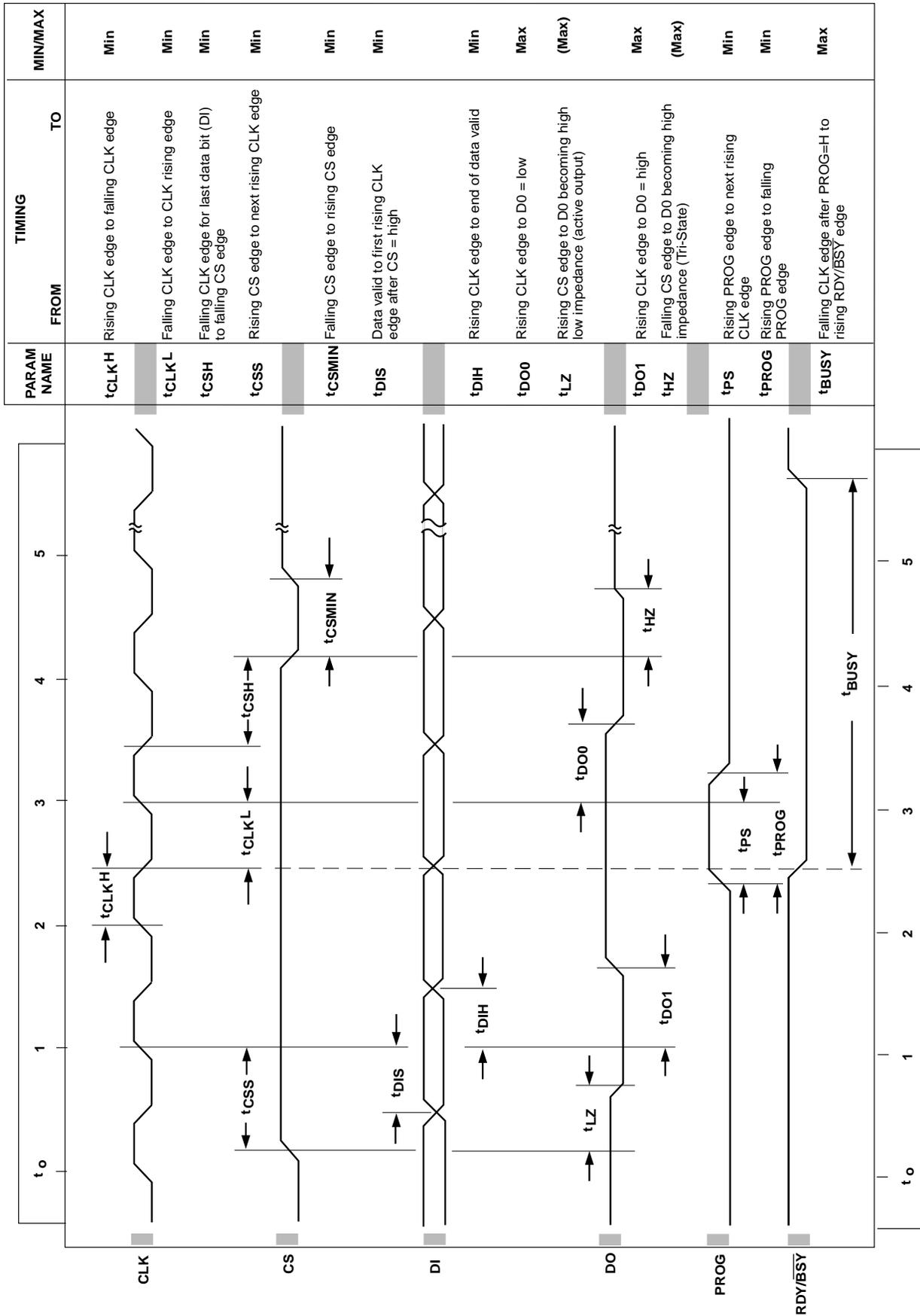
**AC ELECTRICAL CHARACTERISTICS:**

$V_{DD} = +2.7V$  to  $+5.5V$ ,  $V_{REFH} = V_{DD}$ ,  $V_{REFL} = 0V$ , unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Digital</b>						
$t_{CSMIN}$	Minimum CS Low Time		150	—	—	ns
$t_{CSS}$	CS Setup Time		100	—	—	ns
$t_{CSH}$	CS Hold Time	$C_L = 100pF$ , see note 1	0	—	—	ns
$t_{DIS}$	DI Setup Time		50	—	—	ns
$t_{DIH}$	DI Hold Time		50	—	—	ns
$t_{DO1}$	Output Delay to 1		—	—	150	ns
$t_{DO0}$	Output Delay to 0		—	—	150	ns
$t_{HZ}$	Output Delay to High-Z			—	400	—
$t_{LZ}$	Output Delay to Low-Z		—	400	—	ns
$t_{BUSY}$	Erase/Write Cycle Time		—	4	5	ms
$t_{PS}$	PROG Setup Time		150	—	—	ns
$t_{PROG}$	Minimum Pulse Width		700	—	—	ns
$t_{CLKH}$	Minimum CLK High Time		500	—	—	ns
$t_{CLKL}$	Minimum CLK Low Time		300	—	—	ns
$f_C$	Clock Frequency		DC	—	1	MHz
<b>Analog</b>						
$t_{DS}$	DPP Settling Time to 1 LSB	$C_{LOAD} = 10 pF$ , $V_{DD} = +5V$	—	3	10	$\mu s$
		$C_{LOAD} = 10 pF$ , $V_{DD} = +3V$	—	6	10	$\mu s$

- NOTES:** 1. All timing measurements are defined at the point of signal crossing  $V_{DD} / 2$ .  
2. These parameters are periodically sampled and are not 100% tested.

A. C. TIMING DIAGRAM



## PIN DESCRIPTION

Pin	Name	Function
1	V <sub>DD</sub>	Power supply positive.
2	CLK	Clock input pin.Clock input pin.
3	RDY/ $\overline{\text{BSY}}$	Ready/Busy Output
4	CS	Chip Select
5	DI	Serial data input pin.
6	DO	Serial data output pin.
7	PROG	Non-volatile Memory Programming Enable Input
8	GND	Power supply ground.
9	V <sub>REFL</sub>	Minimum DPP output voltage.
10	V <sub>OUT4</sub>	DPP output channel 4.
11	V <sub>OUT3</sub>	DPP output channel 3.
12	V <sub>OUT2</sub>	DPP output channel 2.
13	V <sub>OUT1</sub>	DPP output channel 1.
14	V <sub>REFH</sub>	Maximum DPP output voltage.

DPP addressing is as follows:

DPP OUTPUT	A0	A1
V <sub>OUT1</sub>	0	0
V <sub>OUT2</sub>	1	0
V <sub>OUT3</sub>	0	1
V <sub>OUT4</sub>	1	1

## DEVICE OPERATION

The CAT524 is a quad 8-bit configured digitally programmable potentiometer (DPP) whose outputs can be programmed to any one of 256 individual voltage steps. Once programmed, these output settings are retained in non-volatile memory and will not be lost when power is removed from the chip. Upon power up the DPPs return to the settings stored in non-volatile memory. Each DPP can be written to and read from independently without effecting the output voltage during the read or write cycle. Each output can also be temporarily adjusted without changing the stored output setting, which is useful for testing new output settings before storing them in memory.

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Multiple devices may share a common input data line by selectively activating the CS control of the desired IC. Data Outputs (DO) can also share a common line because the DO pin is Tri-States and returns to a high impedance when not in use.

### CHIP SELECT

Chip Select (CS) enables and disables the CAT524's

read and write operations. When CS is high data may be read to or from the chip, and the Data Output (DO) pin is active. Data loaded into the DPP control registers will remain in effect until CS goes low. Bringing CS to a logic low returns all DPP outputs to the settings stored in non-volatile memory and switches DO to its high impedance Tri-State mode.

Because CS functions like a reset the CS pin has been equipped with a 30 ns to 90 ns filter circuit to prevent noise spikes from causing unwanted resets and the loss of volatile data.

### CLOCK

The CAT524's clock controls both data flow in and out of the IC and non-volatile memory cell programming. Serial data is shifted into the DI pin and out of the DO pin on the clock's rising edge. While it is not necessary for the clock to be running between data transfers, the clock must be operating in order to write to non-volatile memory, even though the data being saved may already be resident in the DPP wiper control register.

No clock is necessary upon system power-up. The CAT524's internal power-on reset circuitry loads data from non-volatile memory to the DPPs without using the external clock.

As data transfers are edge triggered clean clock transitions are necessary to avoid falsely clocking data into the control registers. Standard CMOS and TTL logic families work well in this regard and it is recommended that any mechanical switches used for breadboarding or device evaluation purposes be debounced by a flip-flop or other suitable debouncing circuit.

**V<sub>REF</sub>**

V<sub>REF</sub>, the voltage applied between pins V<sub>REFH</sub> and V<sub>REFL</sub>, sets the configured DPP's Zero to Full Scale output range where V<sub>REFL</sub> = Zero and V<sub>REFH</sub> = Full Scale. V<sub>REF</sub> can span the full power supply range or just a fraction of it. In typical applications V<sub>REFH</sub> and V<sub>REFL</sub> are connected across the power supply rails. When using less than the full supply voltage V<sub>REFH</sub> is restricted to voltages between V<sub>DD</sub> and V<sub>DD</sub>/2 and V<sub>REFL</sub> to voltages between GND and V<sub>DD</sub>/2.

**READY/BSY**

When saving data to non-volatile memory, the Ready/Busy output (RDY/BSY) signals the start and duration of the non-volatile erase/write cycle. Upon receiving a command to store data (PROG goes high) RDY/BSY goes low and remains low until the programming cycle is complete. During this time the CAT524 will ignore any data appearing at DI and no data will be output on DO.

RDY/BSY is internally ANDed with a low voltage detector circuit monitoring V<sub>DD</sub>. If V<sub>DD</sub> is below the minimum value required for non-volatile programming, RDY/BSY will remain high following the program command indicating a failure to record the desired data in non-volatile memory.

**DATA OUTPUT**

Data is output serially by the CAT524, LSB first, via the Data Out (DO) pin following the reception of a start bit and two address bits by the Data Input (DI). DO becomes active whenever CS goes high and resumes its high impedance Tri-State mode when CS returns low. Tri-Stating the DO pin allows several 524s to share a single serial data line and simplifies interfacing multiple 524s to a microprocessor.

**WRITING TO MEMORY**

Programming the CAT524's non-volatile memory is accomplished through the control signals: Chip Select

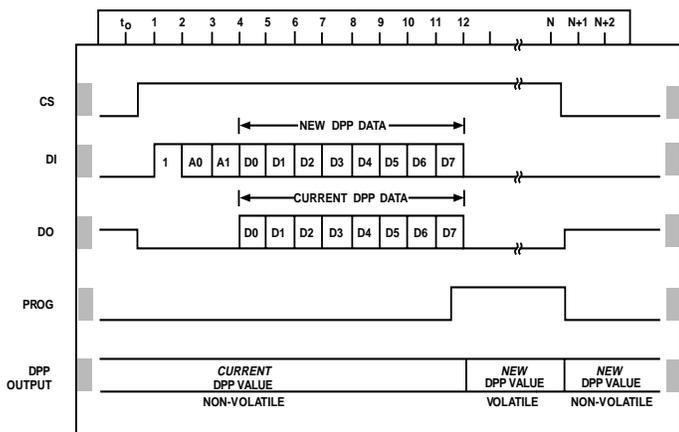
(CS) and Program (PROG). With CS high, a start bit followed by a two bit DPP address and eight data bits are clocked into the DPP control register via the DI pin. Data enters on the clock's rising edge. The DPP output changes to its new setting on the clock cycle following D7, the last data bit.

Programming is achieved by bringing PROG high for a minimum of 3 ms. PROG must be brought high sometime after the start bit and at least 150 ns prior to the rising edge of the clock cycle immediately following the D7 bit. Two clock cycles after the D7 bit the DPP wiper control register will be ready to receive the next set of address and data bits. The clock must be kept running throughout the programming cycle. Internal control circuitry takes care of ramping the programming voltage for data transfer to the non-volatile cells. The CAT524 non-volatile memory cells will endure over 100,000 write cycles and will retain data for a minimum of 20 years without being refreshed.

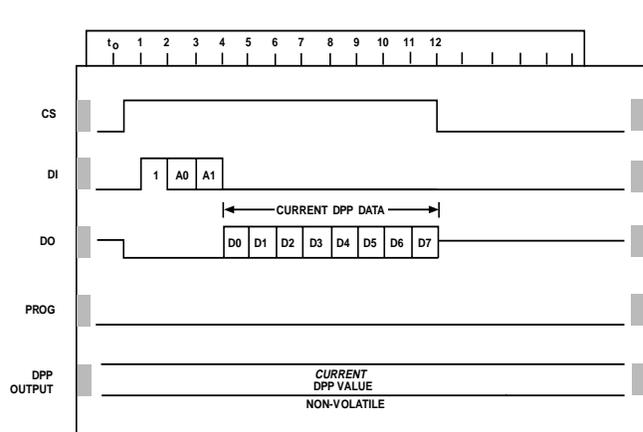
**READING DATA**

Each time data is transferred into a DPP wiper control register currently held data is shifted out via the D0 pin, thus in every data transaction a read cycle occurs. Note, however, that the reading process is destructive. Data must be removed from the register in order to be read. Figure 2 depicts a Read Only cycle in which no change occurs in the DPP's output. This feature allows  $\mu$ Ps to poll DPPs for their current setting without disturbing the output voltage but it assumes that the setting being read is also stored in non-volatile memory so that it can be restored at the end of the read cycle. In Figure 2 CS returns low before the 13<sup>th</sup> clock cycle completes. In doing so the non-volatile memory setting is reloaded into the DPP wiper control register.

**Figure 1. Writing to Memory**



**Figure 2. Reading from Memory**



Since this value is the same as that which had been there previously no change in the DPP's output is noticed. Had the value held in the control register been different from that stored in non-volatile memory then a *change would occur* at the read cycle's conclusion.

### TEMPORARILY CHANGE OUTPUT

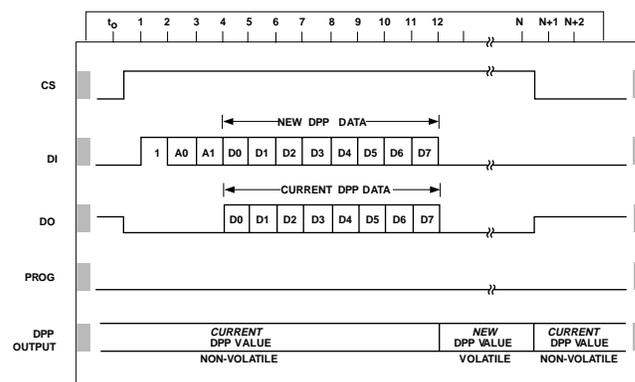
The CAT524 allows temporary changes in DPP's output to be made without disturbing the settings retained in non-volatile memory. This feature is particularly useful when testing for a new output setting and allows for user adjustment of preset or default values without losing the original factory settings.

Figure 3 shows the control and data signals needed to effect a temporary output change. DPP wiper settings may be changed as many times as required and can be made to any of the four DPPs in any order or sequence. The temporary setting(s) remain in effect long as CS remains high. When CS returns low all four DPPs will return to the output values stored in non-volatile memory.

When it is desired to save a new setting acquired using

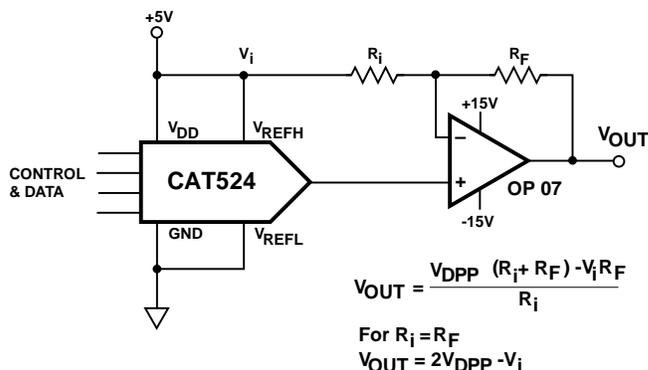
this feature, the new value must be reloaded into the DPP control register prior to programming. This is because the CAT524's internal control circuitry discards the new data from the programming register two clock cycles after receiving it (after reception is complete) if no PROG signal is received.

Figure 3. Temporary Change in Output

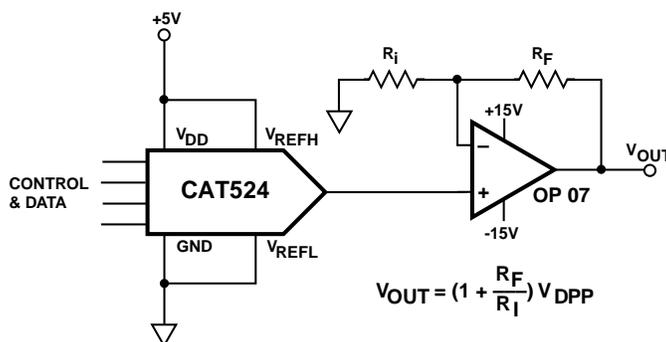


### APPLICATION CIRCUITS

DPP INPUT		DPP OUTPUT	ANALOG OUTPUT
		$V_{DPP} = \frac{CODE}{255} (V_{FS} - V_{ZERO}) + V_{ZERO}$	
		$V_{FS} = 0.99 V_{REF}$	$V_{REF} = 5V$
		$V_{ZERO} = 0.01 V_{REF}$	$R_I = R_F$
MSB	LSB		
1111	1111	$\frac{255}{255} (.98 V_{REF}) + .01 V_{REF} = .990 V_{REF}$	$V_{OUT} = +4.90V$
1000	0000	$\frac{128}{255} (.98 V_{REF}) + .01 V_{REF} = .502 V_{REF}$	$V_{OUT} = +0.02V$
0111	1111	$\frac{127}{255} (.98 V_{REF}) + .01 V_{REF} = .498 V_{REF}$	$V_{OUT} = -0.02V$
0000	0001	$\frac{1}{255} (.98 V_{REF}) + .01 V_{REF} = .014 V_{REF}$	$V_{OUT} = -4.86V$
0000	0000	$\frac{0}{255} (.98 V_{REF}) + .01 V_{REF} = .010 V_{REF}$	$V_{OUT} = -4.90V$

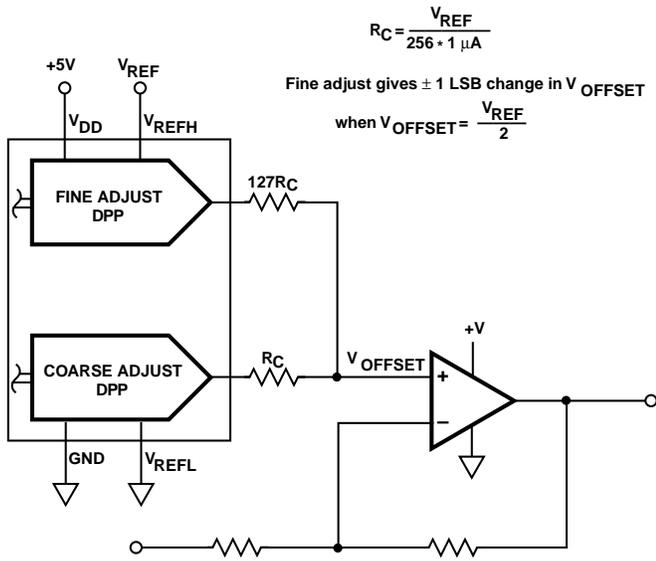


Bipolar DPP Output

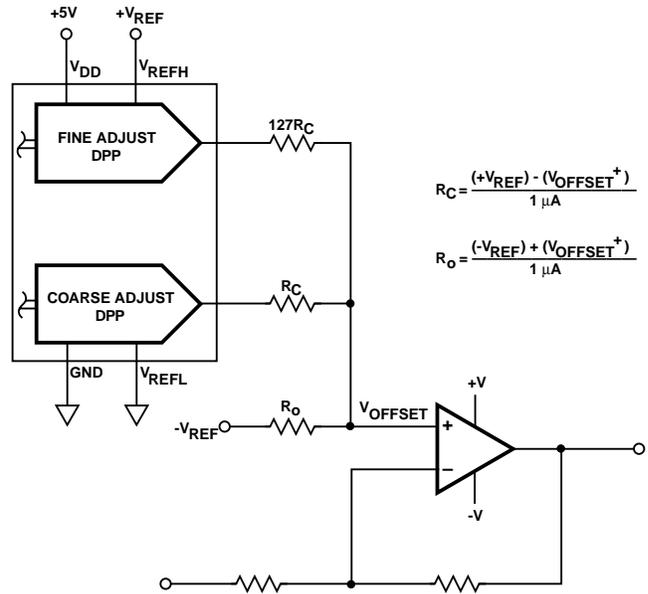


Amplified DPP Output

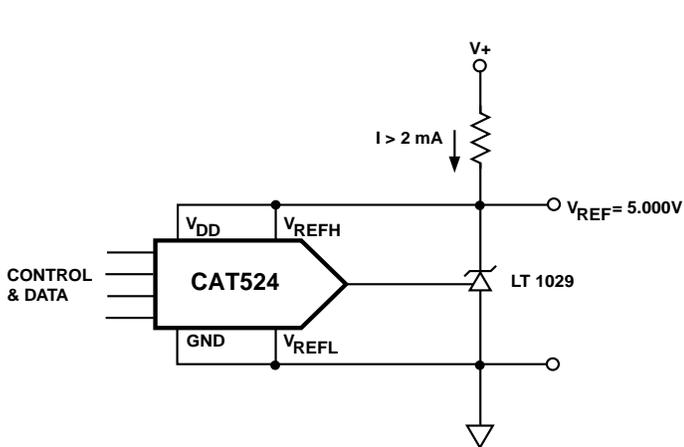
APPLICATION CIRCUITS (Cont.)



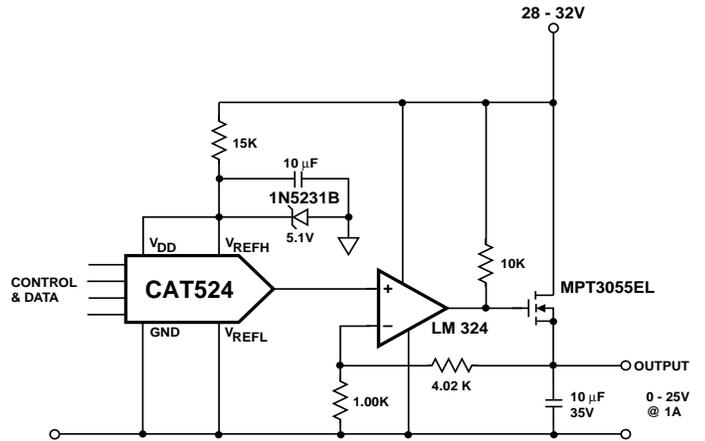
Coarse-Fine Offset Control by Averaging DPP Outputs for Single Power Supply Systems



Coarse-Fine Offset Control by Averaging DPP Outputs for Dual Power Supply Systems

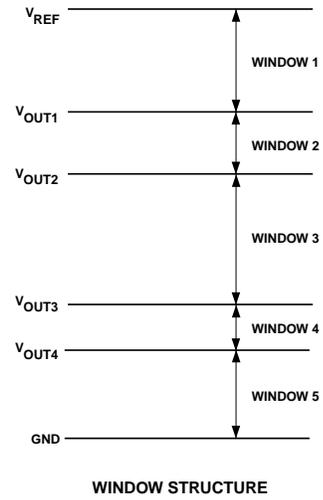
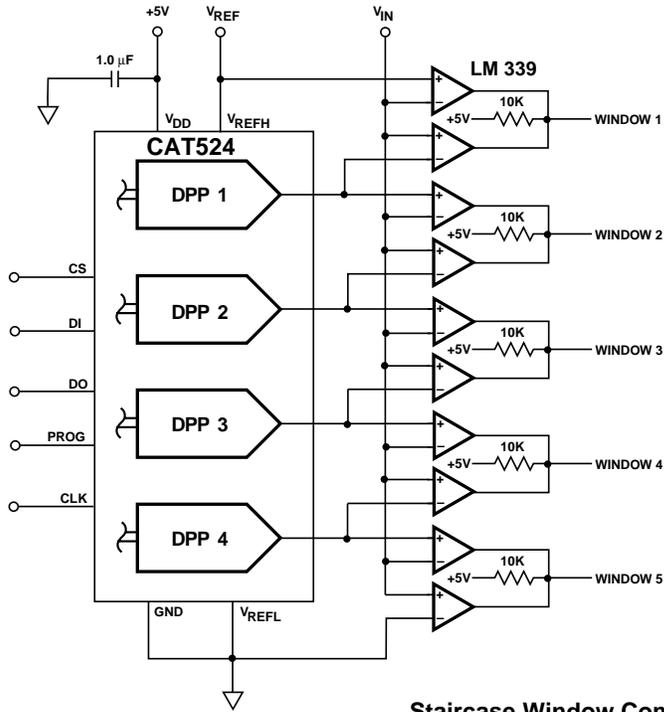


Digitally Trimmed Voltage Reference

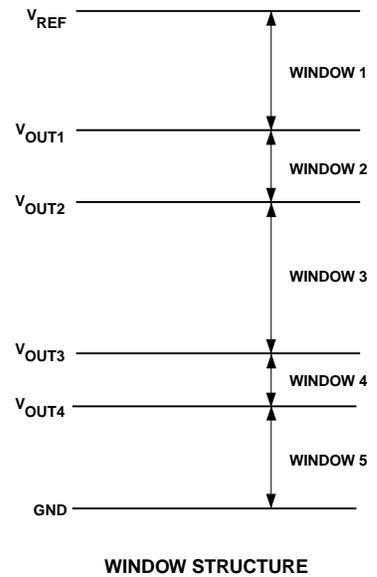
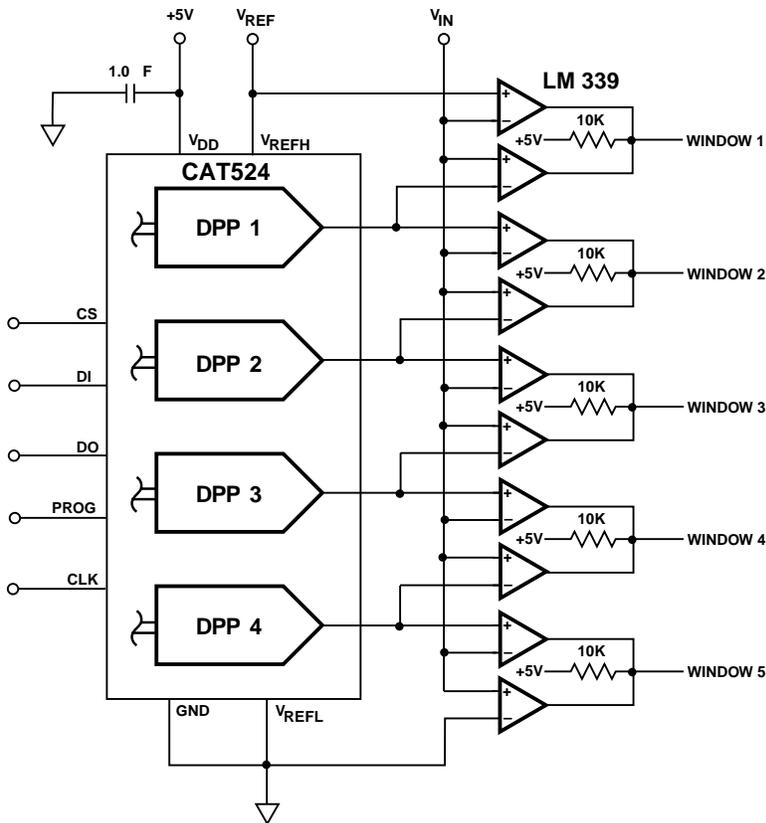


Digitally Controlled Voltage Reference

APPLICATION CIRCUITS (Cont.)

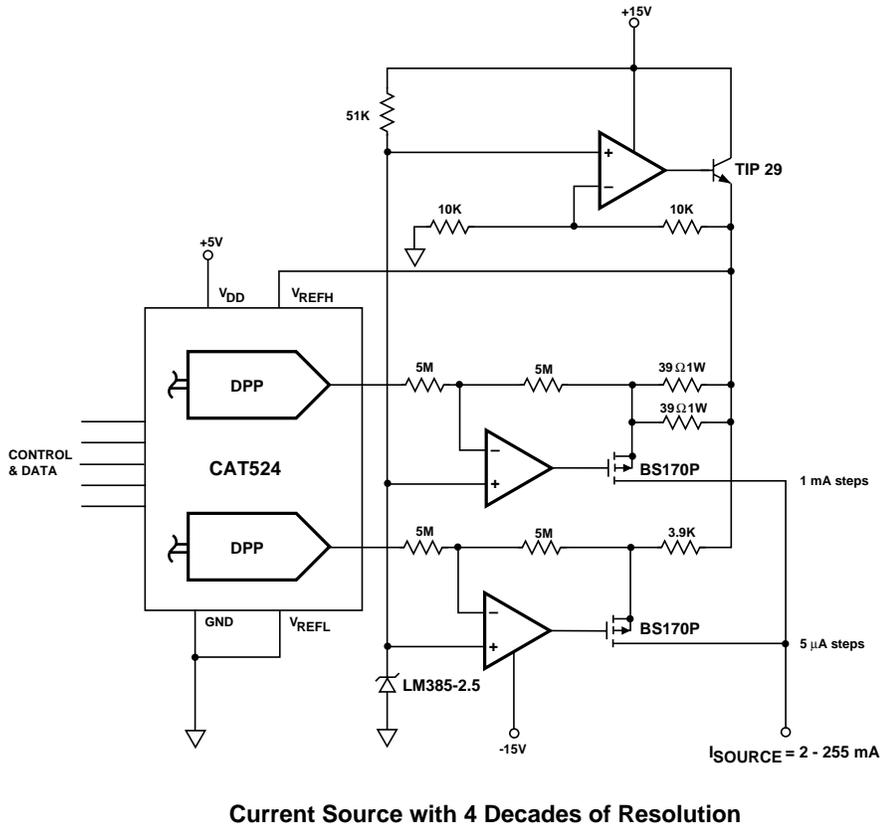
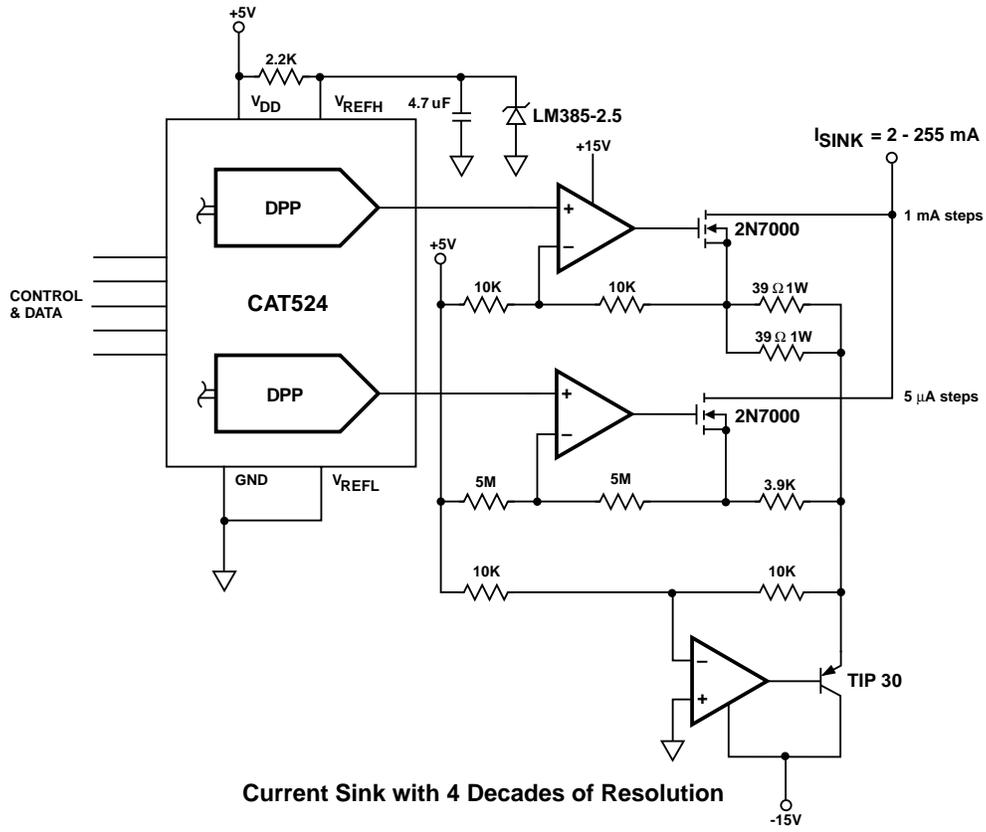


Staircase Window Comparator

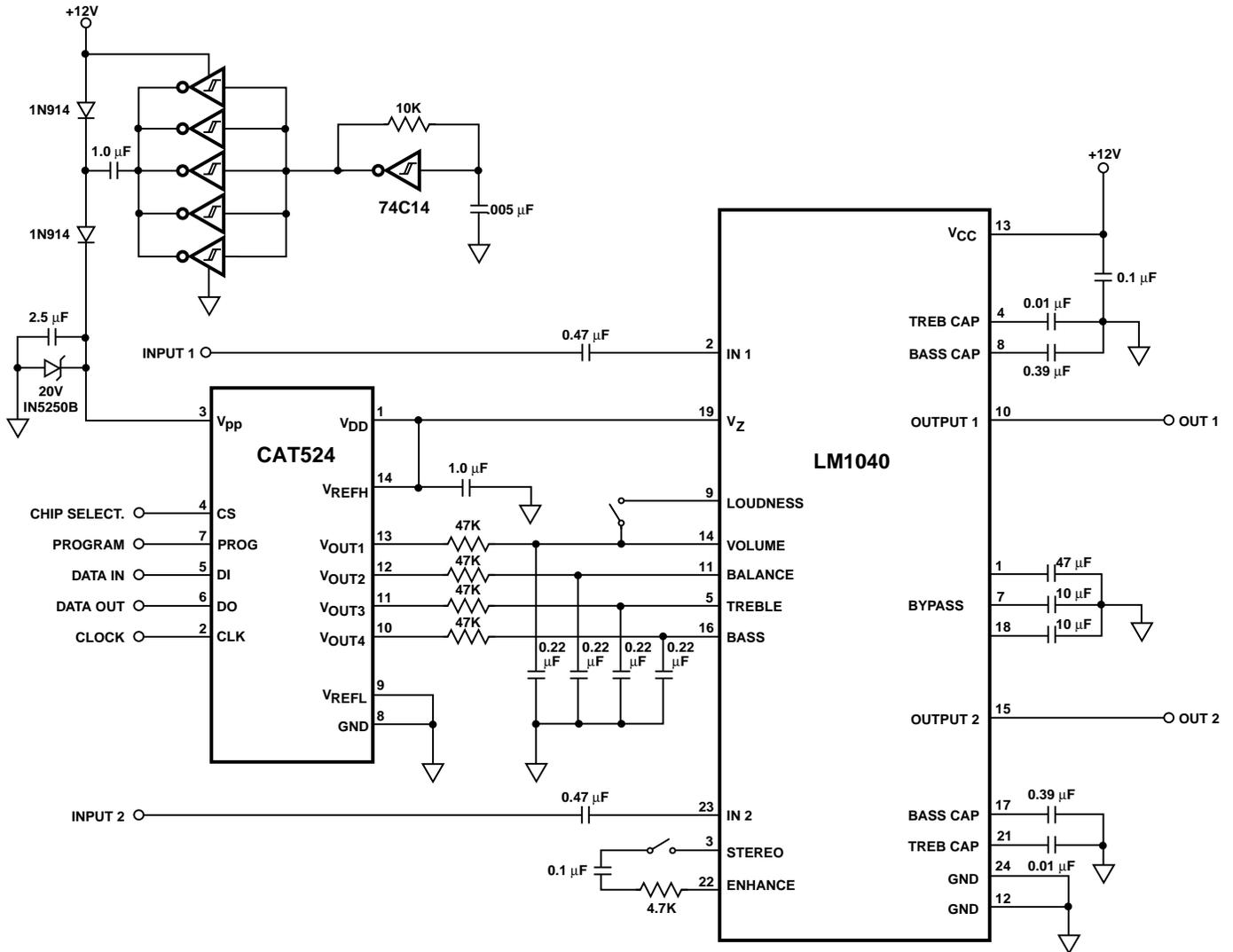


Overlapping Window Comparator

APPLICATION CIRCUITS (Cont.)

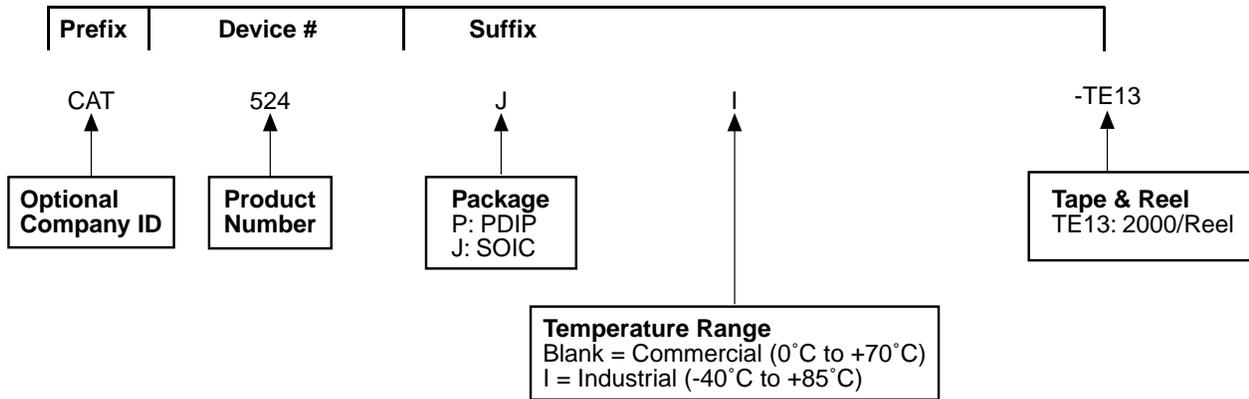


APPLICATION CIRCUITS (Cont.)



Digital Stereo Control

**ORDERING INFORMATION**



**Notes:**

(1) The device used in the above example is a CAT524JI-TE13 (SOIC, Industrial Temperature, Tape & Reel)

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# CAT525

## Configured Digitally Programmable Potentiometer (DPP™): Programmable Voltage Applications

### FEATURES

- Four 8-bit DPPs configured as programmable voltage sources in DAC-like applications
- Independent reference inputs
- Buffered wiper outputs
- Non-volatile NVRAM memory wiper storage
- Output voltage range includes both supply rails
- 4 independently addressable buffered output wipers
- 1 LSB accuracy, high resolution
- Serial Microwire-like interface
- Single supply operation: 2.7V - 5.5V
- Setting read-back without effecting outputs

### APPLICATIONS

- Automated product calibration
- Remote control adjustment of equipment
- Offset, gain and zero adjustments in self-calibrating and adaptive control systems
- Tamper-proof calibrations
- DAC (with memory) substitute

### DESCRIPTION

The CAT525 is a quad 8-bit digitally programmable potentiometer (DPP™) configured for programmable voltage and DAC-like applications. Intended for final calibration of products such as camcorders, fax machines and cellular telephones on automated high volume production lines and systems capable of self calibration, it is also well suited for applications where equipment requiring periodic adjustment is either difficult to access or located in a hazardous environment.

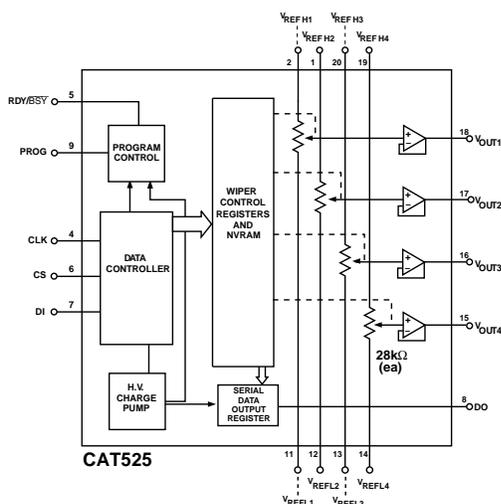
The CAT525 offers four independently programmable DPPs each having its own reference inputs and each capable of rail to rail output swing. The wipers are buffered by rail to rail op amps. Wiper settings, stored in non-volatile NVRAM memory, are not lost when the device is powered down and are automatically reinstated when power is returned. Each wiper can be dithered to

test new output values without effecting the stored settings and stored settings can be read back without disturbing the DPP's output.

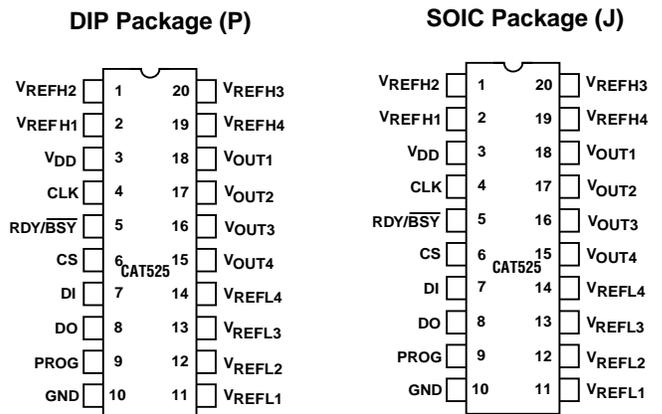
Control of the CAT525 is accomplished with a simple 3-wire, Microwire-like serial interface. A Chip Select pin allows several CAT525's to share a common serial interface and communications back to the host controller is via a single serial data line thanks to the CAT525's Tri-Stated Data Output pin. A RDY/BSY output working in concert with an internal low voltage detector signals proper operation of non-volatile NVRAM Memory Erase/Write cycle.

The CAT525 is available in the 0°C to 70°C commercial and -40°C to 85°C industrial operating temperature ranges and offered in 20-pin plastic DIP and surface mount packages.

### FUNCTIONAL DIAGRAM



### PIN CONFIGURATION



**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage\*  
 $V_{DD}$  to GND ..... -0.5V to +7V

Inputs  
 CLK to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 CS to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 DI to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 RDY/BSY to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 PROG to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 $V_{REFH}$  to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 $V_{REFL}$  to GND ..... -0.5V to  $V_{DD} + 0.5V$

Outputs  
 $D_0$  to GND ..... -0.5V to  $V_{DD} + 0.5V$   
 $V_{OUT}$  1– 4 to GND ..... -0.5V to  $V_{DD} + 0.5V$

Operating Ambient Temperature

Commercial ('C' or Blank suffix) ..... 0°C to +70°C  
 Industrial ('I' suffix) ..... -40°C to +85°C  
 Junction Temperature ..... +150°C  
 Storage Temperature ..... -65°C to +150°C  
 Lead Soldering (10 sec max) ..... +300°C

\* Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Absolute Maximum Ratings are limited values applied individually while other parameters are within specified operating conditions, and functional operation at any of these conditions is NOT implied. Device performance and reliability may be impaired by exposure to absolute rating conditions for extended periods of time.

**RELIABILITY CHARACTERISTICS**

Symbol	Parameter	Min	Max	Units	Test Method
$V_{ZAP}^{(1)}$	ESD Susceptibility	2000		Volts	MIL-STD-883, Test Method 3015
$I_{LTH}^{(1)(2)}$	Latch-Up	100		mA	JEDEC Standard 17

- NOTES:** 1. This parameter is tested initially and after a design or process change that affects the parameter.  
 2. Latch-up protection is provided for stresses up to 100mA on address and data pins from -1V to  $V_{CC} + 1V$ .

**POWER SUPPLY**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{DD1}$	Supply Current (Read)	Normal Operating	—	400	600	$\mu A$
$I_{DD2}$	Supply Current (Write)	Programming, $V_{DD} = 5V$	—	1600	2500	$\mu A$
		$V_{DD} = 3V$	—	1000	1600	$\mu A$
$V_{DD}$	Operating Voltage Range		2.7	—	5.5	V

**LOGIC INPUTS**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{IH}$	Input Leakage Current	$V_{IN} = V_{DD}$	—	—	10	$\mu A$
$I_{IL}$	Input Leakage Current	$V_{IN} = 0V$	—	—	-10	$\mu A$
$V_{IH}$	High Level Input Voltage		2	—	$V_{DD}$	V
$V_{IL}$	Low Level Input Voltage		0	—	0.8	V

**LOGIC OUTPUTS**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{OH}$	High Level Output Voltage	$I_{OH} = -40\mu A$	$V_{DD} - 0.3$	—	—	V
$V_{IL}$	Low Level Output Voltage	$I_{OL} = 1\text{ mA}, V_{DD} = +5V$	—	—	0.4	V
		$I_{OL} = 0.4\text{ mA}, V_{DD} = +3V$	—	—	0.4	V

**POTENTIOMETER CHARACTERISTICS**

$V_{DD} = +2.7V$  to  $+5.5V$ ,  $V_{REFH} = V_{DD}$ ,  $V_{REFL} = 0V$ , unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$R_{POT}$	Potentiometer Resistance			28		$k\Omega$
	$R_{POT}$ to $R_{POT}$ Match		—	$\pm 0.5$	$\pm 1$	%
	Pot Resistance Tolerance				$\pm 15$	%
	Voltage on $V_{REFH}$ pin		2.7		$V_{DD}$	V
	Voltage on $V_{REFL}$ pin		OV		$V_{DD} - 2.7$	V
	Resolution			0.4		%
INL	Integral Linearity Error			0.5	1	LSB
DNL	Differential Linearity Error			0.25	0.5	LSB
$R_{OUT}$	Buffer Output Resistance				10	$\Omega$
$I_{OUT}$	Buffer Output Current				3	mA
$TC_{RPOT}$	TC of Pot Resistance			300		ppm/ $^{\circ}C$
$TC_{RATIO}$	Ratiometric TC					ppm/ $^{\circ}C$
$R_{ISO}$	Isolation Resistance					$\Omega$
$V_N$	Noise					nV/ $\sqrt{Hz}$
$C_H/C_L$	Potentiometer Capacitances			8/8		pF
fc	Frequency Response	Passive Attenuator				MHz

**AC ELECTRICAL CHARACTERISTICS:**

$V_{DD} = +2.7V$  to  $+5.5V$ ,  $V_{REFH} = V_{DD}$ ,  $V_{REFL} = 0V$ , unless otherwise specified

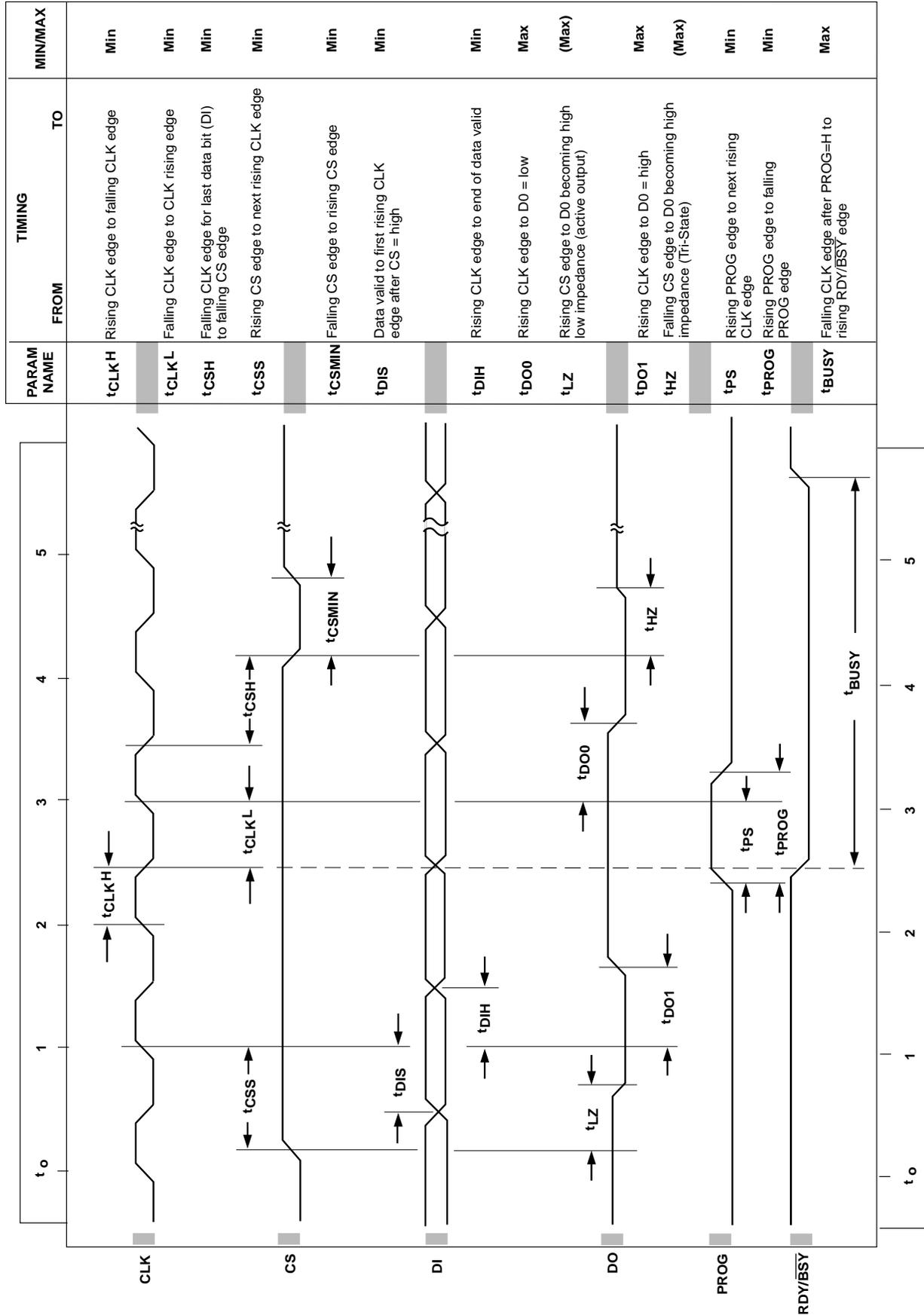
Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Digital</b>						
$t_{CSMIN}$	Minimum CS Low Time		150	—	—	ns
$t_{CSS}$	CS Setup Time		100	—	—	ns
$t_{CSH}$	CS Hold Time	$C_L = 100pF$ , see note 1	0	—	—	ns
$t_{DIS}$	DI Setup Time		50	—	—	ns
$t_{DIH}$	DI Hold Time		50	—	—	ns
$t_{DO1}$	Output Delay to 1		—	—	150	ns
$t_{DO0}$	Output Delay to 0		—	—	150	ns
$t_{HZ}$	Output Delay to High-Z			—	400	—
$t_{LZ}$	Output Delay to Low-Z		—	400	—	ns
$t_{BUSY}$	Erase/Write Cycle Time		—	4	5	ms
$t_{PS}$	PROG Setup Time		150	—	—	ns
$t_{PROG}$	Minimum Pulse Width		700	—	—	ns
$t_{CLKH}$	Minimum CLK High Time		500	—	—	ns
$t_{CLKL}$	Minimum CLK Low Time		300	—	—	ns
fc	Clock Frequency		DC	—	1	MHz

**Analog**

$t_{DS}$	DPP Settling Time to 1 LSB	$C_{LOAD} = 10 pF$ , $V_{DD} = +5V$	—	3	10	$\mu s$
		$C_{LOAD} = 10 pF$ , $V_{DD} = +3V$	—	6	10	$\mu s$

- NOTES:** 1. All timing measurements are defined at the point of signal crossing  $V_{DD} / 2$ .  
2. These parameters are periodically sampled and are not 100% tested.

A. C. TIMING DIAGRAM



## PIN DESCRIPTION

Pin	Name	Function
1	V <sub>REFH2</sub>	Maximum DPP 2 output voltage
2	V <sub>REFH1</sub>	Maximum DPP 1 output voltage
3	V <sub>DD</sub>	Power supply positive
4	CLK	Clock input pin
5	RDY/ $\overline{\text{BSY}}$	Ready/Busy output
6	CS	Chip select
7	DI	Serial data input pin
8	DO	Serial data output pin
9	PROG	Non-volatile Memory Programming Enable Input
10	GND	Power supply ground
11	V <sub>REFL1</sub>	Minimum DPP 1 output voltage
12	V <sub>REFL2</sub>	Minimum DPP 2 output voltage
13	V <sub>REFL3</sub>	Minimum DPP 3 output voltage
14	V <sub>REFL4</sub>	Minimum DPP 4 output voltage
15	V <sub>OUT4</sub>	DPP 4 output
16	V <sub>OUT3</sub>	DPP 3 output
17	V <sub>OUT2</sub>	DPP 2 output
18	V <sub>OUT1</sub>	DPP 1 output
19	V <sub>REFH4</sub>	Maximum DPP 4 output voltage
20	V <sub>REFH3</sub>	Maximum DPP 3 output voltage

CDPP/DPP addressing is as follows:

DPP OUTPUT	A0	A1
V <sub>OUT1</sub>	0	0
V <sub>OUT2</sub>	1	0
V <sub>OUT3</sub>	0	1
V <sub>OUT4</sub>	1	1

## DEVICE OPERATION

The CAT525 is a quad 8-bit configured digitally programmable potentiometer (DPP/CDPP) whose outputs can be programmed to any one of 256 individual voltage steps. Once programmed, these output settings are retained in non-volatile memory and will not be lost when power is removed from the chip. Upon power up the DPPs return to the settings stored in non-volatile memory. Each configured DPP can be written to and read from independently without effecting the output voltage during the read or write cycle. Each output can also be adjusted without altering the stored output setting, which is useful for testing new output settings before storing them in memory.

## DIGITAL INTERFACE

The CAT525 employs a 3 wire serial, Microwire-like control interface consisting of Clock (CLK), Chip Select (CS) and Data In (DI) inputs. For all operations, address and data are shifted in LSB first. In addition, all digital data must be preceded by a logic "1" as a start bit. The DPP address and data are clocked into the DI pin on the clock's rising edge. When sending multiple blocks of information a minimum of two clock cycles is required between the last block sent and the next start bit.

Multiple devices may share a common input data line by selectively activating the CS control of the desired IC. Data Outputs (DO) can also share a common line because the DO pin is Tri-States and returns to a high

impedance when not in use.

## CHIP SELECT

Chip Select (CS) enables and disables the CAT525's read and write operations. When CS is high data may be read to or from the chip, and the Data Output (DO) pin is active. Data loaded into the DPP wiper control registers will remain in effect until CS goes low. Bringing CS to a logic low returns all DPP outputs to the settings stored in non-volatile memory and switches DO to its high impedance Tri-State mode.

Because CS functions like a reset the CS pin has been desensitized with a 30 ns to 90 ns filter circuit to prevent noise spikes from causing unwanted resets and the loss of volatile data.

## CLOCK

The CAT525's clock controls both data flow in and out of the IC and non-volatile memory cell programming. Serial data is shifted into the DI pin and out of the DO pin on the clock's rising edge. While it is not necessary for the clock to be running between data transfers, the clock must be operating in order to write to non-volatile memory, even though the data being saved may already be resident in the DPP wiper control register.

No clock is necessary upon system power-up. The CAT525's internal power-on reset circuitry loads data from non-volatile memory to the DPPs without using the external clock.

As data transfers are edge triggered clean clock transitions are necessary to avoid falsely clocking data into the control registers. Standard CMOS and TTL logic families work well in this regard and it is recommended that any mechanical switches used for breadboarding or device evaluation purposes be debounced by a flip-flop or other suitable debouncing circuit.

**V<sub>REF</sub>**

V<sub>REF</sub>, the voltage applied between pins V<sub>REFH</sub> & V<sub>REFL</sub>, sets the configured DPP's Zero to Full Scale output range where V<sub>REFL</sub> = Zero and V<sub>REFH</sub> = Full Scale. V<sub>REF</sub> can span the full power supply range or just a fraction of it. In typical applications V<sub>REFH</sub> & V<sub>REFL</sub> are connected across the power supply rails. When using less than the full supply voltage be mindfull of the limits placed on V<sub>REFH</sub> and V<sub>REFL</sub> as specified in the References section of DC Electrical Characteristics.

**READY/BSY**

When saving data to non-volatile memory, the Ready/Busy output (RDY/BSY) signals the start and duration of the erase/write cycle. Upon receiving a command to store data (PROG goes high) RDY/BSY goes low and remains low until the programming cycle is complete. During this time the CAT525 will ignore any data appearing at DI and no data will be output on DO.

RDY/BSY is internally ANDed with a low voltage detector circuit monitoring V<sub>DD</sub>. If V<sub>DD</sub> is below the minimum value required for EEPROM programming, RDY/BSY will remain high following the program command indicating a failure to record the desired data in non-volatile memory.

**DATA OUTPUT**

Data is output serially by the CAT525, LSB first, via the Data Out (DO) pin following the reception of a start bit and two address bits by the Data Input (DI). DO becomes active whenever CS goes high and resumes its high impedance Tri-State mode when CS returns low. Tri-Stating the DO pin allows several 525s to share a

single serial data line and simplifies interfacing multiple 525s to a microprocessor.

**WRITING TO MEMORY**

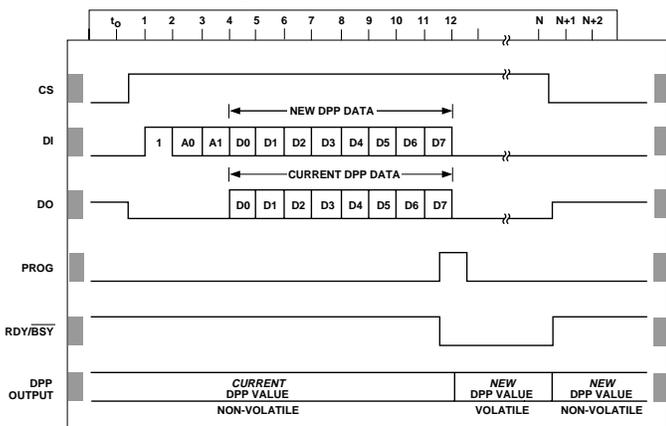
Programming the CAT525's non-volatile memory is accomplished through the control signals: Chip Select (CS) and Program (PROG). With CS high, a start bit followed by a two bit DPP address and eight data bits are clocked into the DPP wiper control register via the DI pin. Data enters on the clock's rising edge. The DPP output changes to its new setting on the clock cycle following D7, the last data bit.

Programming is accomplished by bringing PROG high sometime after the start bit and at least 150 ns prior to the rising edge of the clock cycle immediately following the D7 bit. Two clock cycles after the D7 bit the DPP control register will be ready to receive the next set of address and data bits. The clock must be kept running throughout the programming cycle. Internal control circuitry takes care of generating and ramping up the programming voltage for data transfer to the non-volatile memory cells. The CAT525's non-volatile memory cells will endure over 100,000 write cycles and will retain data for a minimum of 20 years without being refreshed.

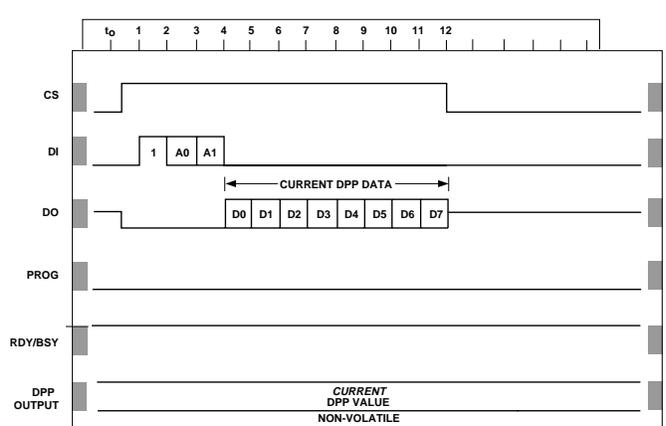
**READING DATA**

Each time data is transferred into a DPP wiper control register currently held data is shifted out via the D0 pin, thus in every data transaction a read cycle occurs. Note, however, that the reading process is destructive. Data must be removed from the register in order to be read. Figure 2 depicts a Read Only cycle in which no change occurs in the DPP's output. This feature allows  $\mu$ Ps to poll DPPs for their current setting without disturbing the output voltage but it assumes that the setting being read is also stored in non-volatile memory so that it can be restored at the end of the read cycle. In Figure 2 CS returns low before the 13<sup>th</sup> clock cycle completes. In doing so the non-volatile memory setting is reloaded into the DPP wiper control register. Since this value is the

**Figure 1. Writing to Memory**



**Figure 2. Reading from Memory**



same as that which had been there previously no change in the DPP's output is noticed. Had the value held in the control register been different from that stored in non-volatile memory then *a change would occur* at the read cycle's conclusion.

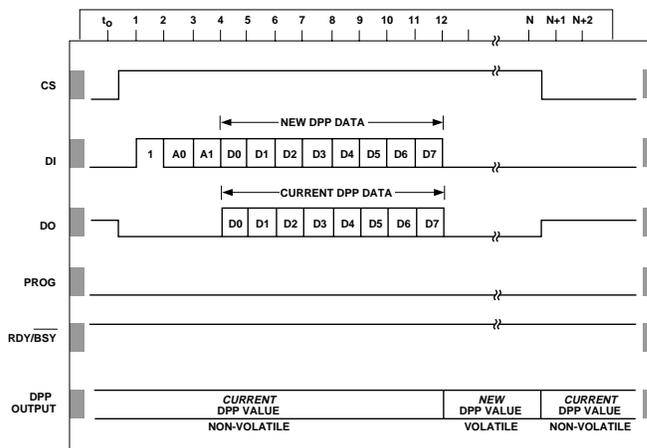
**TEMPORARILY CHANGE OUTPUT**

The CAT525 allows temporary changes in DPP's output to be made without disturbing the settings retained in non-volatile memory. This feature is particularly useful when testing for a new output setting and allows for user adjustment of preset or default values without losing the original factory settings.

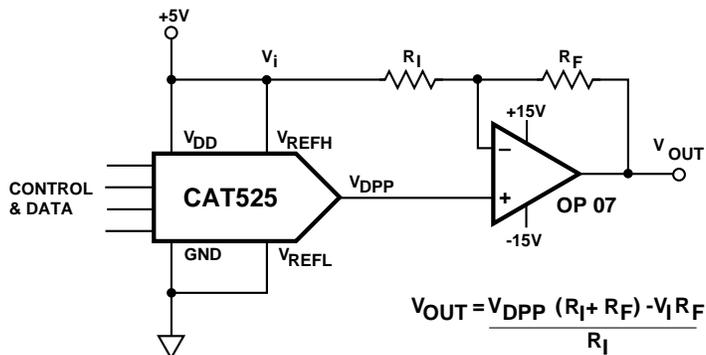
Figure 3 shows the control and data signals needed to effect a temporary output change. DPP settings may be changed as many times as required and can be made to any of the four DPPs in any order or sequence. The temporary setting(s) remain in effect long as CS remains high. When CS returns low all four DPPs will return to the output values stored in non-volatile memory.

When it is desired to save a new setting acquired using this feature, the new value must be reloaded into the DPP control register prior to programming. This is because the CAT525's internal control circuitry discards from the programming register the new data two clock cycles after receiving it if no PROG signal is received.

**Figure 3. Temporary Change in Output**



**APPLICATION CIRCUITS**

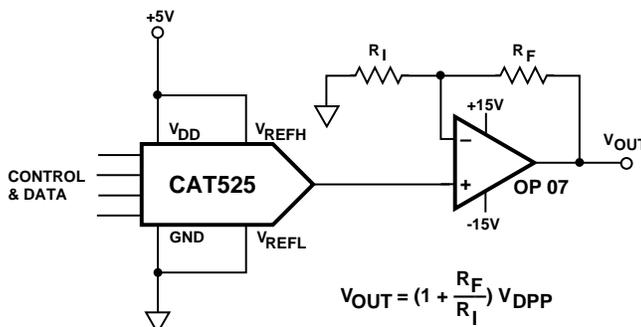


$$V_{OUT} = \frac{V_{DPP} (R_1 + R_F) - V_I R_F}{R_1}$$

For  $R_1 = R_F$   
 $V_{OUT} = 2V_{DPP} - V_I$

DPP INPUT		DPP OUTPUT	ANALOG OUTPUT
MSB	LSB	$V_{DPP} = \frac{CODE}{255} (V_{FS} - V_{ZERO}) + V_{ZERO}$ $V_{FS} = 0.99 V_{REF}$ $V_{ZERO} = 0.01 V_{REF}$	$V_{REF} = 5V$ $R_1 = R_F$
1111	1111	$\frac{255}{255} (.98 V_{REF}) + .01 V_{REF} = .990 V_{REF}$	$V_{OUT} = +4.90V$
1000	0000	$\frac{128}{255} (.98 V_{REF}) + .01 V_{REF} = .502 V_{REF}$	$V_{OUT} = +0.02V$
0111	1111	$\frac{127}{255} (.98 V_{REF}) + .01 V_{REF} = .498 V_{REF}$	$V_{OUT} = -0.02V$
0000	0001	$\frac{1}{255} (.98 V_{REF}) + .01 V_{REF} = .014 V_{REF}$	$V_{OUT} = -4.86V$
0000	0000	$\frac{0}{255} (.98 V_{REF}) + .01 V_{REF} = .010 V_{REF}$	$V_{OUT} = -4.90V$

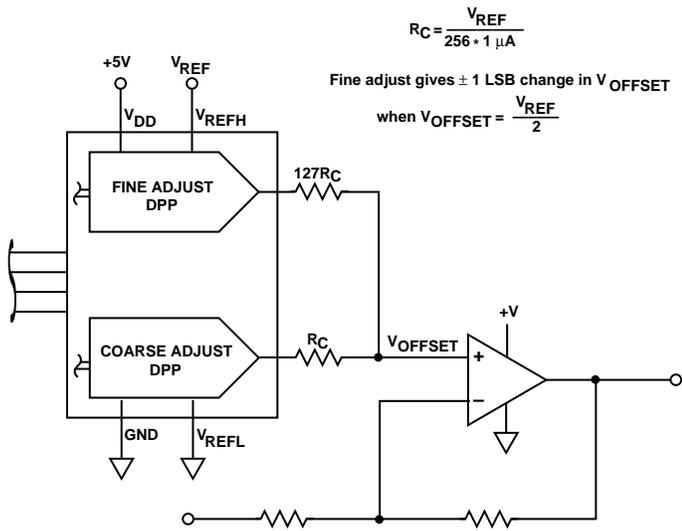
**Bipolar DPP Output**



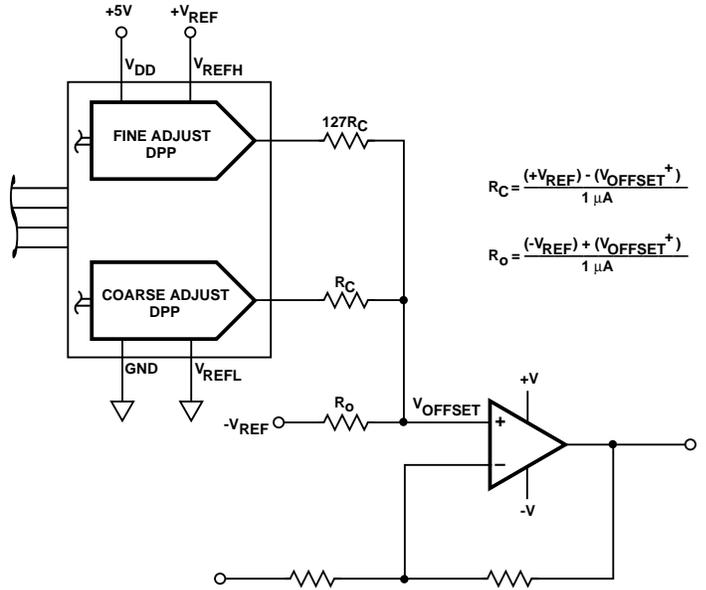
$$V_{OUT} = (1 + \frac{R_F}{R_1}) V_{DPP}$$

**Amplified DPP Output**

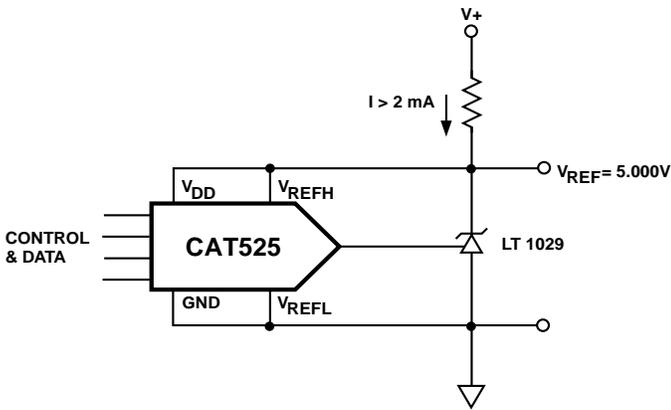
APPLICATION CIRCUITS (Cont.)



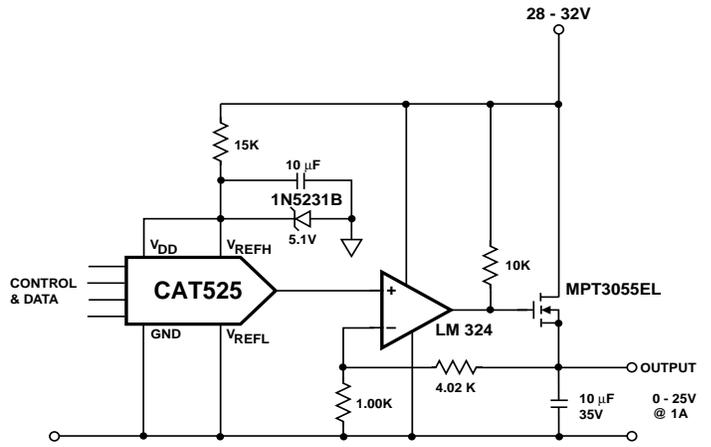
Coarse-Fine Offset Control by Averaging DPP Outputs for Single Power Supply Systems



Coarse-Fine Offset Control by Averaging DPP Outputs for Dual Power Supply Systems

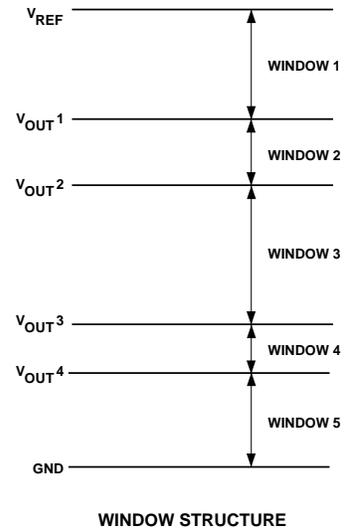
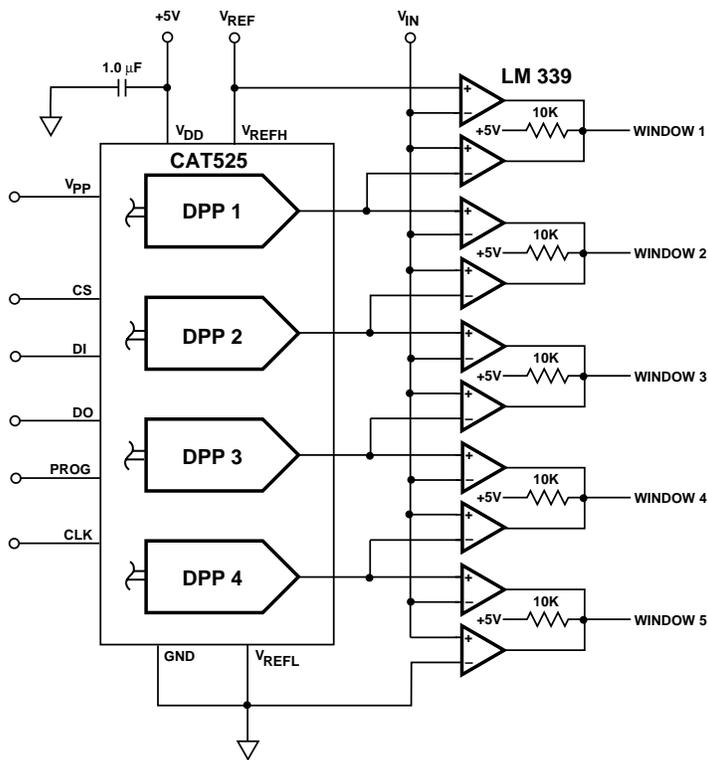


Digitally Trimmed Voltage Reference

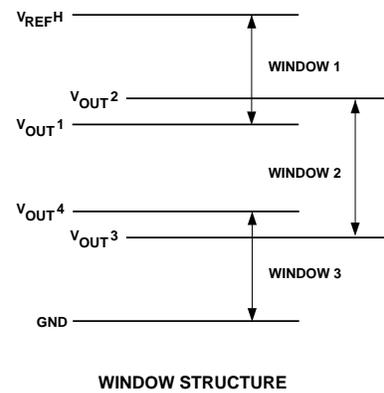
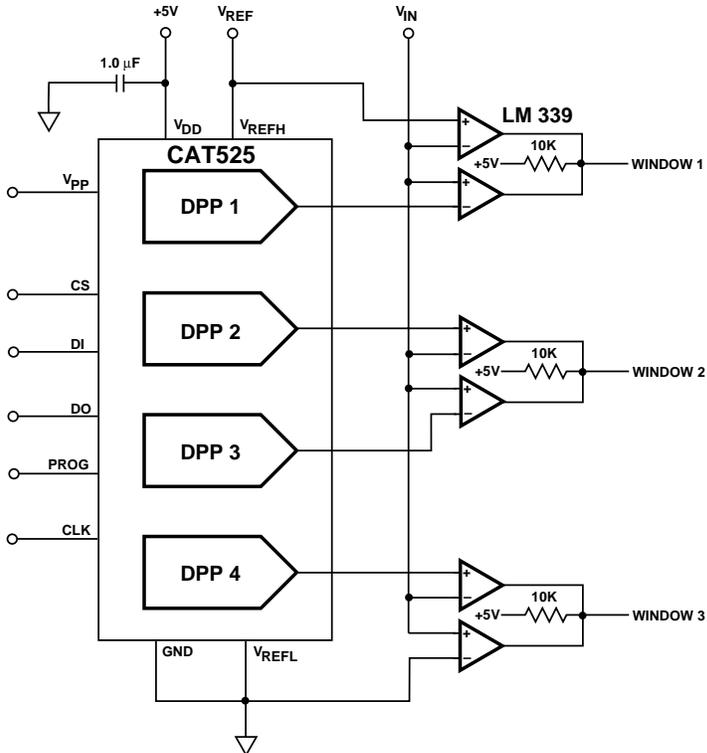


Digitally Controlled Voltage Reference

APPLICATION CIRCUITS (Cont.)

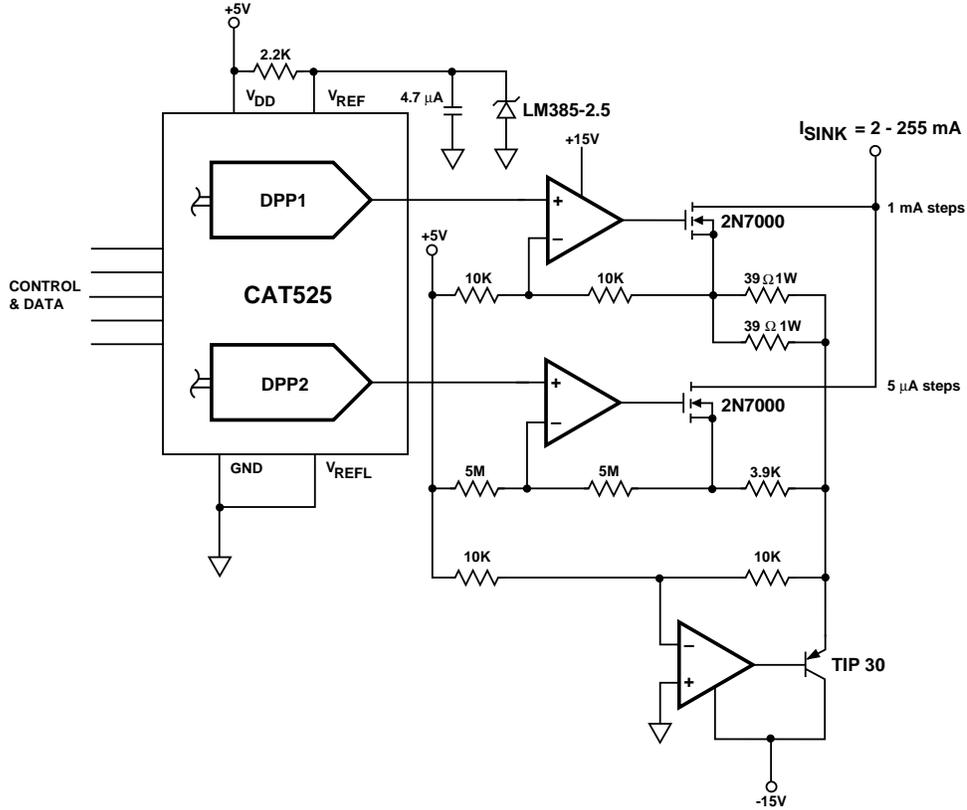


Staircase Window Comparator

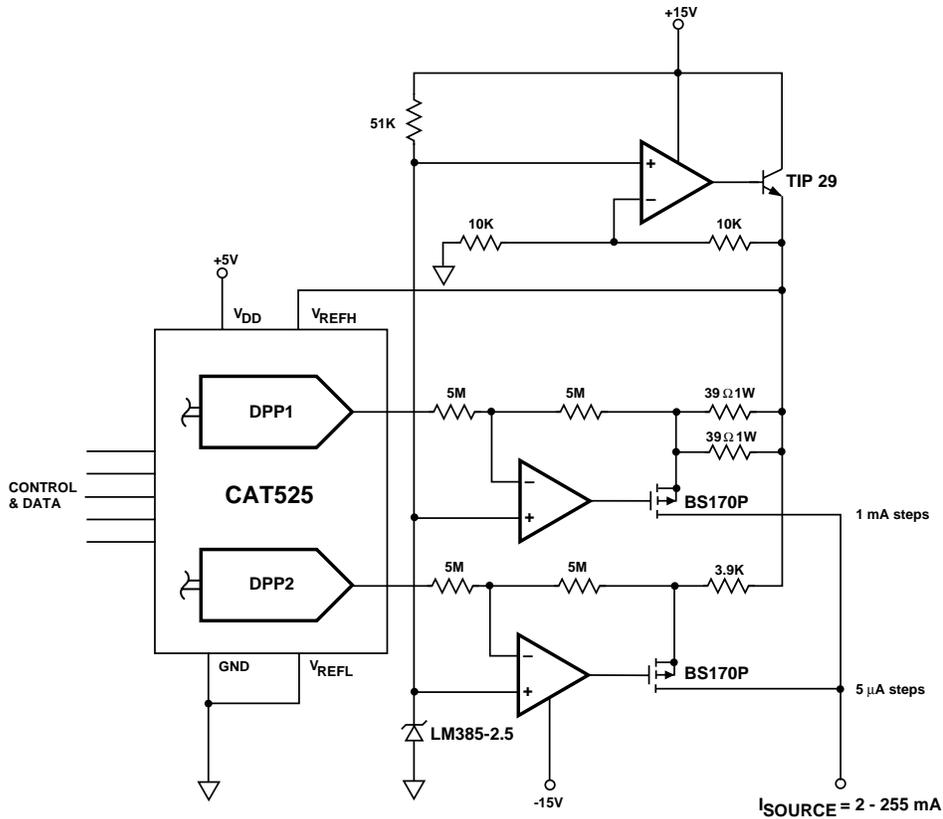


Overlapping Window Comparator

APPLICATION CIRCUITS (Cont.)

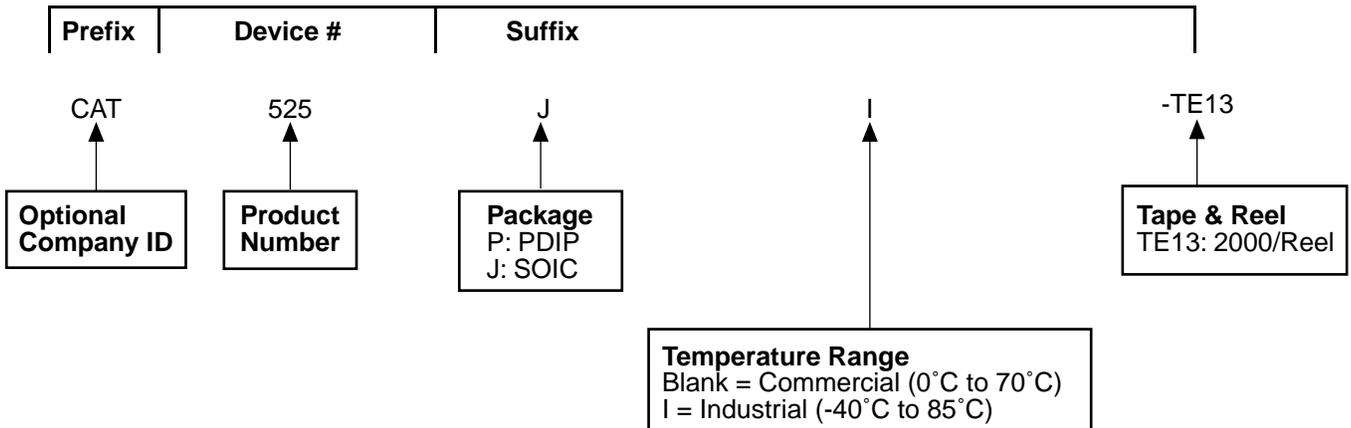


Current Sink with 4 Decades of Resolution



Current Source with 4 Decades of Resolution

**ORDERING INFORMATION**



Notes:

(1) The device used in the above example is a CAT525JI-TE13 (SOIC, Industrial Temperature, Tape & Reel)

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Publication #: 2001  
Revision: B  
Issue Date: 3/22/02  
Type: Final

# CAT5111

## 100-Tap Digitally Programmable Potentiometer (DPP™) with Buffered Wiper

### FEATURES

- 100-position linear taper potentiometer
- Non-volatile NVRAM wiper storage; buffered wiper
- Low power CMOS technology
- Single supply operation: 2.5V-6.0V
- Increment up/down serial interface
- Resistance values: 10kΩ, 50kΩ and 100kΩ
- Available in PDIP, SOIC, TSSOP and MSOP packages

### APPLICATIONS

- Automated product calibration
- Remote control adjustments
- Offset, gain and zero control
- Tamper-proof calibrations
- Contrast, brightness and volume controls
- Motor controls and feedback systems
- Programmable analog functions

### DESCRIPTION

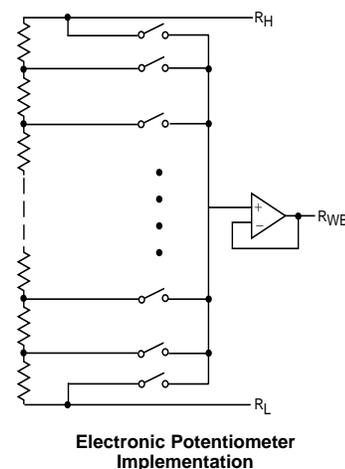
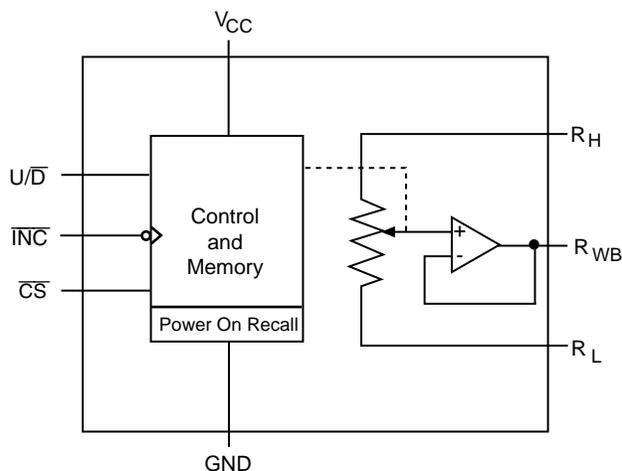
The CAT5111 is a single digitally programmable potentiometer (DPP™) designed as a electronic replacement for mechanical potentiometers and trim pots. Ideal for automated adjustments on high volume production lines, they are also well suited for applications where equipment requiring periodic adjustment is either difficult to access or located in a hazardous or remote environment.

The CAT5111 contains a 100-tap series resistor array connected between two terminals  $R_H$  and  $R_L$ . An up/down counter and decoder that are controlled by three input pins, determines which tap is connected to the wiper,  $R_{WB}$ . The CAT5111 wiper is buffered by an op amp that operates rail to rail. The wiper setting, stored in non-volatile NVRAM memory, is not lost when the device is powered down and is automatically recalled when

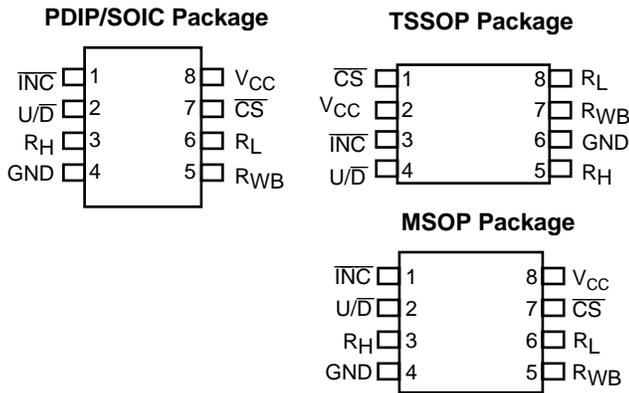
power is returned. The wiper can be adjusted to test new system values without effecting the stored setting. Wiper-control of the CAT5111 is accomplished with three input control pins,  $\overline{CS}$ ,  $U/\overline{D}$ , and  $\overline{INC}$ . The  $\overline{INC}$  input increments the wiper in the direction which is determined by the logic state of the  $U/\overline{D}$  input. The  $\overline{CS}$  input is used to select the device and also store the wiper position prior to power down.

The digitally programmable potentiometer can be used as a three-terminal resistive divider or as a two-terminal variable resistor. DPPs bring variability and programmability to a broad range of applications and are used primarily to control, regulate or adjust a characteristic or parameter of an analog circuit.

### FUNCTIONAL DIAGRAM



**PIN CONFIGURATION**



**PIN FUNCTIONS**

Pin Name	Function
$\overline{INC}$	Increment Control
$U/\overline{D}$	Up/Down Control
$R_H$	Potentiometer High Terminal
GND	Ground
$R_{WB}$	Buffered Wiper Terminal
$R_L$	Potentiometer Low Terminal
$\overline{CS}$	Chip Select
$V_{CC}$	Supply Voltage

**PIN DESCRIPTIONS**

**$\overline{INC}$ :** Increment Control Input

The  $\overline{INC}$  input (on the falling edge) moves the wiper in the up or down direction determined by the condition of the  $U/\overline{D}$  input.

**$U/\overline{D}$ :** Up/Down Control Input

The  $U/\overline{D}$  input controls the direction of the wiper movement. When in a high state and  $\overline{CS}$  is low, any high-to-low transition on  $\overline{INC}$  will cause the wiper to move one increment toward the  $R_H$  terminal. When in a low state and  $\overline{CS}$  is low, any high-to-low transition on  $\overline{INC}$  will cause the wiper to move one increment towards the  $R_L$  terminal.

**$R_H$ :** High End Potentiometer Terminal

$R_H$  is the high end terminal of the potentiometer. It is not required that this terminal be connected to a potential greater than the  $R_L$  terminal. Voltage applied to the  $R_H$  terminal cannot exceed the supply voltage,  $V_{CC}$  or go below ground, GND.

**$R_{WB}$ :** Wiper Potentiometer Terminal (Buffered)

$R_{WB}$  is the buffered wiper terminal of the potentiometer. Its position on the resistor array is controlled by the control inputs,  $\overline{INC}$ ,  $U/\overline{D}$  and  $\overline{CS}$ .

**$R_L$ :** Low End Potentiometer Terminal

$R_L$  is the low end terminal of the potentiometer. It is not required that this terminal be connected to a potential less than the  $R_H$  terminal. Voltage applied to the  $R_L$  terminal cannot exceed the supply voltage,  $V_{CC}$  or go below ground, GND.  $R_L$  and  $R_H$  are electrically interchangeable.

**$\overline{CS}$ :** Chip Select

The chip select input is used to activate the control input

of the CAT5111 and is active low. When in a high state, activity on the  $\overline{INC}$  and  $U/\overline{D}$  inputs will not affect or change the position of the wiper.

**DEVICE OPERATION**

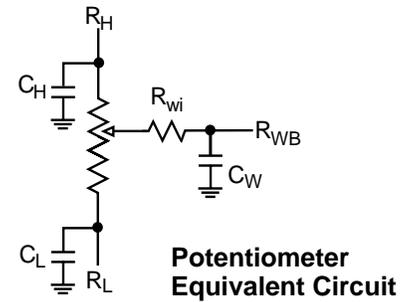
The CAT5111 operates like a digitally controlled potentiometer with  $R_H$  and  $R_L$  equivalent to the high and low terminals and  $R_{WB}$  equivalent to the mechanical potentiometer's wiper. There are 100 available tap positions including the resistor end points,  $R_H$  and  $R_L$ . There are 99 resistor elements connected in series between the  $R_H$  and  $R_L$  terminals. The wiper terminal is connected to one of the 100 taps and controlled by three inputs,  $\overline{INC}$ ,  $U/\overline{D}$  and  $\overline{CS}$ . These inputs control a seven-bit up/down counter whose output is decoded to select the wiper position. The selected wiper position can be stored in nonvolatile memory using the  $\overline{INC}$  and  $\overline{CS}$  inputs.

With  $\overline{CS}$  set LOW the CAT5111 is selected and will respond to the  $U/\overline{D}$  and  $\overline{INC}$  inputs. HIGH to LOW transitions on  $\overline{INC}$  will increment or decrement the wiper (depending on the state of the  $U/\overline{D}$  input and seven-bit counter). The wiper, when at either fixed terminal, acts like its mechanical equivalent and does not move beyond the last position. The value of the counter is stored in nonvolatile memory whenever  $\overline{CS}$  transitions HIGH while the  $\overline{INC}$  input is also HIGH. When the CAT5111 is powered-down, the last stored wiper counter position is maintained in the nonvolatile memory. When power is restored, the contents of the memory are recalled and the counter is set to the value stored.

With  $\overline{INC}$  set low, the CAT5111 may be de-selected and powered down without storing the current wiper position in nonvolatile memory. This allows the system to always power up to a preset value stored in nonvolatile memory.

**OPERATING MODES**

$\overline{INC}$	$\overline{CS}$	$U/\overline{D}$	Operation
High to Low	Low	High	Wiper toward $R_H$
High to Low	Low	Low	Wiper toward $R_L$
High	Low to High	X	Store Wiper Position
Low	Low to High	X	No Store, Return to Standby
X	High	X	Standby



**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage $V_{CC}$ to GND	-0.5V to +7V
Inputs $\overline{CS}$ to GND	-0.5V to $V_{CC} + 0.5V$
$\overline{INC}$ to GND	-0.5V to $V_{CC} + 0.5V$
$U/\overline{D}$ to GND	-0.5V to $V_{CC} + 0.5V$
$R_H$ to GND	-0.5V to $V_{CC} + 0.5V$
$R_L$ to GND	-0.5V to $V_{CC} + 0.5V$
$R_{WB}$ to GND	-0.5V to $V_{CC} + 0.5V$

Operating Ambient Temperature

Commercial ('C' or Blank suffix)	0°C to +70°C
Industrial ('I' suffix)	-40°C to +85°C
Junction Temperature	+150°C
Storage Temperature	-65°C to +150°C
Lead Soldering (10 sec max)	+300°C

\* Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Absolute Maximum Ratings are limited values applied individually while other parameters are within specified operating conditions, and functional operation at any of these conditions is NOT implied. Device performance and reliability may be impaired by exposure to absolute rating conditions for extended periods of time.

**RELIABILITY CHARACTERISTICS**

Symbol	Parameter	Test Method	Min	Typ	Max	Units
$V_{ZAP}^{(1)}$	ESD Susceptibility	MIL-STD-883, Test Method 3015	2000			Volts
$I_{LTH}^{(1)(2)}$	Latch-Up	JEDEC Standard 17	100			mA
$T_{DR}$	Data Retention	MIL-STD-883, Test Method 1008	100			Years
$N_{END}$	Endurance	MIL-STD-883, Test Method 1003	1,000,000			Stores

**DC Electrical Characteristics:  $V_{CC} = +2.5V$  to  $+6.0V$  unless otherwise specified**

**Power Supply**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{CC}$	Operating Voltage Range		2.5	—	6.0	V
$I_{CC1}$	Supply Current (Increment)	$V_{CC} = 6V, f = 1MHz, I_W=0$ $V_{CC} = 6V, f = 250kHz, I_W=0$	—	—	200 100	$\mu A$
$I_{CC2}$	Supply Current (Write)	Programming, $V_{CC} = 6V$ $V_{CC} = 3V$	—	—	1 500	mA $\mu A$
$ISB_1^{(2)}$	Supply Current (Standby)	$CS = V_{CC} - 0.3V$ $U/\overline{D}, INC = V_{CC} - 0.3V$ or GND	—	75	150	$\mu A$

**Logic Inputs**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{IH}$	Input Leakage Current	$V_{IN} = V_{CC}$	—	—	10	$\mu A$
$I_{IL}$	Input Leakage Current	$V_{IN} = 0V$	—	—	-10	$\mu A$
$V_{IH1}$	TTL High Level Input Voltage	$4.5V \leq V_{CC} \leq 5.5V$	2	—	$V_{CC}$	V
$V_{IL1}$	TTL Low Level Input Voltage		0	—	0.8	V
$V_{IH2}$	CMOS High Level Input Voltage	$2.5V \leq V_{CC} \leq 6V$	$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V
$V_{IL2}$	CMOS Low Level Input Voltage		-0.3	—	$V_{CC} \times 0.2$	V

- NOTES:**
- (1) This parameter is tested initially and after a design or process change that affects the parameter.
  - (2) Latch-up protection is provided for stresses up to 100mA on address and data pins from -1V to  $V_{CC} + 1V$
  - (3)  $I_W$ =source or sink
  - (4) These parameters are periodically sampled and are not 100% tested.

Potentiometer Parameters

Symbol	Parameter	Conditions	Min	Typ	Max	Units
R <sub>POT</sub>	Potentiometer Resistance	-10 Device		10		kΩ
		-50 Device		50		
		-00 Device		100		
	Pot Resistance Tolerance				±15	%
V <sub>RH</sub>	Voltage on R <sub>H</sub> pin		0		V <sub>CC</sub>	V
V <sub>RL</sub>	Voltage on R <sub>L</sub> pin		0		V <sub>CC</sub>	V
	Resolution			1		%
INL	Integral Linearity Error	I <sub>W</sub> ≤ 2μA		0.5	1	LSB
DNL	Differential Linearity Error	I <sub>W</sub> ≤ 2μA		0.25	0.5	LSB
R <sub>OUT</sub>	Buffer Output Resistance	.05V <sub>CC</sub> ≤ V <sub>WB</sub> ≤ .95V <sub>CC</sub> , V <sub>CC</sub> =5V			1	Ω
I <sub>OUT</sub>	Buffer Output Current	.05V <sub>CC</sub> ≤ V <sub>WB</sub> ≤ .95V <sub>CC</sub> , V <sub>CC</sub> =5V			3	mA
TC <sub>R<sub>POT</sub></sub>	TC of Pot Resistance			300		ppm/°C
TC <sub>RATIO</sub>	Ratiometric TC			TBD		ppm/°C
R <sub>ISO</sub>	Isolation Resistance			TBD		Ω
C <sub>RH</sub> /C <sub>R<sub>L</sub></sub> /C <sub>R<sub>W</sub></sub>	Potentiometer Capacitances			8/8/25		pF
fc	Frequency Response	Passive Attenuator, 10kΩ		1.7		MHz
V <sub>WB(SWING)</sub>	Output Voltage Range	I <sub>OUT</sub> ≤ 100μA, V <sub>CC</sub> =5V	0.01V <sub>CC</sub>		.99V <sub>CC</sub>	

**AC CONDITIONS OF TEST**

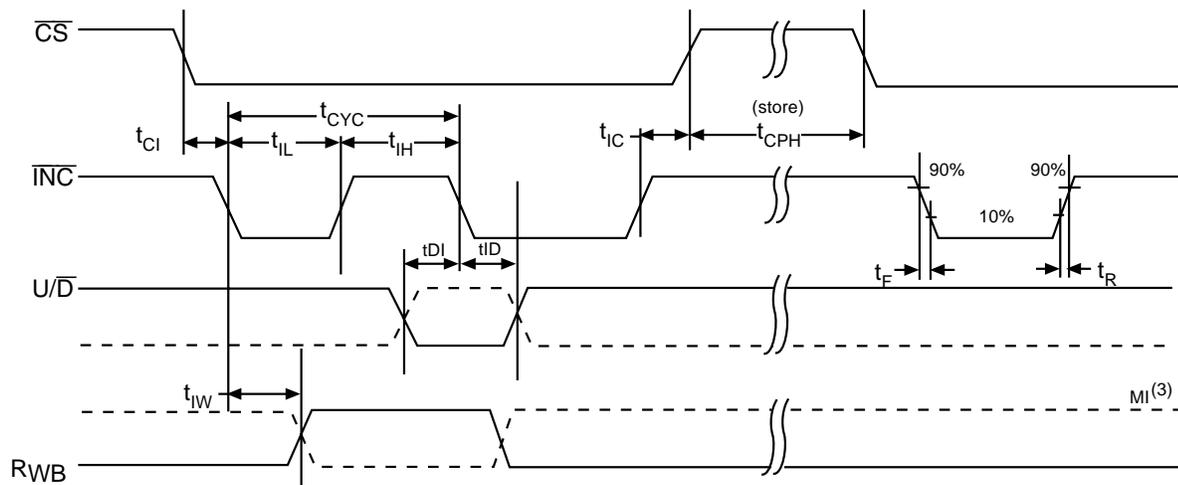
V <sub>CC</sub> Range	2.5V ≤ V <sub>CC</sub> ≤ 6V
Input Pulse Levels	0.2V <sub>CC</sub> to 0.7V <sub>CC</sub>
Input Rise and Fall Times	10ns
Input Reference Levels	0.5V <sub>CC</sub>

**AC OPERATING CHARACTERISTICS:**

V<sub>CC</sub> = +2.5V to +6.0V, V<sub>H</sub> = V<sub>CC</sub>, V<sub>L</sub> = 0V, unless otherwise specified

Symbol	Parameter	Min	Typ <sup>(1)</sup>	Max	Units
t <sub>CI</sub>	$\overline{CS}$ to INC Setup	100	—	—	ns
t <sub>DI</sub>	U/ $\overline{D}$ to $\overline{INC}$ Setup	50	—	—	ns
t <sub>ID</sub>	U/ $\overline{D}$ to $\overline{INC}$ Hold	100	—	—	ns
t <sub>IL</sub>	$\overline{INC}$ LOW Period	250	—	—	ns
t <sub>IH</sub>	$\overline{INC}$ HIGH Period	250	—	—	ns
t <sub>IC</sub>	$\overline{INC}$ Inactive to $\overline{CS}$ Inactive	1	—	—	μs
t <sub>CPH</sub>	$\overline{CS}$ Deselect Time (NO STORE)	100	—	—	ns
t <sub>CPH</sub>	$\overline{CS}$ Deselect Time (STORE)	10	—	—	ms
t <sub>IW</sub>	$\overline{INC}$ to V <sub>OUT</sub> Change	—	1	5	μs
t <sub>CYC</sub>	$\overline{INC}$ Cycle Time	1	—	—	μs
t <sub>R</sub> , t <sub>F</sub> <sup>(2)</sup>	$\overline{INC}$ Input Rise and Fall Time	—	—	500	μs
t <sub>PU</sub> <sup>(2)</sup>	Power-up to Wiper Stable	—	—	1	msec
t <sub>WR</sub>	Store Cycle	—	5	10	ms

**A. C. TIMING**

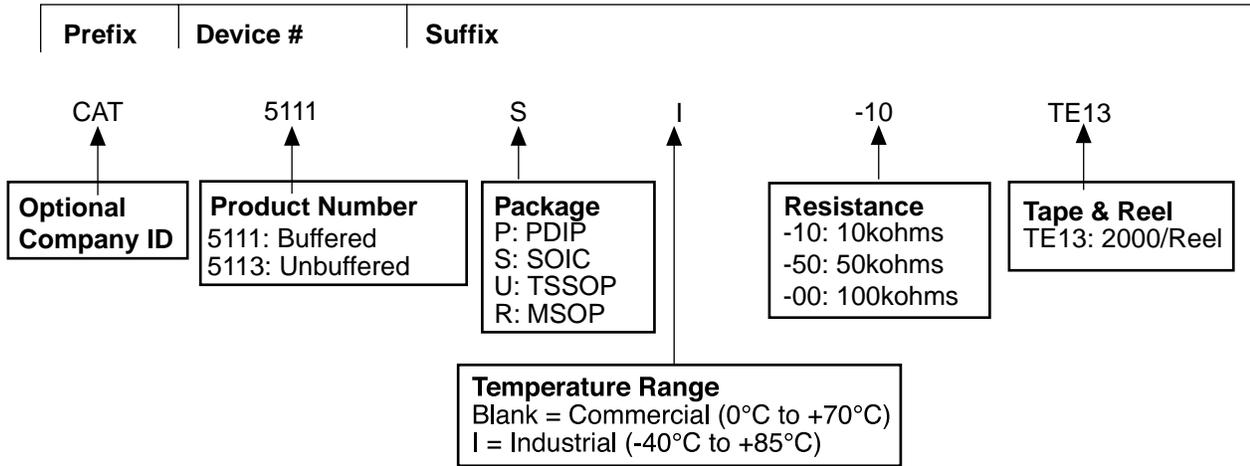


(1) Typical values are for T<sub>A</sub>=25°C and nominal supply voltage.

(2) This parameter is periodically sampled and not 100% tested.

(3) MI in the A.C. Timing diagram refers to the minimum incremental change in the W output due to a change in the wiper position.

**ORDERING INFORMATION**



Notes:

(1) The device used in the above example is a CAT5111 SI-10TE13 (SOIC, 10K Ohms, Industrial Temperature, Tape & Reel)

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 Revision: I  
 Issue date: 04/17/02  
 Type: Final



# CAT5112

## 32-Tap Digitally Programmable Potentiometer (DPP™) with Buffered Wiper

### FEATURES

- 32-position linear taper potentiometer
- Non-volatile NVRAM wiper storage; buffered wiper
- Low power CMOS technology
- Single supply operation: 2.5V-6.0V
- Increment up/down serial interface
- Resistance values: 10kΩ, 50kΩ and 100kΩ
- Available in PDIP, SOIC, TSSOP and MSOP packages

### APPLICATIONS

- Automated product calibration
- Remote control adjustments
- Offset, gain and zero control
- Tamper-proof calibrations
- Contrast, brightness and volume controls
- Motor controls and feedback systems
- Programmable analog functions

### DESCRIPTION

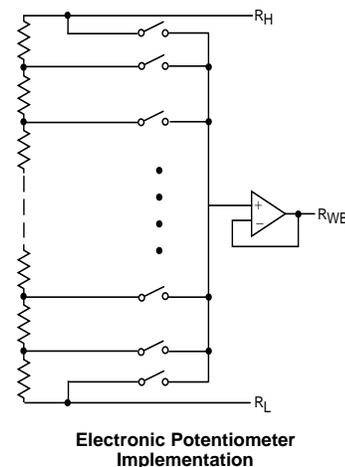
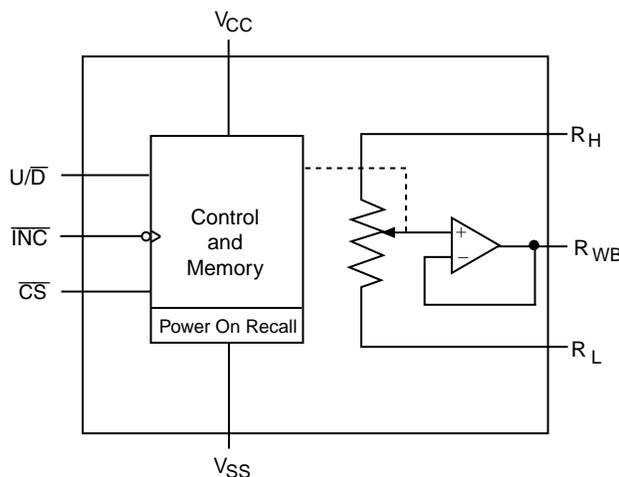
The CAT5112 is a single digitally programmable potentiometer (DPP™) designed as a electronic replacement for mechanical potentiometers and trim pots. Ideal for automated adjustments on high volume production lines, they are also well suited for applications where equipment requiring periodic adjustment is either difficult to access or located in a hazardous or remote environment.

The CAT5112 contains a 32-tap series resistor array connected between two terminals  $R_H$  and  $R_L$ . An up/down counter and decoder that are controlled by three input pins, determines which tap is connected to the wiper,  $R_{WB}$ . The CAT5112 wiper is buffered by an op amp that operates rail to rail. The wiper setting, stored in non-volatile NVRAM memory, is not lost when the device is powered down and is automatically recalled when

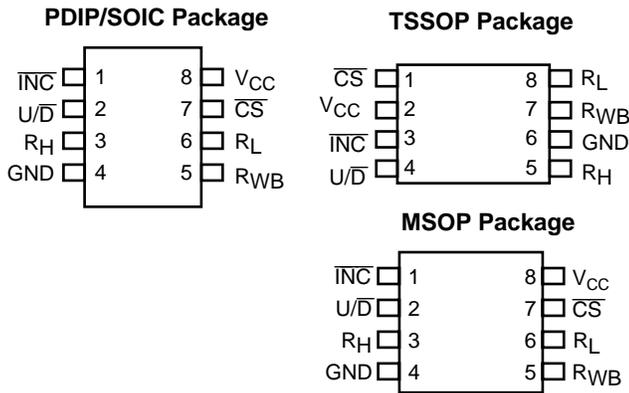
power is returned. The wiper can be adjusted to test new system values without effecting the stored setting. Wiper-control of the CAT5112 is accomplished with three input control pins,  $\overline{CS}$ ,  $U/\overline{D}$ , and  $\overline{INC}$ . The  $\overline{INC}$  input increments the wiper in the direction which is determined by the logic state of the  $U/\overline{D}$  input. The  $\overline{CS}$  input is used to select the device and also store the wiper position prior to power down.

The digitally programmable potentiometer can be used as a three-terminal resistive divider or as a two-terminal variable resistor. DPPs bring variability and programmability to a broad range of applications and are used primarily to control, regulate or adjust a characteristic or parameter of an analog circuit.

### FUNCTIONAL DIAGRAM



**PIN CONFIGURATION**



**PIN FUNCTIONS**

Pin Name	Function
INC	Increment Control
U/D	Up/Down Control
R <sub>H</sub>	Potentiometer High Terminal
GND	Ground
R <sub>WB</sub>	Buffered Wiper Terminal
R <sub>L</sub>	Potentiometer Low Terminal
CS	Chip Select
V <sub>CC</sub>	Supply Voltage

**PIN DESCRIPTIONS**

**INC:** Increment Control Input

The INC input (on the falling edge) moves the wiper in the up or down direction determined by the condition of the U/D input.

**U/D:** Up/Down Control Input

The U/D input controls the direction of the wiper movement. When in a high state and CS is low, any high-to-low transition on INC will cause the wiper to move one increment toward the R<sub>H</sub> terminal. When in a low state and CS is low, any high-to-low transition on INC will cause the wiper to move one increment towards the R<sub>L</sub> terminal.

**R<sub>H</sub>:** High End Potentiometer Terminal

R<sub>H</sub> is the high end terminal of the potentiometer. It is not required that this terminal be connected to a potential greater than the R<sub>L</sub> terminal. Voltage applied to the R<sub>H</sub> terminal cannot exceed the supply voltage, V<sub>CC</sub> or go below ground, GND.

**R<sub>WB</sub>:** Wiper Potentiometer Terminal (Buffered)

R<sub>WB</sub> is the buffered wiper terminal of the potentiometer. Its position on the resistor array is controlled by the control inputs, INC, U/D and CS.

**R<sub>L</sub>:** Low End Potentiometer Terminal

R<sub>L</sub> is the low end terminal of the potentiometer. It is not required that this terminal be connected to a potential less than the R<sub>H</sub> terminal. Voltage applied to the R<sub>L</sub> terminal cannot exceed the supply voltage, V<sub>CC</sub> or go below ground, GND. R<sub>L</sub> and R<sub>H</sub> are electrically interchangeable.

**CS:** Chip Select

The chip select input is used to activate the control input

of the CAT5112 and is active low. When in a high state, activity on the INC and U/D inputs will not affect or change the position of the wiper.

**DEVICE OPERATION**

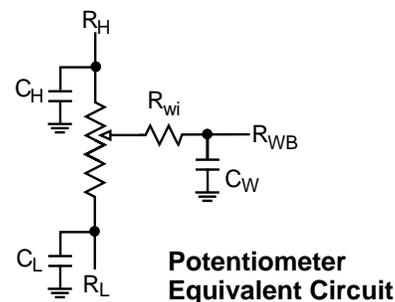
The CAT5112 operates like a digitally controlled potentiometer with R<sub>H</sub> and R<sub>L</sub> equivalent to the high and low terminals and R<sub>WB</sub> equivalent to the mechanical potentiometer's wiper. There are 32 available tap positions including the resistor end points, R<sub>H</sub> and R<sub>L</sub>. There are 31 resistor elements connected in series between the R<sub>H</sub> and R<sub>L</sub> terminals. The wiper terminal is connected to one of the 32 taps and controlled by three inputs, INC, U/D and CS. These inputs control a five-bit up/down counter whose output is decoded to select the wiper position. The selected wiper position can be stored in nonvolatile memory using the INC and CS inputs.

With CS set LOW the CAT5112 is selected and will respond to the U/D and INC inputs. HIGH to LOW transitions on INC will increment or decrement the wiper (depending on the state of the U/D input and five-bit counter). The wiper, when at either fixed terminal, acts like its mechanical equivalent and does not move beyond the last position. The value of the counter is stored in nonvolatile memory whenever CS transitions HIGH while the INC input is also HIGH. When the CAT5112 is powered-down, the last stored wiper counter position is maintained in the nonvolatile memory. When power is restored, the contents of the memory are recalled and the counter is set to the value stored.

With INC set low, the CAT5112 may be de-selected and powered down without storing the current wiper position in nonvolatile memory. This allows the system to always power up to a preset value stored in nonvolatile memory.

## OPERATING MODES

$\overline{\text{INC}}$	$\overline{\text{CS}}$	$\text{U}/\overline{\text{D}}$	Operation
High to Low	Low	High	Wiper toward H
High to Low	Low	Low	Wiper toward L
High	Low to High	X	Store Wiper Position
Low	Low to High	X	No Store, Return to Standby
X	High	X	Standby



## ABSOLUTE MAXIMUM RATINGS

Supply Voltage $V_{CC}$ to GND	-0.5V to +7V
Inputs	
$\overline{\text{CS}}$ to GND	-0.5V to $V_{CC} + 0.5V$
$\overline{\text{INC}}$ to GND	-0.5V to $V_{CC} + 0.5V$
$\text{U}/\overline{\text{D}}$ to GND	-0.5V to $V_{CC} + 0.5V$
$R_H$ to GND	-0.5V to $V_{CC} + 0.5V$
$R_L$ to GND	-0.5V to $V_{CC} + 0.5V$
$R_{WB}$ to GND	-0.5V to $V_{CC} + 0.5V$

## Operating Ambient Temperature

Commercial ('C' or Blank suffix)	0°C to +70°C
Industrial ('I' suffix)	-40°C to +85°C
Junction Temperature	+150°C
Storage Temperature	-65°C to +150°C
Lead Soldering (10 sec max)	+300°C

\* Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Absolute Maximum Ratings are limited values applied individually while other parameters are within specified operating conditions, and functional operation at any of these conditions is NOT implied. Device performance and reliability may be impaired by exposure to absolute rating conditions for extended periods of time.

## RELIABILITY CHARACTERISTICS

Symbol	Parameter	Test Method	Min	Typ	Max	Units
$V_{ZAP}^{(1)}$	ESD Susceptibility	MIL-STD-883, Test Method 3015	2000			Volts
$I_{LTH}^{(1)(2)}$	Latch-Up	JEDEC Standard 17	100			mA
$T_{DR}$	Data Retention	MIL-STD-883, Test Method 1008	100			Years
$N_{END}$	Endurance	MIL-STD-883, Test Method 1003	1,000,000			Stores

DC Electrical Characteristics:  $V_{CC} = +2.5V$  to  $+6.0V$  unless otherwise specified

## Power Supply

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{CC}$	Operating Voltage Range		2.5	—	6.0	V
$I_{CC1}$	Supply Current (Increment)	$V_{CC} = 6V, f = 1MHz, I_W = 0$ $V_{CC} = 6V, f = 250kHz, I_W = 0$	—	—	200 100	$\mu A$
$I_{CC2}$	Supply Current (Write)	Programming, $V_{CC} = 6V$ $V_{CC} = 3V$	—	—	1 500	mA $\mu A$
$ISB_1^{(2)}$	Supply Current (Standby)	$CS = V_{CC} - 0.3V$ $U/D, INC = V_{CC} - 0.3V$ or GND	—	75	150	$\mu A$

## Logic Inputs

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{IH}$	Input Leakage Current	$V_{IN} = V_{CC}$	—	—	10	$\mu A$
$I_{IL}$	Input Leakage Current	$V_{IN} = 0V$	—	—	-10	$\mu A$
$V_{IH1}$	TTL High Level Input Voltage	$4.5V \leq V_{CC} \leq 5.5V$	2	—	$V_{CC}$	V
$V_{IL1}$	TTL Low Level Input Voltage		0	—	0.8	V
$V_{IH2}$	CMOS High Level Input Voltage	$2.5V \leq V_{CC} \leq 6V$	$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V
$V_{IL2}$	CMOS Low Level Input Voltage		-0.3	—	$V_{CC} \times 0.2$	V

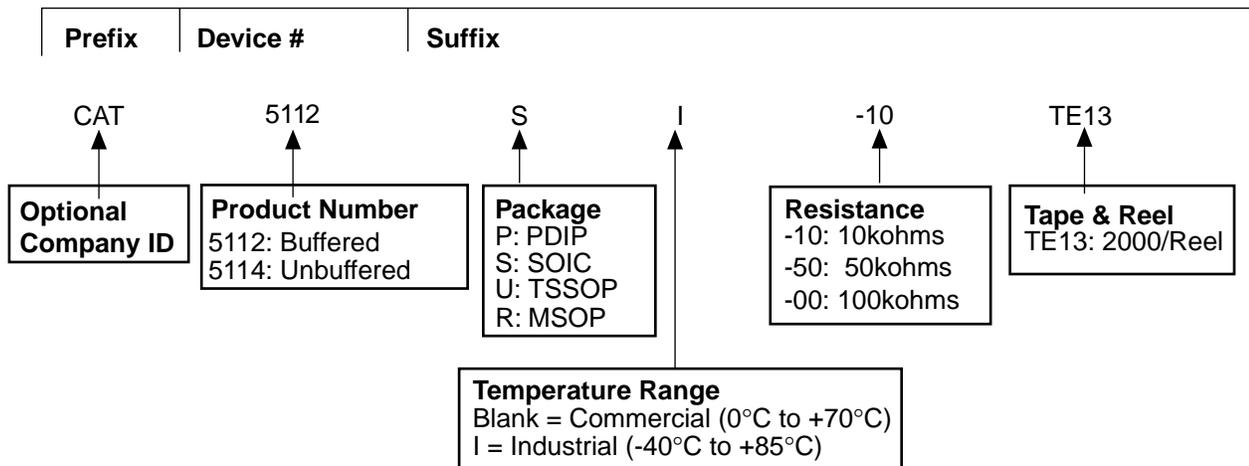
- NOTES: (1) This parameter is tested initially and after a design or process change that affects the parameter.  
(2) Latch-up protection is provided for stresses up to 100mA on address and data pins from -1V to  $V_{CC} + 1V$   
(3)  $I_W$ =source or sink  
(4) These parameters are periodically sampled and are not 100% tested.

Potentiometer Parameters

Symbol	Parameter	Conditions	Min	Typ	Max	Units
R <sub>POT</sub>	Potentiometer Resistance	-10 Device		10		kΩ
		-50 Device		50		
		-00 Device		100		
	Pot Resistance Tolerance				±15	%
V <sub>RH</sub>	Voltage on R <sub>H</sub> pin		0		V <sub>CC</sub>	V
V <sub>RL</sub>	Voltage on R <sub>L</sub> pin		0		V <sub>CC</sub>	V
	Resolution			1		%
INL	Integral Linearity Error	I <sub>W</sub> ≤ 2μA		0.5	1	LSB
DNL	Differential Linearity Error	I <sub>W</sub> ≤ 2μA		0.25	0.5	LSB
R <sub>OUT</sub>	Buffer Output Resistance	.05V <sub>CC</sub> ≤ V <sub>WB</sub> ≤ .95V <sub>CC</sub> , V <sub>CC</sub> =5V			1	Ω
I <sub>OUT</sub>	Buffer Output Current	.05V <sub>CC</sub> ≤ V <sub>WB</sub> ≤ .95V <sub>CC</sub> , V <sub>CC</sub> =5V			3	mA
TC <sub>R<sub>POT</sub></sub>	TC of Pot Resistance			300		ppm/°C
TC <sub>RATIO</sub>	Ratiometric TC			TBD		ppm/°C
R <sub>ISO</sub>	Isolation Resistance			TBD		Ω
C <sub>RH</sub> /C <sub>R<sub>L</sub></sub> /C <sub>R<sub>W</sub></sub>	Potentiometer Capacitances			8/8/25		pF
f <sub>c</sub>	Frequency Response	Passive Attenuator, 10kΩ		1.7		MHz
V <sub>WB(SWING)</sub>	Output Voltage Range	I <sub>OUT</sub> ≤ 100μA, V <sub>CC</sub> =5V	0.01V <sub>CC</sub>		.99V <sub>CC</sub>	



**ORDERING INFORMATION**



Notes:

(1) The device used in the above example is a CAT5112 SI-10TE13 (SOIC, 10K Ohms, Industrial Temperature, Tape & Reel)

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Publication #: 2002  
 Revision: F  
 Issue date: 4/18/02  
 Type: Final



# CAT5113

## 100-Tap Digitally Programmable Potentiometer (DPP™)

### FEATURES

- 100-position linear taper potentiometer
- Non-volatile NVRAM wiper storage
- Low power CMOS technology
- Single supply operation: 2.5V-6.0V
- Increment Up/Down serial interface
- Resistance values: 10kΩ , 50kΩ and 100kΩ
- Available in PDIP, SOIC, TSSOP and MSOP packages

### APPLICATIONS

- Automated product calibration
- Remote control adjustments
- Offset, gain and zero control
- Tamper-proof calibrations
- Contrast, brightness and volume controls
- Motor controls and feedback systems
- Programmable analog functions

### DESCRIPTION

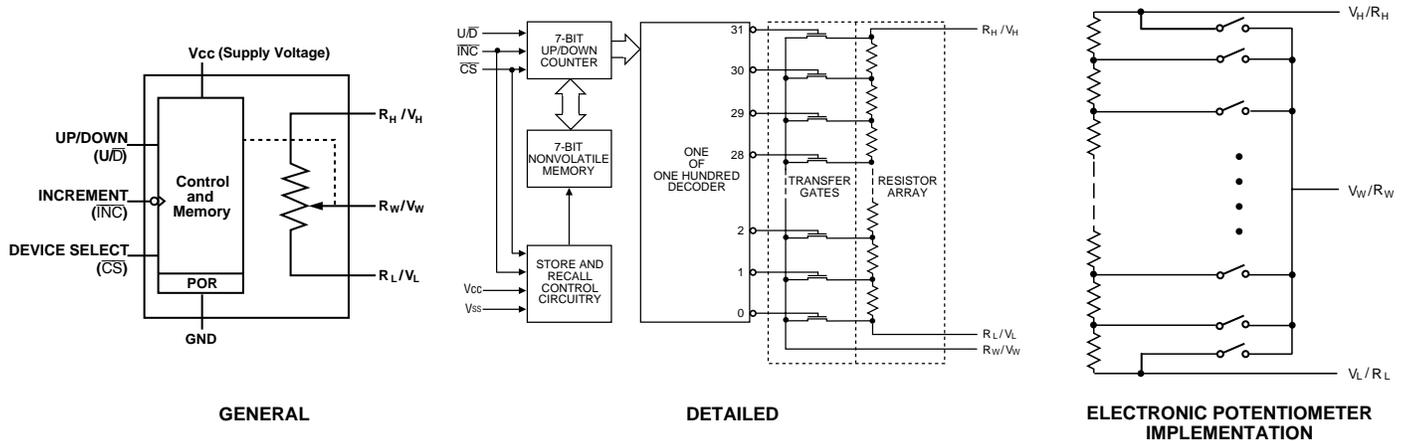
The CAT5113 is a single digitally programmable potentiometer (DPP™) designed as an electronic replacement for mechanical potentiometers and trim pots. Ideal for automated adjustments on high volume production lines, they are also well suited for applications where equipment requiring periodic adjustment is either difficult to access or located in a hazardous or remote environment.

The CAT5113 contains a 100-tap series resistor array connected between two terminals  $R_H$  and  $R_L$ . An up/down counter and decoder that are controlled by three input pins, determines which tap is connected to the wiper,  $R_W$ . The wiper setting, stored in nonvolatile memory, is not lost when the device is powered down and is automatically reinstated when power is returned. The wiper can be adjusted to test

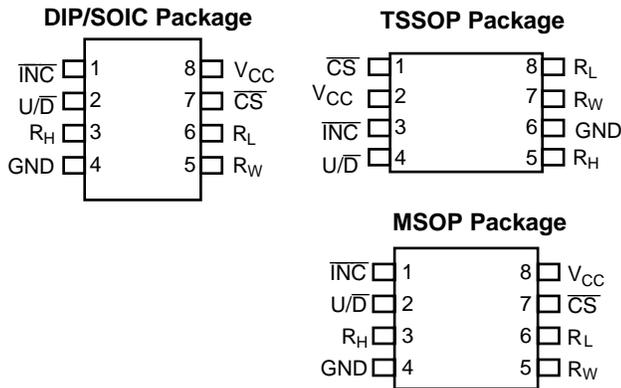
new system values without effecting the stored setting. Wiper-control of the CAT5113 is accomplished with three input control pins,  $\overline{CS}$ ,  $U/\overline{D}$ , and  $\overline{INC}$ . The  $\overline{INC}$  input increments the wiper in the direction which is determined by the logic state of the  $U/\overline{D}$  input. The  $\overline{CS}$  input is used to select the device and also store the wiper position prior to power down.

The digitally programmable potentiometer can be used as a three-terminal resistive divider or as a two-terminal variable resistor. DPPs bring variability and programmability to a wide variety of applications including control, parameter adjustments, and signal processing.

### FUNCTIONAL DIAGRAM



**PIN CONFIGURATION**



**PIN FUNCTIONS**

Pin Name	Function
$\overline{INC}$	Increment Control
$\overline{U/D}$	Up/Down Control
R <sub>H</sub>	Potentiometer High Terminal
GND	Ground
R <sub>W</sub>	Potentiometer Wiper Terminal
R <sub>L</sub>	Potentiometer Low Terminal
$\overline{CS}$	Chip Select
V <sub>CC</sub>	Supply Voltage

**PIN DESCRIPTIONS**

**$\overline{INC}$ :** Increment Control Input

The  $\overline{INC}$  input moves the wiper in the up or down direction determined by the condition of the  $\overline{U/D}$  input.

**$\overline{U/D}$ :** Up/Down Control Input

The  $\overline{U/D}$  input controls the direction of the wiper movement. When in a high state and  $\overline{CS}$  is low, any high-to-low transition on  $\overline{INC}$  will cause the wiper to move one increment toward the R<sub>H</sub> terminal. When in a low state and  $\overline{CS}$  is low, any high-to-low transition on  $\overline{INC}$  will cause the wiper to move one increment towards the R<sub>L</sub> terminal.

**R<sub>H</sub>:** High End Potentiometer Terminal

R<sub>H</sub> is the high end terminal of the potentiometer. It is not required that this terminal be connected to a potential greater than the R<sub>L</sub> terminal. Voltage applied to the R<sub>H</sub> terminal cannot exceed the supply voltage, V<sub>CC</sub> or go below ground, GND.

**R<sub>W</sub>:** Wiper Potentiometer Terminal

R<sub>W</sub> is the wiper terminal of the potentiometer. Its position on the resistor array is controlled by the control inputs,  $\overline{INC}$ ,  $\overline{U/D}$  and  $\overline{CS}$ . Voltage applied to the R<sub>W</sub> terminal cannot exceed the supply voltage, V<sub>CC</sub> or go below ground, GND.

**R<sub>L</sub>:** Low End Potentiometer Terminal

R<sub>L</sub> is the low end terminal of the potentiometer. It is not required that this terminal be connected to a potential less than the R<sub>H</sub> terminal. Voltage applied to the R<sub>L</sub> terminal cannot exceed the supply voltage, V<sub>CC</sub> or go below ground, GND. R<sub>L</sub> and R<sub>H</sub> are electrically interchangeable.

**$\overline{CS}$ :** Chip Select

The chip select input is used to activate the control input

of the CAT5113 and is active low. When in a high state, activity on the  $\overline{INC}$  and  $\overline{U/D}$  inputs will not affect or change the position of the wiper.

**DEVICE OPERATION**

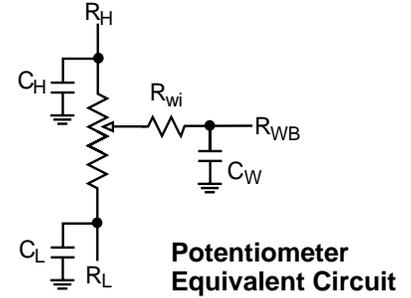
The CAT5113 operates like a digitally controlled potentiometer with R<sub>H</sub> and R<sub>L</sub> equivalent to the high and low terminals and R<sub>W</sub> equivalent to the mechanical potentiometer's wiper. There are 100 available tap positions including the resistor end points, R<sub>H</sub> and R<sub>L</sub>. There are 99 resistor elements connected in series between the R<sub>H</sub> and R<sub>L</sub> terminals. The wiper terminal is connected to one of the 100 taps and controlled by three inputs,  $\overline{INC}$ ,  $\overline{U/D}$  and  $\overline{CS}$ . These inputs control a seven-bit up/down counter whose output is decoded to select the wiper position. The selected wiper position can be stored in nonvolatile memory using the  $\overline{INC}$  and  $\overline{CS}$  inputs.

With  $\overline{CS}$  set LOW the CAT5113 is selected and will respond to the  $\overline{U/D}$  and  $\overline{INC}$  inputs. HIGH to LOW transitions on  $\overline{INC}$  will increment or decrement the wiper (depending on the state of the  $\overline{U/D}$  input and seven-bit counter). The wiper, when at either fixed terminal, acts like its mechanical equivalent and does not move beyond the last position. The value of the counter is stored in nonvolatile memory whenever  $\overline{CS}$  transitions HIGH while the  $\overline{INC}$  input is also HIGH. When the CAT5113 is powered-down, the last stored wiper counter position is maintained in the nonvolatile memory. When power is restored, the contents of the memory are recalled and the counter is set to the value stored.

With  $\overline{INC}$  set low, the CAT5113 may be de-selected and powered down without storing the current wiper position in nonvolatile memory. This allows the system to always power up to a preset value stored in nonvolatile memory.

## OPERATION MODES

$\overline{INC}$	$\overline{CS}$	U/D	Operation
High to Low	Low	High	Wiper toward H
High to Low	Low	Low	Wiper toward L
High	Low to High	X	Store Wiper Position
Low	Low to High	X	No Store, Return to Standby
X	High	X	Standby



## ABSOLUTE MAXIMUM RATINGS

Supply Voltage

$V_{CC}$  to GND ..... -0.5V to +7V

Inputs

$\overline{CS}$  to GND ..... -0.5V to  $V_{CC} + 0.5V$

$\overline{INC}$  to GND ..... -0.5V to  $V_{CC} + 0.5V$

U/D to GND ..... -0.5V to  $V_{CC} + 0.5V$

H to GND ..... -0.5V to  $V_{CC} + 0.5V$

L to GND ..... -0.5V to  $V_{CC} + 0.5V$

W to GND ..... -0.5V to  $V_{CC} + 0.5V$

Operating Ambient Temperature

Commercial ('C' or Blank suffix) ..... 0°C to +70°C

Industrial ('I' suffix) ..... -40°C to +85°C

Junction Temperature ..... +150°C

Storage Temperature ..... -65°C to +150°C

Lead Soldering (10 sec max) ..... +300°C

\* Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Absolute Maximum Ratings are limited values applied individually while other parameters are within specified operating conditions, and functional operation at any of these conditions is NOT implied. Device performance and reliability may be impaired by exposure to absolute rating conditions for extended periods of time.

## RELIABILITY CHARACTERISTICS

Symbol	Parameter	Test Method	Min	Typ	Max	Units
$V_{ZAP}^{(1)}$	ESD Susceptibility	MIL-STD-883, Test Method 3015	2000			Volts
$I_{LTH}^{(1)(2)}$	Latch-Up	JEDEC Standard 17	100			mA
$T_{DR}$	Data Retention	MIL-STD-883, Test Method 1008	100			Years
$N_{END}$	Endurance	MIL-STD-883, Test Method 1003	1,000,000			Stores

## DC Electrical Characteristics: $V_{CC} = +2.5V$ to $+6.0V$ unless otherwise specified

### Power Supply

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{CC}$	Operating Voltage Range		2.5	—	6.0	V
$I_{CC1}$	Supply Current (Increment)	$V_{CC} = 6V, f = 1MHz, I_W = 0$ $V_{CC} = 6V, f = 250kHz, I_W = 0$	—	—	100	$\mu A$
$I_{CC2}$	Supply Current (Write)	Programming, $V_{CC} = 6V$ $V_{CC} = 3V$	—	—	1	mA
$ISB_1^{(2)}$	Supply Current (Standby)	$CS = V_{CC} - 0.3V$ U/D, $INC = V_{CC} - 0.3V$ or GND	—	—	1	$\mu A$

### Logic Inputs

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{IH}$	Input Leakage Current	$V_{IN} = V_{CC}$	—	—	10	$\mu A$
$I_{IL}$	Input Leakage Current	$V_{IN} = 0V$	—	—	-10	$\mu A$
$V_{IH1}$	TTL High Level Input Voltage	$4.5V \leq V_{CC} \leq 5.5V$	2	—	$V_{CC}$	V
$V_{IL1}$	TTL Low Level Input Voltage					
$V_{IH2}$	CMOS High Level Input Voltage	$2.5V \leq V_{CC} \leq 6V$	$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V
$V_{IL2}$	CMOS Low Level Input Voltage					

- NOTES:** (1) This parameter is tested initially and after a design or process change that affects the parameter.  
 (2) Latch-up protection is provided for stresses up to 100mA on address and data pins from -1V to  $V_{CC} + 1V$   
 (3)  $I_W$ =source or sink  
 (4) These parameters are periodically sampled and are not 100% tested.

## Potentiometer Parameters

Symbol	Parameter	Conditions	Min	Typ	Max	Units
R <sub>POT</sub>	Potentiometer Resistance	-10 Device		10		kΩ
		-50 Device		50		
		-00 Device		100		
	Pot Resistance Tolerance				±15	%
V <sub>RH</sub>	Voltage on R <sub>H</sub> pin		0		V <sub>CC</sub>	V
V <sub>RL</sub>	Voltage on R <sub>L</sub> pin		0		V <sub>CC</sub>	V
	Resolution			1%		%
INL	Integral Linearity Error	I <sub>W</sub> ≤ 2μA		0.5	1	LSB
DNL	Differential Linearity Error	I <sub>W</sub> ≤ 2μA		0.25	0.5	LSB
R <sub>Wi</sub>	Wiper Resistance	V <sub>CC</sub> = 5V, I <sub>W</sub> = 1mA			400	Ω
		V <sub>CC</sub> = 2.5V, I <sub>W</sub> = 1mA			1	kΩ
I <sub>W</sub>	Wiper Current				1	mA
TC <sub>R<sub>POT</sub></sub>	TC of Pot Resistance			300		ppm/°C
TC <sub>R<sub>RATIO</sub></sub>	Ratiometric TC				20	ppm/°C
R <sub>ISO</sub>	Isolation Resistance			TBD		Ω
V <sub>N</sub>	Noise	100kHz / 1kHz		8/24		nV/√Hz
C <sub>H</sub> /C <sub>L</sub> /C <sub>W</sub>	Potentiometer Capacitances			8/8/25		pF
fc	Frequency Response	Passive Attenuator, 10kΩ		1.7		MHz

## AC CONDITIONS OF TEST

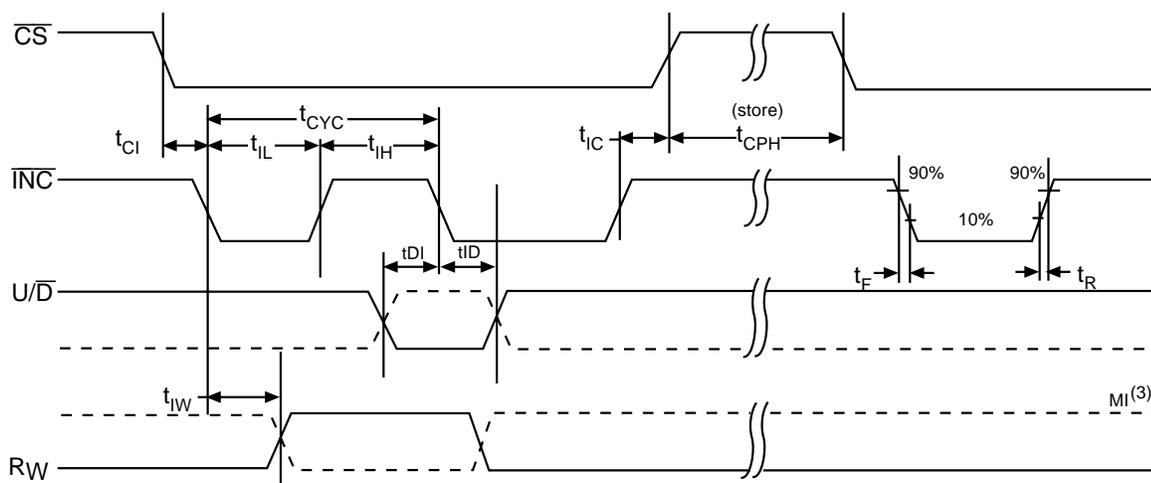
V <sub>CC</sub> Range	2.5V ≤ V <sub>CC</sub> ≤ 6V
Input Pulse Levels	0.2V <sub>CC</sub> to 0.7V <sub>CC</sub>
Input Rise and Fall Times	10ns
Input Reference Levels	0.5V <sub>CC</sub>

## AC OPERATING CHARACTERISTICS:

V<sub>CC</sub> = +2.5V to +6.0V, V<sub>H</sub> = V<sub>CC</sub>, V<sub>L</sub> = 0V, unless otherwise specified

Symbol	Parameter	Min	Typ <sup>(1)</sup>	Max	Units
t <sub>CI</sub>	$\overline{CS}$ to INC Setup	100	—	—	ns
t <sub>DI</sub>	U/D to $\overline{INC}$ Setup	50	—	—	ns
t <sub>ID</sub>	U/D to $\overline{INC}$ Hold	100	—	—	ns
t <sub>IL</sub>	$\overline{INC}$ LOW Period	250	—	—	ns
t <sub>IH</sub>	$\overline{INC}$ HIGH Period	250	—	—	ns
t <sub>IC</sub>	$\overline{INC}$ Inactive to $\overline{CS}$ Inactive	1	—	—	μs
t <sub>CPH</sub>	$\overline{CS}$ Deselect Time (NO STORE)	100	—	—	ns
t <sub>CPH</sub>	$\overline{CS}$ Deselect Time (STORE)	10	—	—	ms
t <sub>IW</sub>	$\overline{INC}$ to V <sub>OUT</sub> Change	—	1	5	μs
t <sub>CYC</sub>	$\overline{INC}$ Cycle Time	1	—	—	μs
t <sub>R</sub> , t <sub>F</sub> <sup>(2)</sup>	$\overline{INC}$ Input Rise and Fall Time	—	—	500	μs
t <sub>PU</sub> <sup>(2)</sup>	Power-up to Wiper Stable	—	—	1	msec
t <sub>WR</sub>	Store Cycle	—	5	10	ms

## A. C. TIMING



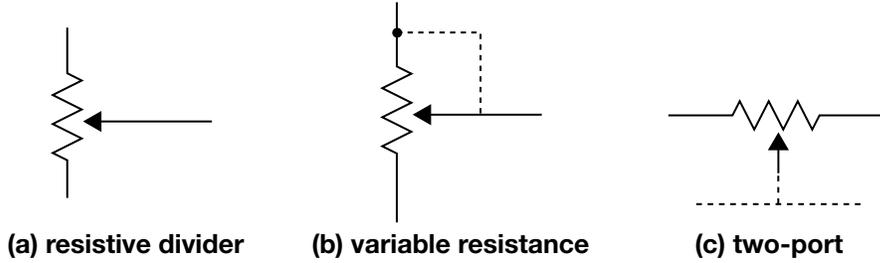
(1) Typical values are for T<sub>A</sub>=25°C and nominal supply voltage.

(2) This parameter is periodically sampled and not 100% tested.

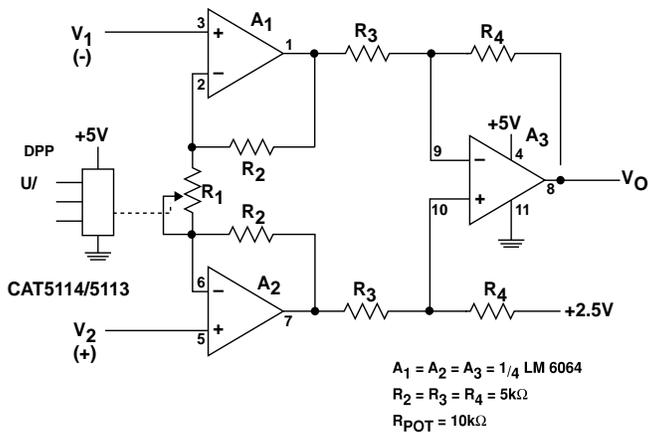
(3) MI in the A.C. Timing diagram refers to the minimum incremental change in the W output due to a change in the wiper position.

# APPLICATIONS INFORMATION

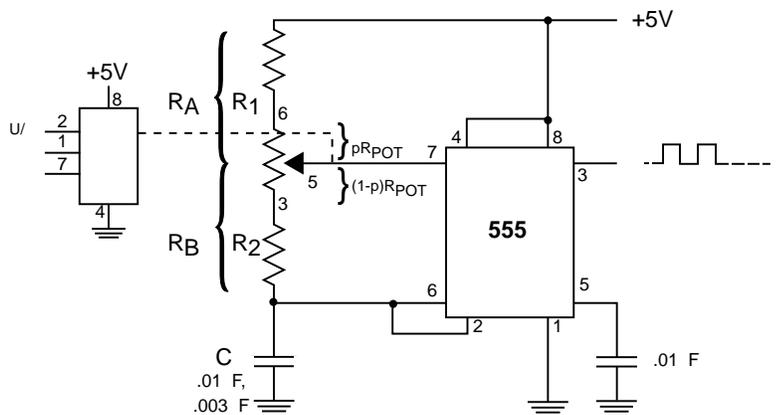
## Potentiometer Configurations



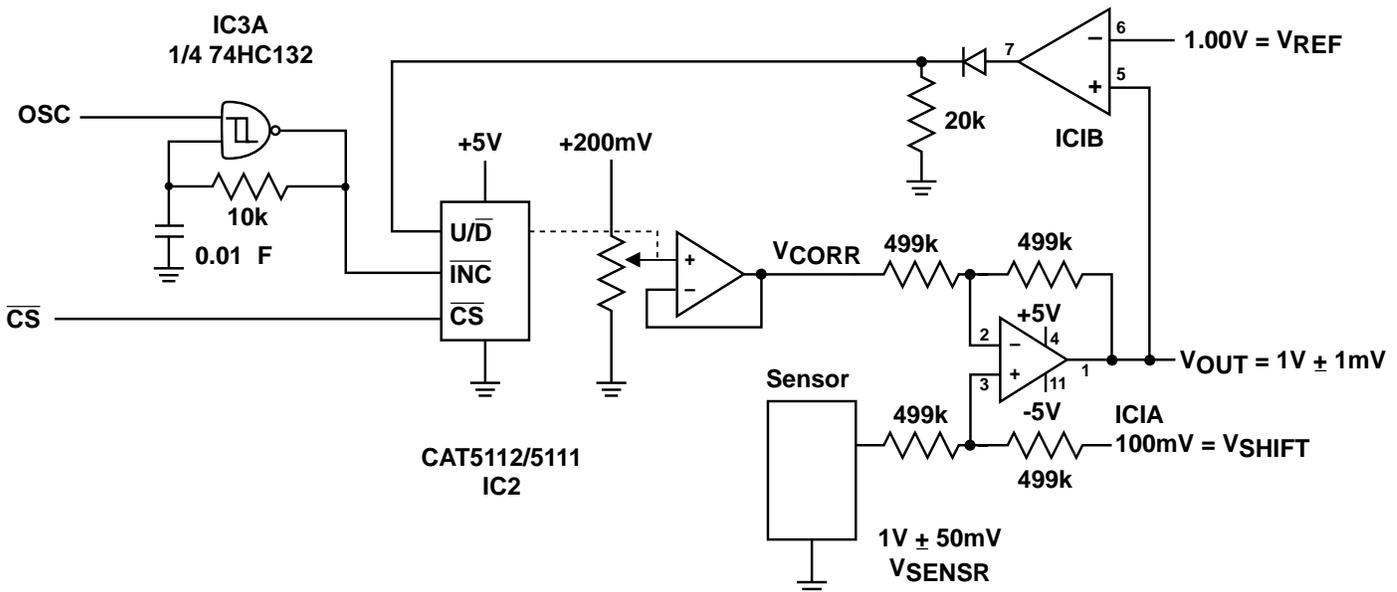
## Applications



Programmable Instrumentation Amplifier

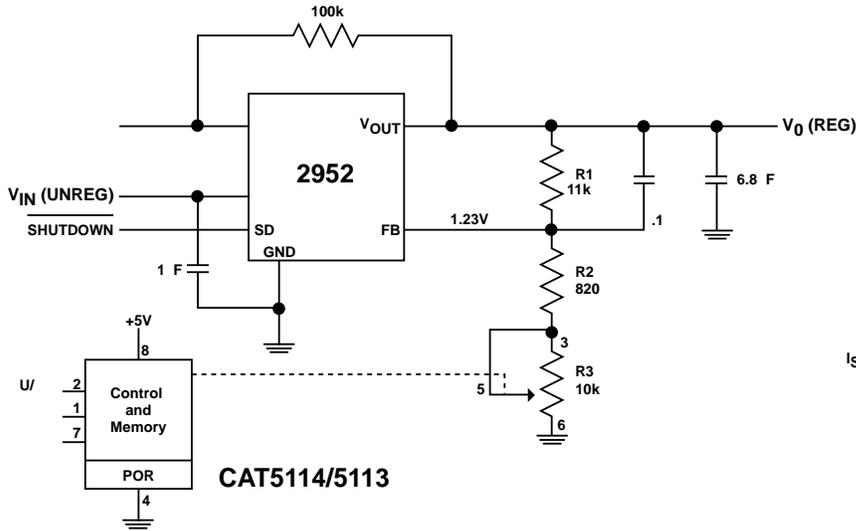


Programmable Sq. Wave Oscillator (555)

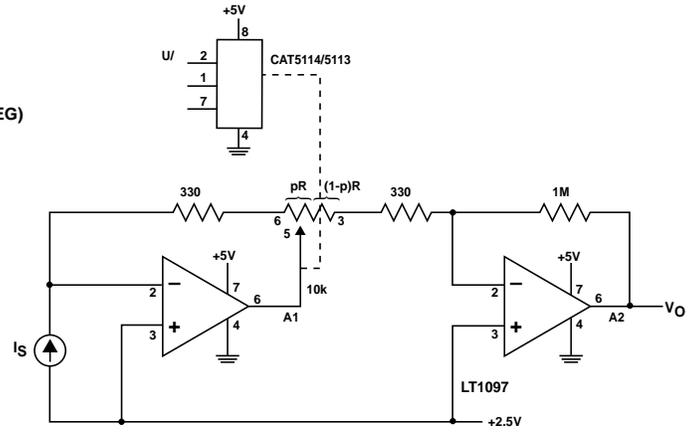


Sensor Auto Referencing Circuit

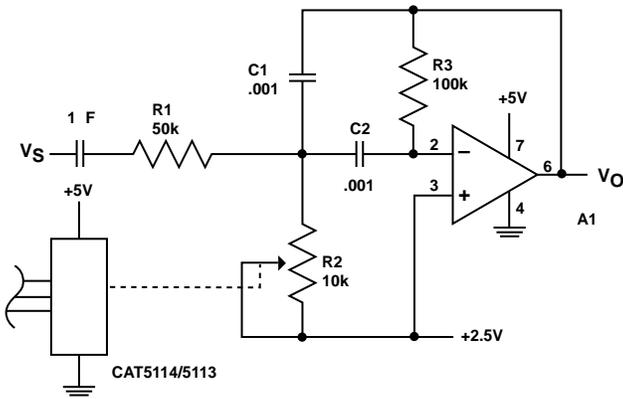
# APPLICATIONS INFORMATION



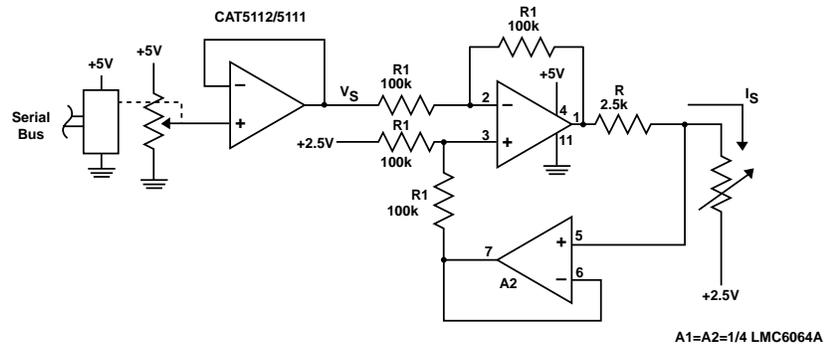
Programmable Voltage Regulator



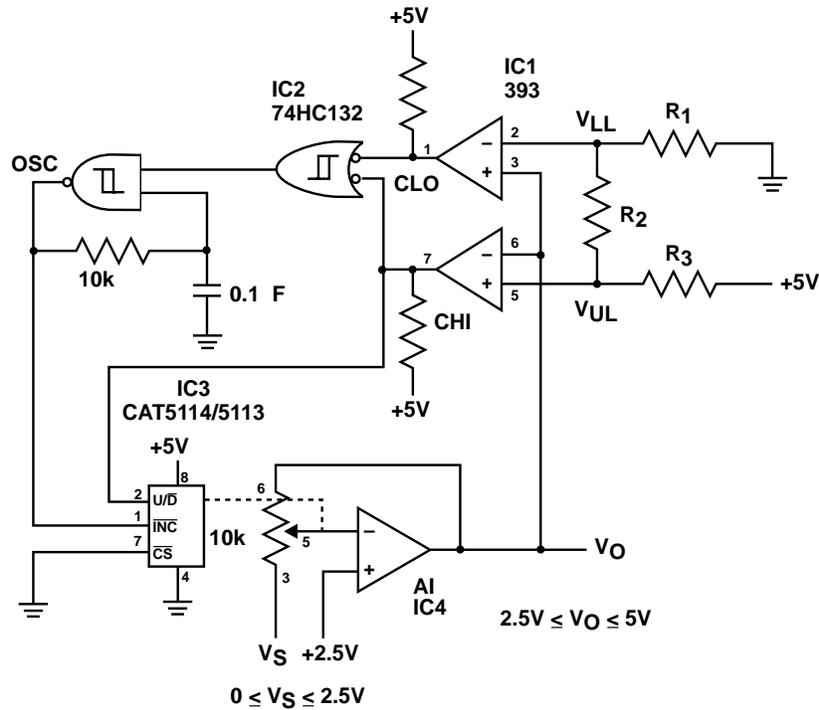
Programmable I to V convertor



Programmable Bandpass Filter

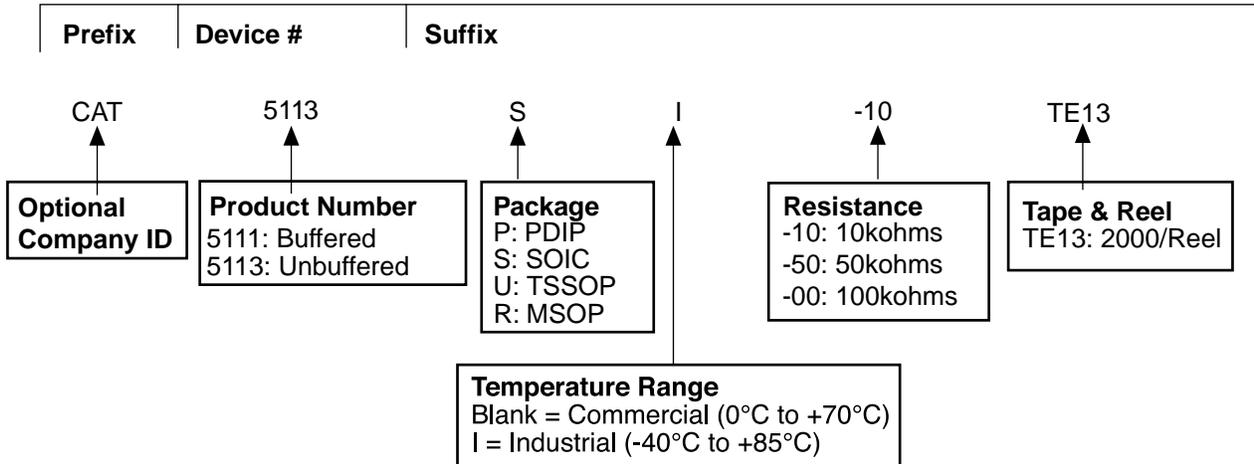


Programmable Current Source/Sink



Automatic Gain Control

**ORDERING INFORMATION**



Notes:

(1) The device used in the above example is a CAT5113 SI-10TE13 (SOIC, 10K Ohms, Industrial Temperature, Tape & Reel)

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 Type: Final



# CAT5114

## 32-Tap Digitally Programmable Potentiometer (DPP™)

### FEATURES

- 32-position linear taper potentiometer
- Non-volatile NVRAM wiper storage
- Low power CMOS technology
- Single supply operation: 2.5V-6.0V
- Increment Up/Down serial interface
- Resistance values: 10kΩ, 50kΩ and 100kΩ
- Available in PDIP, SOIC, TSSOP and MSOP packages

### APPLICATIONS

- Automated product calibration
- Remote control adjustments
- Offset, gain and zero control
- Tamper-proof calibrations
- Contrast, brightness and volume controls
- Motor controls and feedback systems
- Programmable analog functions

### DESCRIPTION

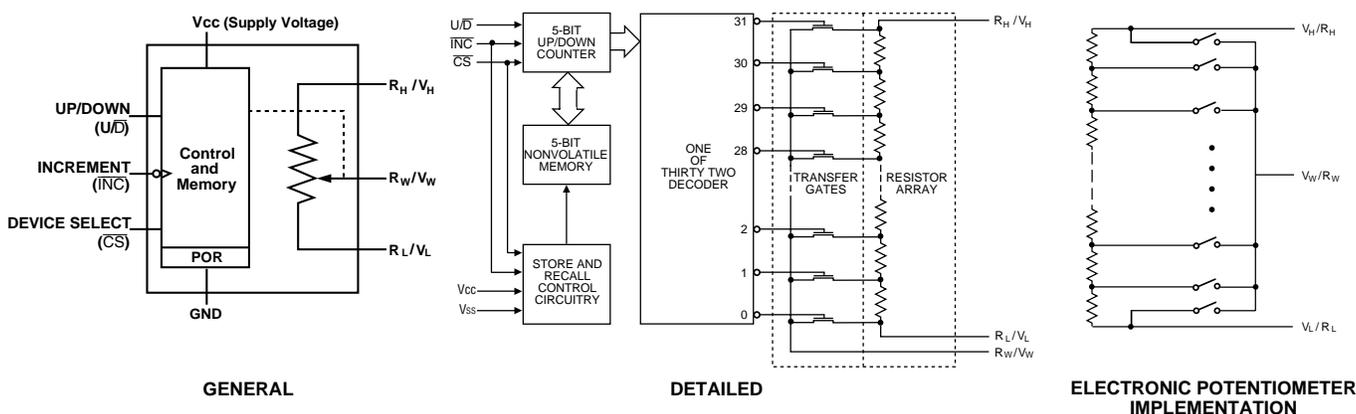
The CAT5114 is a single digitally programmable potentiometer (DPP™) designed as an electronic replacement for mechanical potentiometers and trim pots. Ideal for automated adjustments on high volume production lines, they are also well suited for applications where equipment requiring periodic adjustment is either difficult to access or located in a hazardous or remote environment.

The CAT5114 contains a 32-tap series resistor array connected between two terminals  $R_H$  and  $R_L$ . An up/down counter and decoder that are controlled by three input pins, determines which tap is connected to the wiper,  $R_W$ . The wiper setting, stored in nonvolatile memory, is not lost when the device is powered down and is automatically reinstated when power is returned. The wiper can be adjusted to test

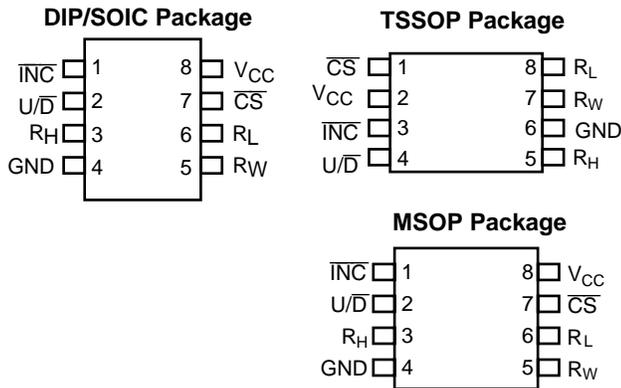
new system values without effecting the stored setting. Wiper-control of the CAT5114 is accomplished with three input control pins,  $\overline{CS}$ ,  $U/\overline{D}$ , and  $\overline{INC}$ . The  $\overline{INC}$  input increments the wiper in the direction which is determined by the logic state of the  $U/\overline{D}$  input. The  $\overline{CS}$  input is used to select the device and also store the wiper position prior to power down.

The digitally programmable potentiometer can be used as a three-terminal resistive divider or as a two-terminal variable resistor. DPPs bring variability and programmability to a wide variety of applications including control, parameter adjustments, and signal processing.

### FUNCTIONAL DIAGRAM



**PIN CONFIGURATION**



**PIN FUNCTIONS**

Pin Name	Function
$\overline{INC}$	Increment Control
$\overline{U/D}$	Up/Down Control
R <sub>H</sub>	Potentiometer High Terminal
GND	Ground
R <sub>W</sub>	Potentiometer Wiper Terminal
R <sub>L</sub>	Potentiometer Low Terminal
$\overline{CS}$	Chip Select
V <sub>CC</sub>	Supply Voltage

**PIN DESCRIPTIONS**

**$\overline{INC}$ :** Increment Control Input

The  $\overline{INC}$  input moves the wiper in the up or down direction determined by the condition of the  $\overline{U/D}$  input.

**$\overline{U/D}$ :** Up/Down Control Input

The  $\overline{U/D}$  input controls the direction of the wiper movement. When in a high state and  $\overline{CS}$  is low, any high-to-low transition on  $\overline{INC}$  will cause the wiper to move one increment toward the R<sub>H</sub> terminal. When in a low state and  $\overline{CS}$  is low, any high-to-low transition on  $\overline{INC}$  will cause the wiper to move one increment towards the R<sub>L</sub> terminal.

**R<sub>H</sub>:** High End Potentiometer Terminal

R<sub>H</sub> is the high end terminal of the potentiometer. It is not required that this terminal be connected to a potential greater than the R<sub>L</sub> terminal. Voltage applied to the R<sub>H</sub> terminal cannot exceed the supply voltage, V<sub>CC</sub> or go below ground, GND.

**R<sub>W</sub>:** Wiper Potentiometer Terminal

R<sub>W</sub> is the wiper terminal of the potentiometer. Its position on the resistor array is controlled by the control inputs,  $\overline{INC}$ ,  $\overline{U/D}$  and  $\overline{CS}$ . Voltage applied to the R<sub>W</sub> terminal cannot exceed the supply voltage, V<sub>CC</sub> or go below ground, GND.

**R<sub>L</sub>:** Low End Potentiometer Terminal

R<sub>L</sub> is the low end terminal of the potentiometer. It is not required that this terminal be connected to a potential less than the R<sub>H</sub> terminal. Voltage applied to the R<sub>L</sub> terminal cannot exceed the supply voltage, V<sub>CC</sub> or go below ground, GND. R<sub>L</sub> and R<sub>H</sub> are electrically interchangeable.

**$\overline{CS}$ :** Chip Select

The chip select input is used to activate the control input

of the CAT5114 and is active low. When in a high state, activity on the  $\overline{INC}$  and  $\overline{U/D}$  inputs will not affect or change the position of the wiper.

**DEVICE OPERATION**

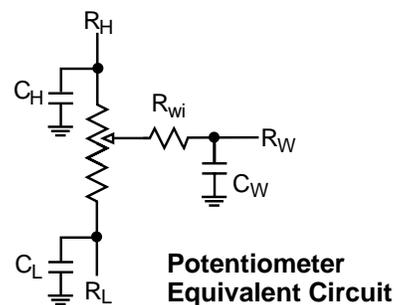
The CAT5114 operates like a digitally controlled potentiometer with R<sub>H</sub> and R<sub>L</sub> equivalent to the high and low terminals and R<sub>W</sub> equivalent to the mechanical potentiometer's wiper. There are 32 available tap positions including the resistor end points, R<sub>H</sub> and R<sub>L</sub>. There are 31 resistor elements connected in series between the R<sub>H</sub> and R<sub>L</sub> terminals. The wiper terminal is connected to one of the 32 taps and controlled by three inputs,  $\overline{INC}$ ,  $\overline{U/D}$  and  $\overline{CS}$ . These inputs control a five-bit up/down counter whose output is decoded to select the wiper position. The selected wiper position can be stored in nonvolatile memory using the  $\overline{INC}$  and  $\overline{CS}$  inputs.

With  $\overline{CS}$  set LOW the CAT5114 is selected and will respond to the  $\overline{U/D}$  and  $\overline{INC}$  inputs. HIGH to LOW transitions on  $\overline{INC}$  will increment or decrement the wiper (depending on the state of the  $\overline{U/D}$  input and five-bit counter). The wiper, when at either fixed terminal, acts like its mechanical equivalent and does not move beyond the last position. The value of the counter is stored in nonvolatile memory whenever  $\overline{CS}$  transitions HIGH while the  $\overline{INC}$  input is also HIGH. When the CAT5114 is powered-down, the last stored wiper counter position is maintained in the nonvolatile memory. When power is restored, the contents of the memory are recalled and the counter is set to the value stored.

With  $\overline{INC}$  set low, the CAT5114 may be de-selected and powered down without storing the current wiper position in nonvolatile memory. This allows the system to always power up to a preset value stored in nonvolatile memory.

## OPERATION MODES

$\overline{INC}$	$\overline{CS}$	U/D	Operation
High to Low	Low	High	Wiper toward H
High to Low	Low	Low	Wiper toward L
High	Low to High	X	Store Wiper Position
Low	Low to High	X	No Store, Return to Standby
X	High	X	Standby



## ABSOLUTE MAXIMUM RATINGS

## Supply Voltage

$V_{CC}$  to GND ..... -0.5V to +7V

## Inputs

$\overline{CS}$  to GND ..... -0.5V to  $V_{CC} + 0.5V$

$\overline{INC}$  to GND ..... -0.5V to  $V_{CC} + 0.5V$

U/D to GND ..... -0.5V to  $V_{CC} + 0.5V$

H to GND ..... -0.5V to  $V_{CC} + 0.5V$

L to GND ..... -0.5V to  $V_{CC} + 0.5V$

W to GND ..... -0.5V to  $V_{CC} + 0.5V$

## Operating Ambient Temperature

Commercial ('C' or Blank suffix) ..... 0°C to +70°C

Industrial ('I' suffix) ..... -40°C to +85°C

Junction Temperature ..... +150°C

Storage Temperature ..... -65°C to +150°C

Lead Soldering (10 sec max) ..... +300°C

\* Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Absolute Maximum Ratings are limited values applied individually while other parameters are within specified operating conditions, and functional operation at any of these conditions is NOT implied. Device performance and reliability may be impaired by exposure to absolute rating conditions for extended periods of time.

## RELIABILITY CHARACTERISTICS

Symbol	Parameter	Test Method	Min	Typ	Max	Units
$V_{ZAP}^{(1)}$	ESD Susceptibility	MIL-STD-883, Test Method 3015	2000			Volts
$I_{LTH}^{(1)(2)}$	Latch-Up	JEDEC Standard 17	100			mA
$T_{DR}$	Data Retention	MIL-STD-883, Test Method 1008	100			Years
$N_{END}$	Endurance	MIL-STD-883, Test Method 1003	1,000,000			Stores

DC Electrical Characteristics:  $V_{CC} = +2.5V$  to  $+6.0V$  unless otherwise specified

## Power Supply

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{CC}$	Operating Voltage Range		2.5	—	6.0	V
$I_{CC1}$	Supply Current (Increment)	$V_{CC} = 6V, f = 1MHz, I_W=0$ $V_{CC} = 6V, f = 250kHz, I_W=0$	—	—	100	$\mu A$
$I_{CC2}$	Supply Current (Write)	Programming, $V_{CC} = 6V$ $V_{CC} = 3V$	—	—	1	mA
$ISB_1^{(2)}$	Supply Current (Standby)	$CS=V_{CC}-0.3V$ U/D, INC= $V_{CC}-0.3V$ or GND	—	—	1	$\mu A$

## Logic Inputs

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$I_{IH}$	Input Leakage Current	$V_{IN} = V_{CC}$	—	—	10	$\mu A$
$I_{IL}$	Input Leakage Current	$V_{IN} = 0V$	—	—	-10	$\mu A$
$V_{IH1}$	TTL High Level Input Voltage	$4.5V \leq V_{CC} \leq 5.5V$	2	—	$V_{CC}$	V
$V_{IL1}$	TTL Low Level Input Voltage					
$V_{IH2}$	CMOS High Level Input Voltage	$2.5V \leq V_{CC} \leq 6V$	$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V
$V_{IL2}$	CMOS Low Level Input Voltage					

- NOTES:** (1) This parameter is tested initially and after a design or process change that affects the parameter.  
(2) Latch-up protection is provided for stresses up to 100mA on address and data pins from -1V to  $V_{CC} + 1V$   
(3)  $I_W$ =source or sink  
(4) These parameters are periodically sampled and are not 100% tested.

Potentiometer Parameters

Symbol	Parameter	Conditions	Min	Typ	Max	Units
R <sub>POT</sub>	Potentiometer Resistance	-10 Device		10		kΩ
		-50 Device		50		
		-00 Device		100		
	Pot Resistance Tolerance				±15	%
V <sub>RH</sub>	Voltage on R <sub>H</sub> pin		0		V <sub>CC</sub>	V
V <sub>RL</sub>	Voltage on R <sub>L</sub> pin		0		V <sub>CC</sub>	V
	Resolution			3.2		%
INL	Integral Linearity Error	I <sub>w</sub> ≤ 2μA		0.5	1	LSB
DNL	Differential Linearity Error	I <sub>w</sub> ≤ 2μA		0.25	0.5	LSB
R <sub>Wi</sub>	Wiper Resistance	V <sub>CC</sub> = 5V, I <sub>w</sub> = 1mA			400	Ω
		V <sub>CC</sub> = 2.5V, I <sub>w</sub> = 1mA			1	kΩ
I <sub>w</sub>	Wiper Current				1	mA
TC <sub>R<sub>POT</sub></sub>	TC of Pot Resistance			300		ppm/°C
TC <sub>R<sub>RATIO</sub></sub>	Ratiometric TC				20	ppm/°C
R <sub>ISO</sub>	Isolation Resistance			TBD		Ω
V <sub>N</sub>	Noise	100kHz / 1kHz		8/24		nV/√Hz
C <sub>H</sub> /C <sub>L</sub> /C <sub>W</sub>	Potentiometer Capacitances			8/8/25		pF
fc	Frequency Response	Passive Attenuator, 10kΩ		1.7		MHz

## AC CONDITIONS OF TEST

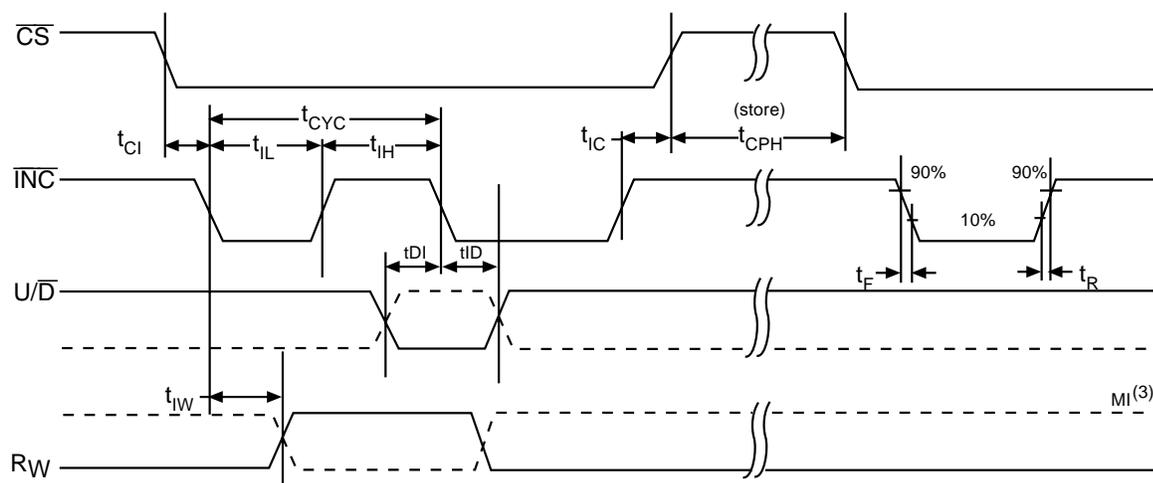
$V_{CC}$ Range	$2.5V \leq V_{CC} \leq 6V$
Input Pulse Levels	$0.2V_{CC}$ to $0.7V_{CC}$
Input Rise and Fall Times	10ns
Input Reference Levels	$0.5V_{CC}$

## AC OPERATING CHARACTERISTICS:

$V_{CC} = +2.5V$  to  $+6.0V$ ,  $V_H = V_{CC}$ ,  $V_L = 0V$ , unless otherwise specified

Symbol	Parameter	Min	Typ <sup>(1)</sup>	Max	Units
$t_{CI}$	$\overline{CS}$ to INC Setup	100	—	—	ns
$t_{DI}$	U/D to $\overline{INC}$ Setup	50	—	—	ns
$t_{ID}$	U/D to $\overline{INC}$ Hold	100	—	—	ns
$t_{IL}$	$\overline{INC}$ LOW Period	250	—	—	ns
$t_{IH}$	$\overline{INC}$ HIGH Period	250	—	—	ns
$t_{IC}$	$\overline{INC}$ Inactive to $\overline{CS}$ Inactive	1	—	—	$\mu s$
$t_{CPH}$	$\overline{CS}$ Deselect Time (NO STORE)	100	—	—	ns
$t_{CPH}$	$\overline{CS}$ Deselect Time (STORE)	10	—	—	ms
$t_{IW}$	$\overline{INC}$ to $V_{OUT}$ Change	—	1	5	$\mu s$
$t_{CYC}$	$\overline{INC}$ Cycle Time	1	—	—	$\mu s$
$t_R, t_F^{(2)}$	$\overline{INC}$ Input Rise and Fall Time	—	—	500	$\mu s$
$t_{PU}^{(2)}$	Power-up to Wiper Stable	—	—	1	msec
$t_{WR}$	Store Cycle	—	5	10	ms

## A. C. TIMING



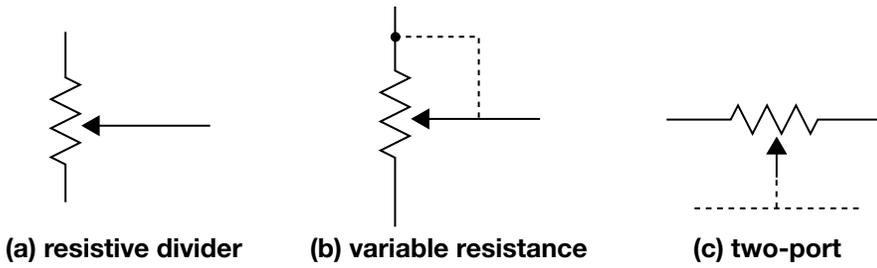
(1) Typical values are for  $T_A=25^\circ C$  and nominal supply voltage.

(2) This parameter is periodically sampled and not 100% tested.

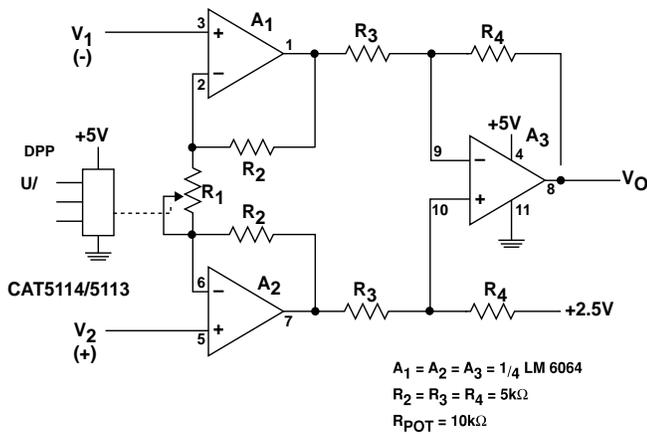
(3) MI in the A.C. Timing diagram refers to the minimum incremental change in the W output due to a change in the wiper position.

# APPLICATIONS INFORMATION

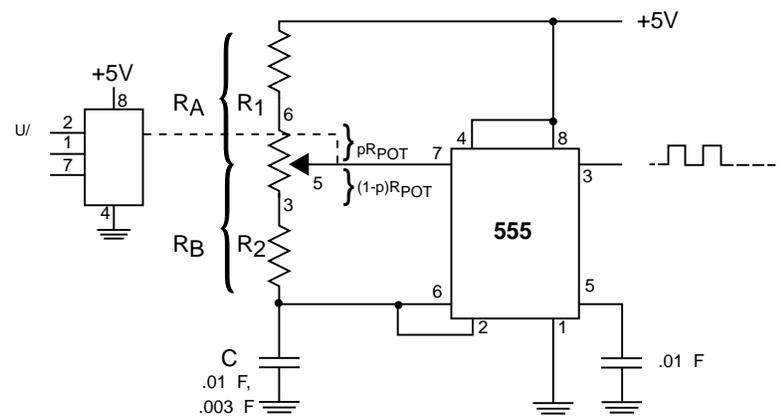
## Potentiometer Configurations



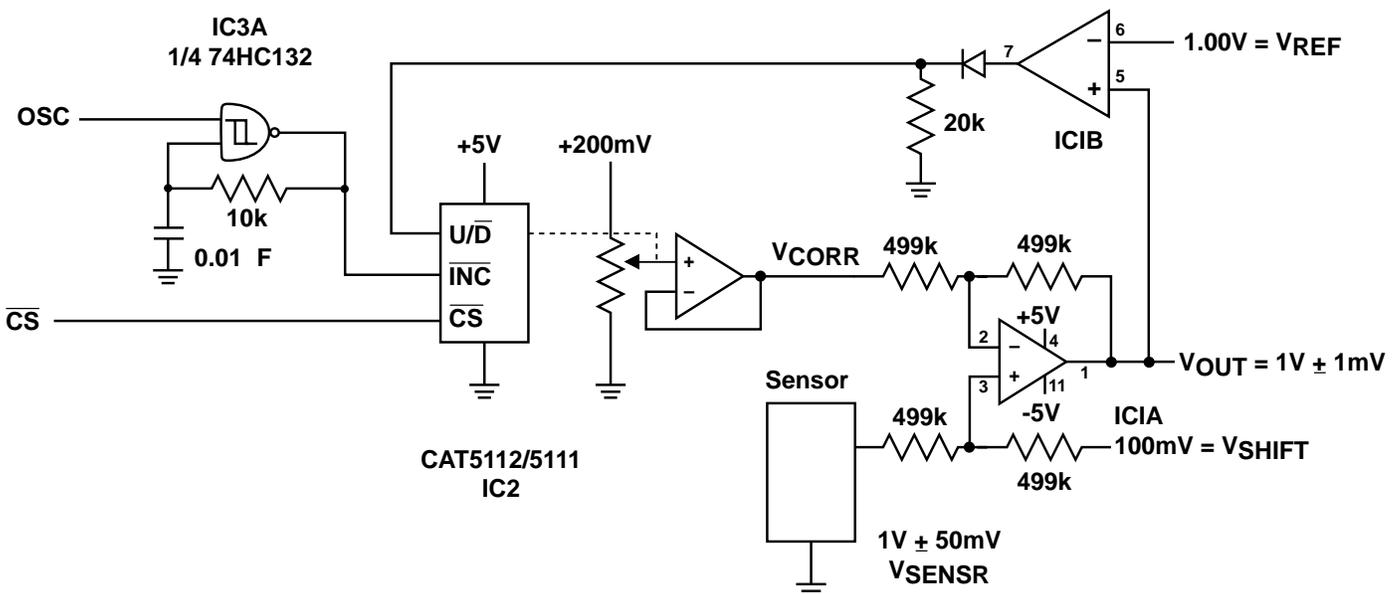
## Applications



**Programmable Instrumentation Amplifier**

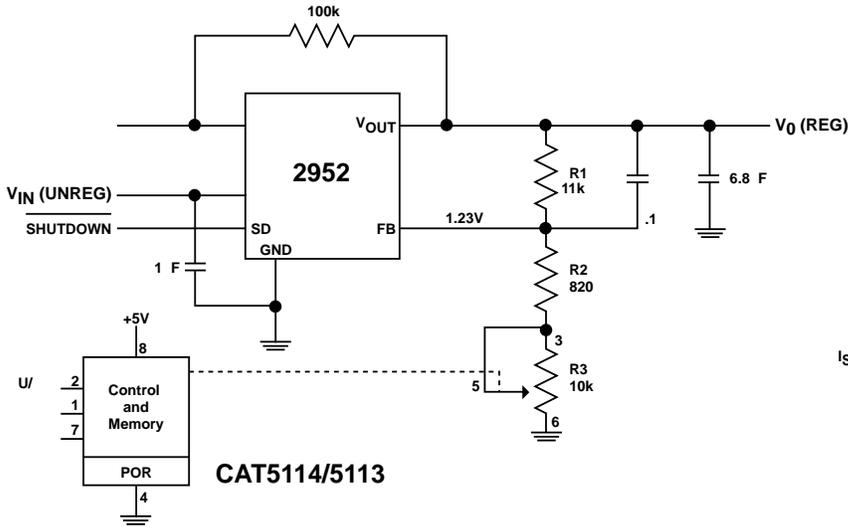


**Programmable Sq. Wave Oscillator (555)**

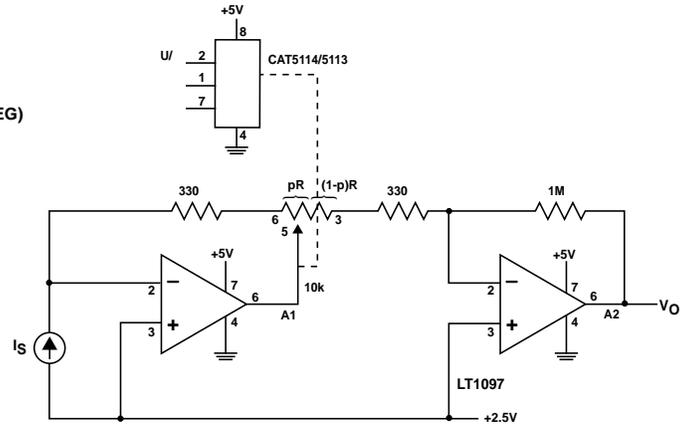


**Sensor Auto Referencing Circuit**

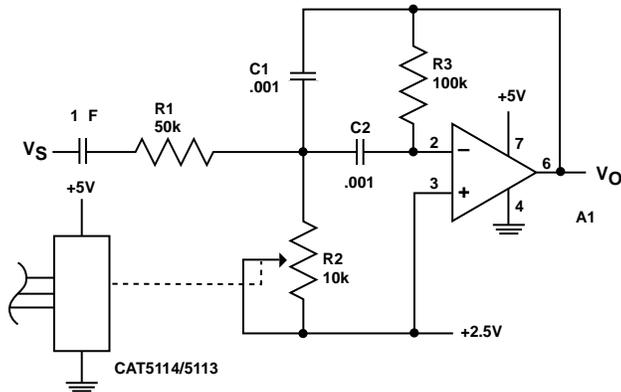
# APPLICATIONS INFORMATION



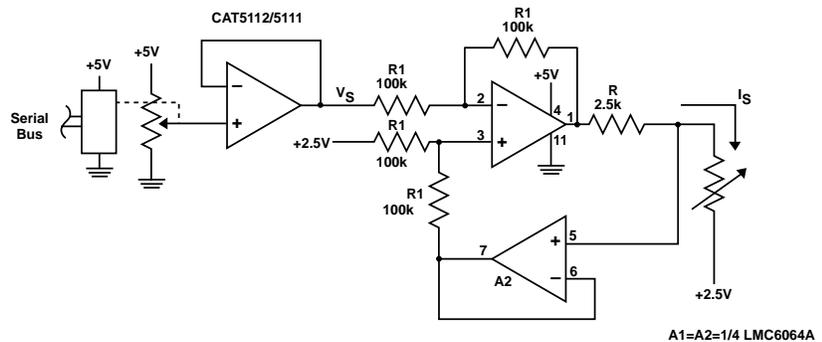
**Programmable Voltage Regulator**



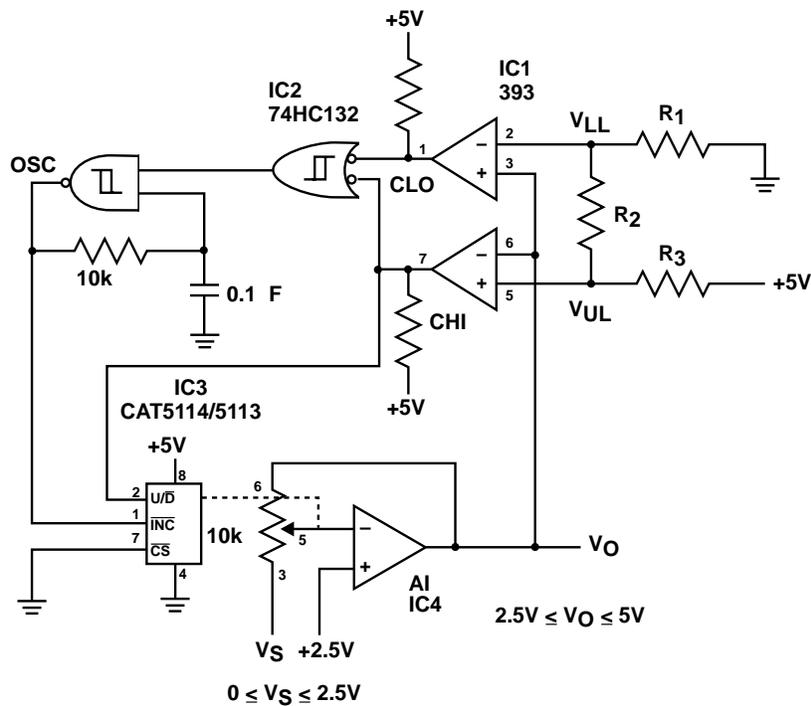
**Programmable I to V convertor**



**Programmable Bandpass Filter**

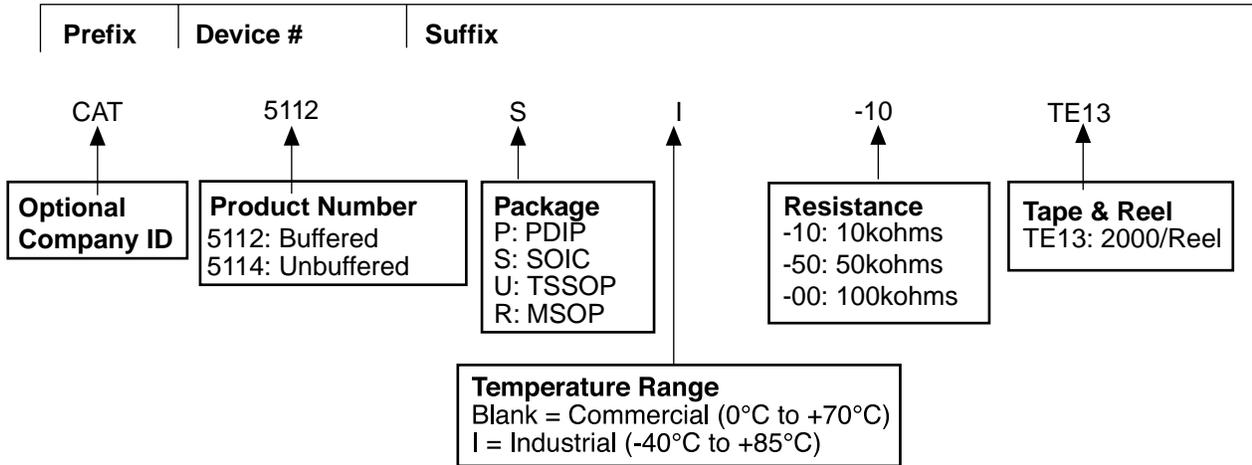


**Programmable Current Source/Sink**



**Automatic Gain Control**

**ORDERING INFORMATION**



Notes:

(1) The device used in the above example is a CAT5114 SI-10TE13 (SOIC, 10K Ohms, Industrial Temperature, Tape & Reel)

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